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APPLICATIONS OF BURZYŃSKI FAILURE CRITERIA.
PART I. ISOTROPIC MATERIALS WITH ASYMMETRY
OF ELASTIC RANGE

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The main idea of energy-based hypothesis of material effort proposed by Burzyński is briefly presented and the resulting failure criteria are discussed. Some examples, based on the own studies, which depict applications of these criteria are discussed and visualizations of limit surfaces in the space of principal stresses are presented.

Key words: Burzyński yield condition, yield surface, strength differential effect, energy-based yield criteria.

1. INTRODUCTION

The aim of the paper is to present an energy-based approach to failure criteria for materials, which reveal asymmetry in failure characteristics. It means that in the results of tension and compression tests there is observed a difference in the values of elastic, yield or strength limits. The energy-based hypothesis of material effort proposed originally by W. BURZYŃSKI is presented [1–3]; and the resulting failure criteria phrased for stress tensor components in an arbitrary Cartesian coordinate system and in particular, with the use of principal stresses, are discussed. As for the new results, our own applications of Burzyński's failure criteria for traditional and new materials are presented.

2. FAILURE CRITERIA BASED ON BURZYŃSKI HYPOTHESIS OF MATERIAL EFFORT FOR ISOTROPIC SOLIDS

Włodzimierz BURZYŃSKI [1] not only summarized the contemporary knowledge about yield criteria but also presented a new idea how to determine the measure of material effort for materials which reveal difference in the failure

strength (in particular: the elastic limit) for tension and compression. According to the original Burzyński's hypothesis, *the measure of material effort defining the limit of elastic range is a sum of the density of elastic energy of distortion and a part of density of elastic energy of volume change being a function of the state of stress and particular material properties.* The mathematical formula corresponding to this statement reads:

$$(2.1) \quad \Phi_f + \eta\Phi_v = K, \quad \eta = \omega + \frac{\delta}{3p}, \quad p = \frac{\sigma_1 + \sigma_2 + \sigma_3}{3},$$

where

$$\Phi_f = \frac{1}{12G} [(\sigma_1 - \sigma_2)^2 + (\sigma_1 - \sigma_3)^2 + (\sigma_2 - \sigma_3)^2]$$

means the density of elastic energy of distortion, while:

$$\Phi_v = \frac{1 - 2\nu}{6E} (\sigma_1 + \sigma_2 + \sigma_3)^2 = \frac{1 - 2\nu}{12G(1 + \nu)} (\sigma_1 + \sigma_2 + \sigma_3)^2$$

is the density of elastic energy of volume change. The constant K corresponds to the value of the density of elastic energy in a limit state, while ω , δ are material parameters dependent on the contribution of the density of elastic energy of volume change influenced by the mean stress p . By the symbols σ_1 , σ_2 , σ_3 are meant principal stresses. By introducing the function η Burzyński took into an account the experimentally based observation, that the increase of the mean stress p results in the diminishing contribution of the elastic energy density of volume change Φ_v in the measure of material effort. The above formulation of the measure of material effort is precise for the limit states of linear elasticity, typical for brittle behaviour of materials. When the limit state is related to the loss of material strength preceded by certain plastic strain, then, the measure of material effort (2.1) loses its foundations of linear elasticity, because in this case inelastic states of material may occur. This is the reason why W. Burzyński suggested to treat functions Φ_f and Φ_v in equation (2.1) as general strain functions, and he emphasized this fact by the term “quasi-energies” of strain.

In the discussed measure of material effort (2.1) three material parameters: ω , δ , K are introduced. The final form of failure hypothesis (2.1) reads [1, 2]:

$$(2.2) \quad \frac{1}{3}\sigma_f^2 + 3\frac{1 - 2\tilde{\nu}}{(1 + \tilde{\nu})}\omega p^2 + \frac{1 - 2\tilde{\nu}}{(1 + \tilde{\nu})}\delta p = 4GK,$$

where $\tilde{\nu} = \frac{k_c k_t}{2k_s^2} - 1$, $K = \frac{2k_c k_t}{12G(1 + \tilde{\nu})}$, $\sigma_f^2 = 12G\Phi_f$. The idea of Burzyński's derivation lies in a particular conversion of variables. The triplet (ω, δ, K) is substituted by another one, which results from commonly performed strength tests: elastic (plastic) limit in uniaxial tension – k_t , uniaxial compression – k_c , and torsion – k_s where $(\omega, \delta, K) \rightarrow (k_t, k_c, k_s)$ (cf. [1, p. 112]).

Because of mentioned above substitution, (2.2) transforms into the form discussed also in [4]:

$$(2.3) \quad \frac{k_c k_t}{3k_s^2} \sigma_e^2 + \left(9 - \frac{3k_c k_t}{k_s^2} \right) p^2 + 3(k_c - k_t)p - k_c k_t = 0,$$

where $\sigma_e^2 = \frac{1}{2} \sigma_f^2$ is an equivalent stress used in the theory of plasticity. According to the discussion conducted in [1] and [4], the equation (2.3) in the space of principal stresses, depending on the relations among material constants (k_t, k_c, k_s), describes the surfaces: an ellipsoid for $3k_s^2 > k_t k_c$ or a hyperboloid for $3k_s^2 < k_t k_c$, which, however, does not have any practical application. W. Burzyński also noticed that there occur interesting cases if these three material constants are particularly connected, for example if they are bound together as the geometrical average: $\sqrt{3}k_s = \sqrt{k_t k_c}$, then (2.3) takes the form [1]:

$$(2.4) \quad \sigma_e^2 + 3(k_c - k_t)p - k_c k_t = 0.$$

The above equation presents the formula of a paraboloid of revolution in the space of principal stresses. The original hypothesis of W. BURZYŃSKI [1] and his comprehensive phenomenological theory of material effort was forgotten and repeatedly “rediscovered” later by several authors, often in parts and without the clarity of the “in depth” analysis and physical foundations of Burzyński’s work. Discussion of other works containing the latter equation is presented in [4, 5]. It is worth to mention that the discussed above paraboloid yield condition finds recent applications also in viscoplastic modeling for metal matrix composites [6]. The latter authors, as well as many others, related this condition with the names of R. von Mises and F. Schleicher, although none of these researchers derived the relation (2.4) (cf. [7] for the discussion of a historical background of the studied paraboloid criterion).

3. RECENT APPLICATIONS OF THE BURZYŃSKI FAILURE CRITERIA

Defining the strength differential factor $\kappa = k_c/k_t$ allows to determine particular cases of the criterion, for example for $\kappa = 1$, $k_c = k_t = k$ and then $k_s = k/\sqrt{3}$, which suits the condition assumed in the Huber-Mises-Hencky criterion. After suitable transformation (2.3) takes the form expressed by stress tensor components in the system of principal axes:

$$(3.1) \quad \sigma_1^2 + \sigma_2^2 + \sigma_3^2 - 2 \left(\frac{k_c k_t}{2k_s^2} - 1 \right) (\sigma_1 \sigma_2 + \sigma_2 \sigma_3 + \sigma_3 \sigma_1) + (k_c - k_t)(\sigma_1 + \sigma_2 + \sigma_3) = k_c k_t.$$

If $\sigma_2 = 0$, there is obtained a plane state of stress, for which:

$$(3.2) \quad (\sigma_1^2 + \sigma_3^2) - 2 \left(\frac{k_c k_t}{2k_s^2} - 1 \right) \sigma_1 \sigma_3 + (k_c - k_t)(\sigma_1 + \sigma_3) = k_c k_t.$$

In the space of principal stresses for $\sqrt{3}k_s = \sqrt{k_t k_c}$ the graphical representation of the criterion (2.3) is a paraboloid of revolution with the axis of symmetry given by the axis of hydrostatic compression: $\sigma_1 = \sigma_2 = \sigma_3$. In the plane state of stress for $\sigma_2 = 0$ the graphical representation of the Burzyński hypothesis is an ellipse. The centre of symmetry of such an ellipse is defined by

$$S_e = \left(\frac{k_s^2(k_c - k_t)}{k_c k_t - 4k_s^2}, \frac{k_s^2(k_c - k_t)}{k_c k_t - 4k_s^2} \right)$$

and the axes of symmetry are given by

$$\sigma_3 = \sigma_1, \quad \sigma_3 = -\sigma_1 + \frac{2k_s^2(k_c - k_t)}{k_c k_t - 4k_s^2}.$$

If $k_c = k_t$ then the centre of the ellipse is given by the beginning of the coordinate system and the Burzyński hypothesis is equal to the Huber hypothesis; in this case, the graphical representation of the yield surface is a cylinder of revolution with the axis of symmetry: $\sigma_1 = \sigma_2 = \sigma_3$.

In [8] the Burzyński material effort hypothesis was specified for some classical experimental data discussed by THEOCARIS [9] and published in historical papers of LODÉ [10] as well as by TAYLOR and QUINNEY [11]. This paper is devoted to applications of the Burzyński failure criteria for our own experimental data obtained in the recent experimental investigations of mechanical properties of polycarbonate and the results related to the current studies of metal-ceramic composites [8, 12, 13].

The polycarbonate samples were investigated for tension, compression and shear performed with the use of a double shear specimen. The pictures of the sample before and after the shear test are shown in Fig. 1.

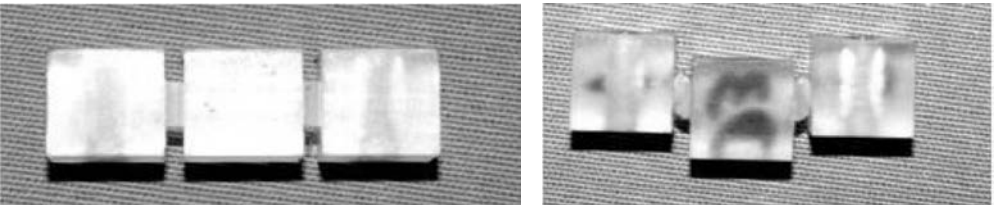
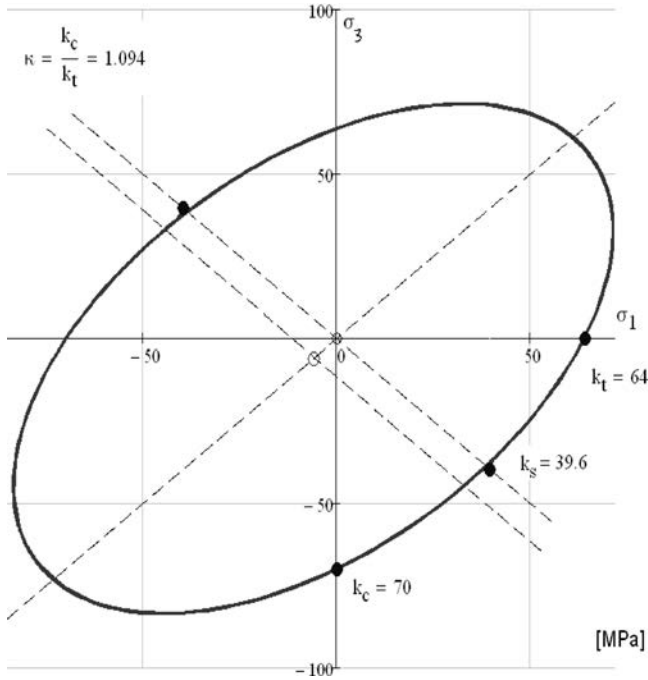


FIG. 1. The sample $12 \times 12 \times 40$ [mm] with the shearing zone $6 \times 6 \times 2$ [mm] prepared for a double shear test before and after deformation.

The numerical analysis of the shear process led to the correction accounting for the geometry of the double shear specimen. As a result, the following data were obtained: $k_c = 70$ MPa, $k_t = 64$ MPa, $k_s = 39.6$ MPa. Application of the

formula (3.2) shows that the Burzyński yield criterion fits very well with the experimental data for the investigated polycarbonate. This is depicted in Fig. 2 and Fig. 3, where the graphical representations of Burzyński yield criterion are shown.



The ellipse of the plane state of stress. The experimental data for yield strength in tension, compression and shear.

FIG. 2. Graphical representation of Burzyński yield criterion for the polycarbonate according to our own experimental investigations.

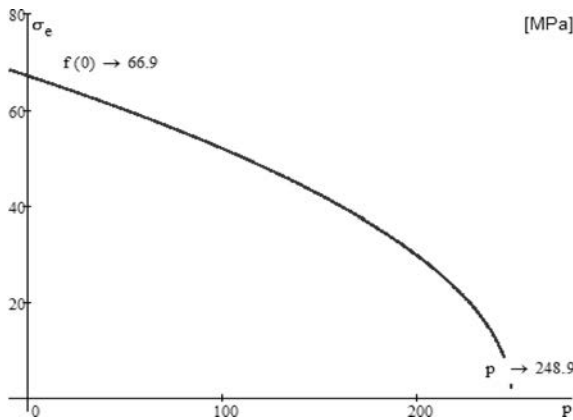
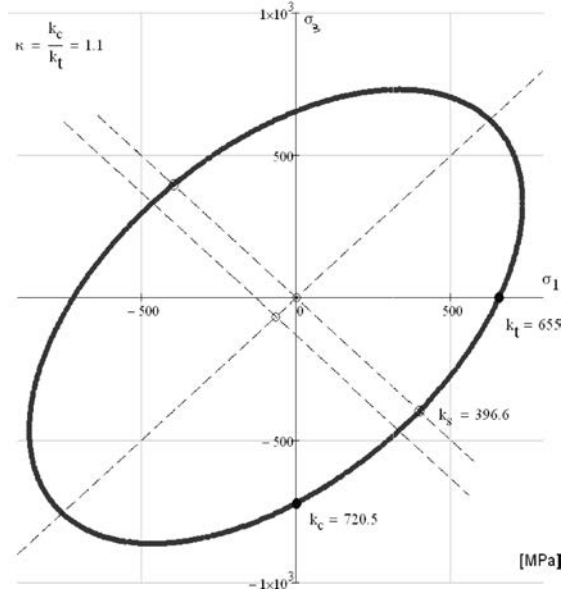


FIG. 3. A half-parabola, being the representation of the Burzyński yield criterion for the polycarbonate in the surface (σ_e, p) .

The graphical representation of the limit function for the metal matrix composites (MMC), in particular alumina alloy 6061 reinforced by zircon and corundum particles: 6061+2Zr+20Al₂O₃ [12] is presented below, Fig. 4. and Fig. 5.



The ellipse of the plane state of stress. The experimental data are marked with solid points $k_c = 720.5$ MPa, $k_t = 655$ MPa and the limit shear strength $k_s = 39.6$ MPa is marked with an open circle.

FIG. 4. Graphical representation of the Burzyński yield criterion for the MMC composite 6061+2Zr+20Al₂O₃.

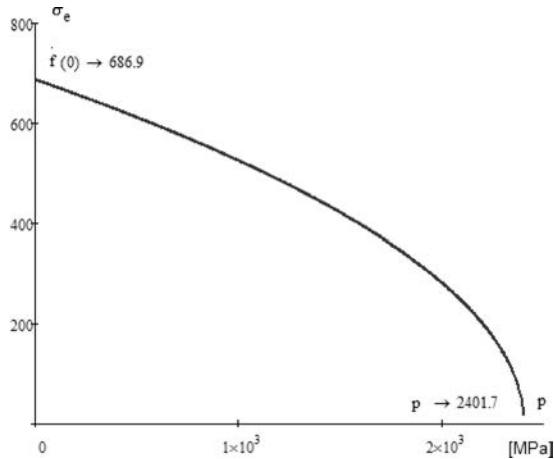


FIG. 5. A half-parabola, being the representation of the Burzyński failure criterion for the MMC composite 6061+2Zr+20Al₂O₃ in the coordinates (σ_e, p) .

Further experimental tests are necessary to verify the presented above paraboloid failure criterion. At least an independent test delivering information about the strength in shear k_s could be helpful for that. The specified formula for paraboloid failure surface can be applied as plastic potential in calculations of plastic deformation of metallic solids, which reveal the stress differential effect, cf. e.g. [6] or [14]. In such a case, the information of how the ratio $\kappa = k_c/k_t$ changes in strain is necessary. In the numerical simulations of some examples of plastic deformation processes presented in [14] the constant value of κ was assumed. However, the analysis of experimental data of the particle-reinforced metal matrix composite (PRMMC) – Al-47Al₂O₃ in [6] shows that the ratio $\kappa = k_c/k_t$ increases in strain.

Another particle-reinforced metal matrix composite 75%Cr – 25%Al₂O₃ (M) was experimentally investigated [13]. The tests, of compression and tension, were performed. The cylindrical specimens of the diameter 12 mm and the height of 10 mm, Fig. 6, were subjected to the compression tests with the use of the strength machine MTS810 of the loading range reaching 250 kN. The corresponding characteristics are given in Table 1.

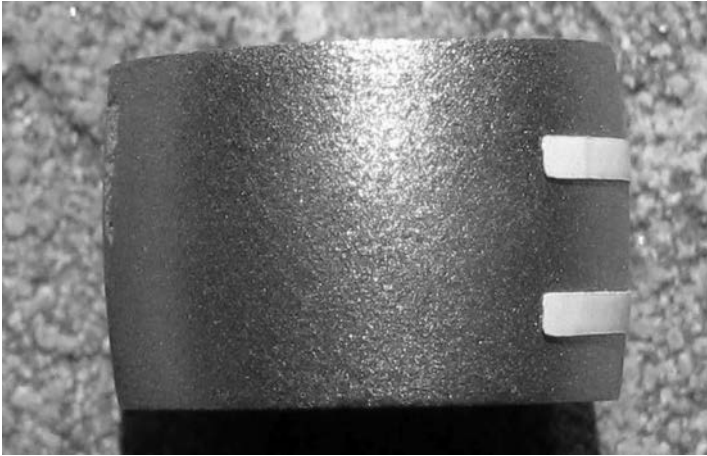


FIG. 6. Picture of the deformed cylindrical specimen.

Table 1. Material characteristics obtained in the compression test.

Type of the composite	$R_{0.2}$ [MPa]	R_m [MPa]
75%Cr – 25%Al ₂ O ₃ (M)	700	920

During the compression of the cylindrical specimen the local failure appeared. The magnified picture ($\times 500$) of the surface with the failure sites with the use of scanning microscopy is shown in Fig. 7. The tensile test was performed with the use of the specimens shown in Fig. 8. The plane tensile specimens were cut

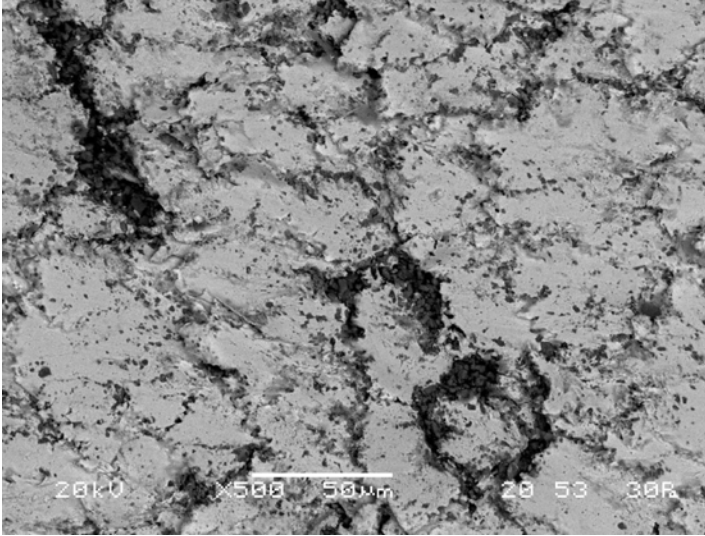


FIG. 7. The picture of the surface of the specimen revealing the sites of failure.

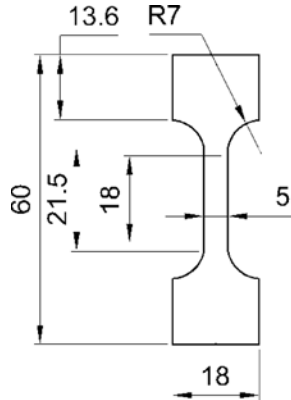


FIG. 8. The shape and dimensions of the tensile specimen.

out from the roller of the diameter 80 mm and thickness of 5 mm. In Table 2 the measured material parameters are given.

Table 2. Material characteristics obtained in the tensile test.

Type of the composite	$R_{0.2}$ [MPa]	R_m [MPa]
75%Cr – 25%Al ₂ O ₃ (M)	23	24

The graphical representation of the limit function for the particle-reinforced metal matrix composite 75%Cr – 25%Al₂O₃ (M) is presented below, Fig. 9 and Fig. 10.

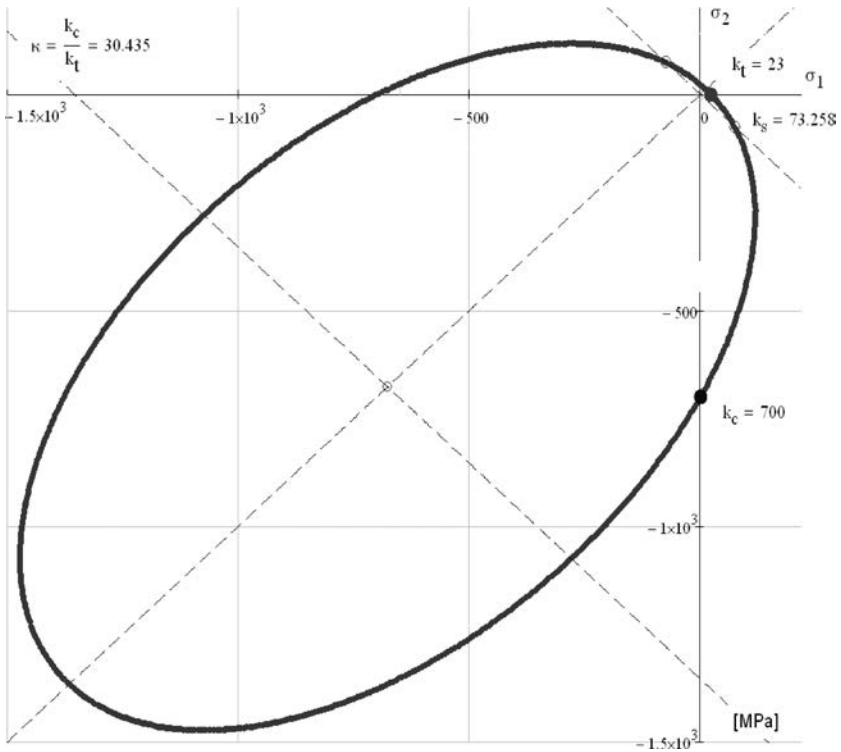


FIG. 9. Graphical representation of the Burzyński yield criterion for the MMC composite 75%Cr - 25%Al₂O₃ (M).

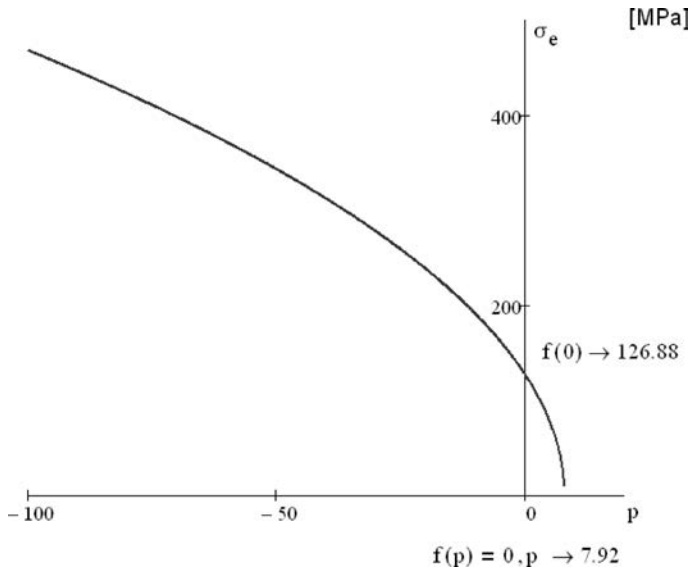


FIG. 10. A half-parabola, being the representation of the Burzyński failure criterion for the MMC composite 75%Cr - 25%Al₂O₃ (M) in the coordinates (σ_e, p) .

4. CONCLUSIONS

It is worthy of emphasizing that W. Burzyński proposed the hypothesis which was universal in the sense of energy. Therefore, it can be applied not only to isotropic materials, it is also applicable to different kinds of anisotropic solids revealing, in particular, characteristic asymmetry of elastic range. W. Burzyński presented, also for the first time, the energetic approach to determine the failure criteria for a certain class of orthotropic materials [1]. The issue of yielding condition of orthotropic materials, raised by Burzyński, is worth further studies because of its promising possibilities of application for modern materials.

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THE THERMODYNAMICAL THEORY OF ELASTO-VISCOPLASTICITY FOR DESCRIPTION OF NANOCRYSTALLINE METALS

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The main objective of the present paper is the development of thermodynamical elasto-viscoplastic constitutive model describing the behaviour of nanocrystalline metals. Only *fcc*, *bcc* and *hcp* metals will be covered in this description, because they are the classes of metals for which systematic experimental observation data sets are available. Investigation of the deformation mechanisms is important for understanding, controlling and optimizing of the mechanical properties of nanocrystalline metals. Strengthening with grain size refinement in metals and alloys, with an average grain size of 100 nm or larger, has been well characterized by the Hall-Petch (H-P) relationship, where dislocation pile-up against grain boundaries, along with other transgranular dislocations mechanisms, are the dominant strength-controlling processes. When the average, and entire range of grain sizes is reduced to less than 100 nm, the dislocation operation becomes increasingly more difficult and grain boundary-mediated processes become increasingly more important. The principal short-range barrier, the Peierls-Nabarro stress, is important for ultrafine crystalline *bcc* metals, whereas in ultrafine crystalline *fcc* and *hcp* metals, forest dislocations are the primary short-range barriers at lower temperatures. Experimental observations have shown that nanosized grains rotate during plastic deformation and can coalesce along directions of shear, creating larger paths for dislocation movement.

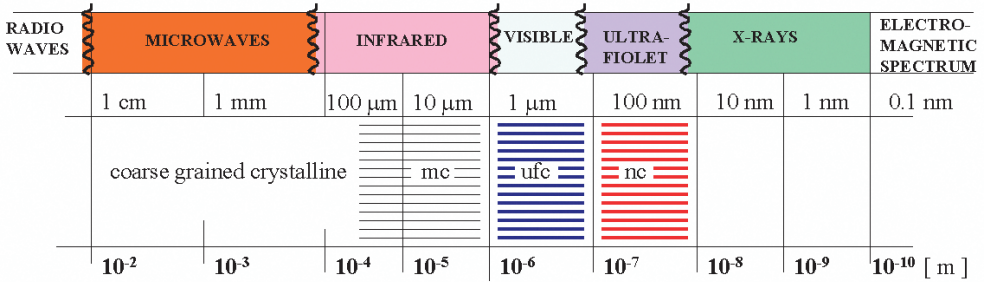
The model is developed within the thermodynamic framework of the rate-type covariance constitutive structure with a finite set of the internal state variables.

The thermodynamic restrictions have been satisfied and the rate-type constitutive equations have been determined. Fracture criterion based on the evolution of the anisotropic intrinsic microdamage is formulated. The fundamental features of the proposed constitutive theory have been carefully discussed.

1. PROLOGUE

Application of nanocrystalline metals, ceramics and composites in modern technology are recently multiplying rapidly. Nanocrystalline materials have been the subject of widespread investigations over the past couple of decades, with significant advancement in their processing as well as understanding of the mechanical properties and novel deformation mechanisms. Nanocrystalline materials are defined as those with their average and entire range of grain size, typically finer than 100 nm; ultrafine crystalline materials are defined as those with grain

sizes of the order of 100 nm – 1 μm ; when one or more dimensions on average are smaller than 100 nm, the material is often termed “a nanostructured material”. Comparison of the average grain size of crystalline materials with length of electromagnetic waves is shown in Fig. 1.



nc – nanocrystalline materials = with their average and entire range of grain size finer than 100 nm
 ufc – ultrafine crystalline materials = with grain size on the order of 100 nm – 1 μm
 mc – microcrystalline materials = with average grain sizes greater than 1 μm
 ns – nanostructured materials = with one or more dimensions on average smaller than 100 nm

FIG. 1. Comparison of the average grain size of crystalline materials with length of electromagnetic waves.

The main objective of the present paper is the development of thermodynamical elasto-viscoplastic constitutive model describing the behaviour of nanocrystalline metals. Only *fcc*, *bcc* and *hcp* metals will be covered in this description, because they are the classes of metals for which systematic experimental observation data sets are available.

Experimental observations and physical foundations concerning the behaviour of nanocrystalline metals under quasistatic and dynamic loading are discussed. Analysis of strength, ductility, strain rate sensitivity, temperature dependence, strain-induced anisotropy, anisotropy of microdamage processes, microshear and macroshear banding, have been presented. Investigation of the deformation mechanisms is important for understanding, controlling and optimizing the mechanical properties of nanocrystalline metals.

Based on experimental observations we can suggest that intrinsic microdamage processes in nanocrystalline metals depend very much on the strain-rate effects. A microdamage process is treated as a sequence of nucleation, growth and coalescence of micro(nano)voids or micro(nano)cracks. The spacing of dimples, however for nanocrystalline metals, is considerably larger than the grain size in their specimen, cf. MEYERS *et al.* [24]. It is important to note that a microdamage process in nanocrystalline metals, is of a very anisotropic nature.

A set of internal state variables $\boldsymbol{\mu} = (\epsilon^p, \boldsymbol{\xi}, \boldsymbol{\alpha}, d)$ consists of two scalars and two tensors, namely the equivalent inelastic deformation ϵ^p , the second-order

microdamage tensor ξ with the physical interpretation that $(\xi : \xi)^{1/2} = \xi$ defines the volume fraction porosity, the residual stress tensor (the back stress) α and d – the mean grain diameter. The equivalent inelastic deformation ϵ^p describes the dissipation effects generated by viscoplastic flow phenomena, the microdamage tensor ξ takes into account the anisotropic intrinsic microdamage mechanisms on internal dissipation, the back stress tensor α aims at the description of dissipation effects caused by the kinematic hardening, and d describes the dynamic grain growth during intensive deformation process.

2. EXPERIMENTAL OBSERVATIONS

2.1. The behaviour of nanocrystalline metals under quasistatic loadings

Grain size is known to have a significant effect on the mechanical behaviour of materials. The yield stress for metals is increasing when the grain size is decreasing.

The compressive stress-strain curves for ultrafine-grained and nanocrystalline Cu, Fe, Ni and Ti are shown in Fig. 2, cf. MEYERS *et al.* [25]. It is observed that work hardening saturates at a very low plastic strain. This is a strong predictor for shear instability, since there are three key elements dictating shear localization: thermal softening, which favors shear localization, and strain-rate sensitivity and work hardening, which oppose shear localization. For nanocrystalline *bcc* metals, the three effects drive shear band formation, and it is indeed prevalent.

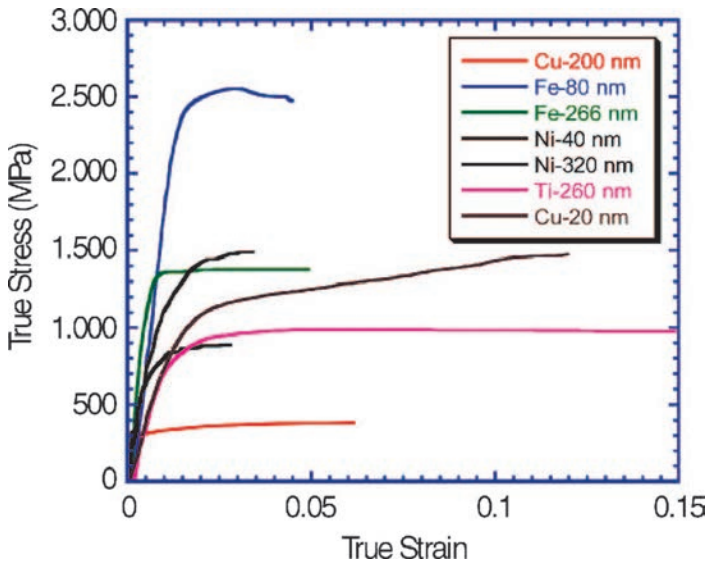


FIG. 2. The compressive stress-strain curves for ultrafine-grained and nanocrystalline Cu, Fe, Ni and Ti (data from several sources), cf. MEYERS *et al.* [25].

Figure 3a shows an engineering stress-strain curve of nanocrystalline Cu (the average d is 54 nm) after RT milling for 5 h following the LN₂T milling, cf. CHENG *et al.* [4]. The material exhibits a 0.2% offset yield strength of ~ 688 MPa. Since the cross-sectional area remained approximately uniform along the gage length during straining, the engineering stress-strain curve was converted into a true stress-strain curve using a standard formula, Fig. 3b, which illustrates an elastic-nearly perfectly plastic behaviour with a total strain of 0.06. The stress-strain curve may be divided into three regions. Region I corresponds to elastic deformation. In Region II, some strain hardening is present and the deformation is uniform across the gage length. The subsequent strain-hardening rate is low because the grains are so small, or already saturated with defects, such that dislocation pile-ups and cell structures cannot develop the same way as that known for coarse-grained Cu. This is followed by Region III, where the stress levels off to a nearly perfectly plastic behaviour that can lead to shear instabilities.

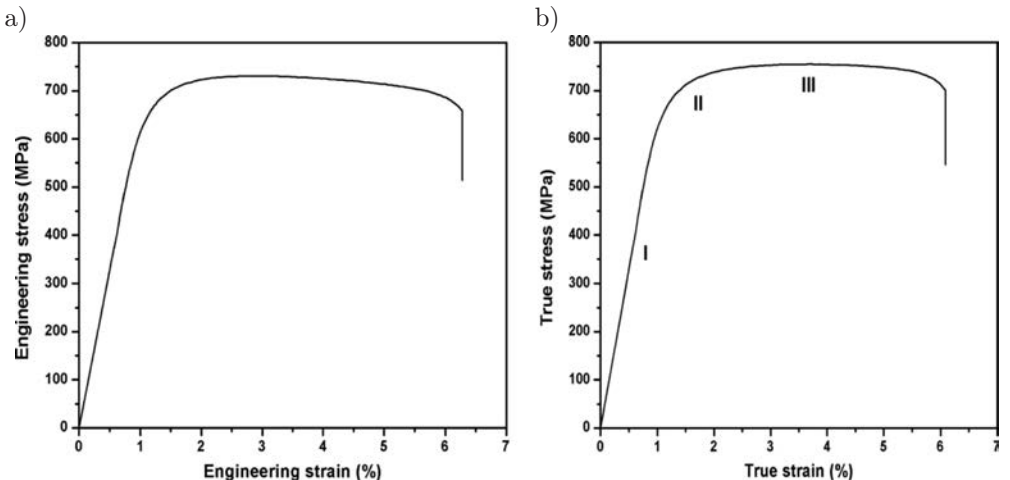


FIG. 3. Tensile engineering (a) and true (b) stress-strain curves of nc-Cu at RT. The strain rate is 10^{-4} s^{-1} . The samples were ball-milled at LN₂T for 3 h and RT for 5 h, cf. CHENG *et al.* [4].

WANG and MA [52] investigated experimentally cryo-rolled UFG Cu (with sizes of grains in the 200–300 nm range). The tensile engineering stress-strain curve of this Cu is unstable, cf. Fig. 4, and peaks quickly at low strains and then plunges, in sharp contrast to that for coarse-grained Cu presented in the same figure that goes through stages of work hardening.

YOUSSEF *et al.* [60] made experimental observations of artifact-free bulk nanocrystalline Cu with a narrow grain size distribution (mean grain size of 23 nm). From Fig. 5 we can see that this Cu exhibits tensile yielded strength,

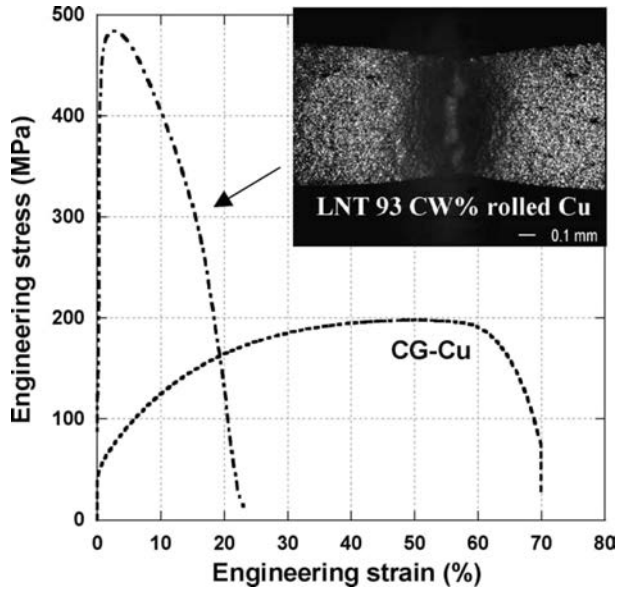


FIG. 4. Tensile engineering stress-strain curve of cryo-rolled Cu compared with that of coarse-grained Cu. The neck developed in the former sample is shown in the inset, cf. WANG and MA [52].

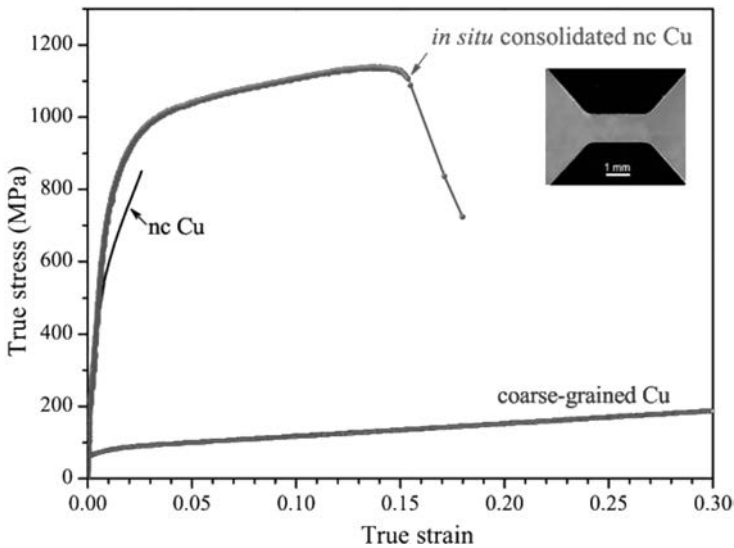


FIG. 5. A typical tensile true stress-strain curve for a bulk *in situ* consolidated nanocrystalline Cu sample (with an average grain size of 23 nm) with high purity and high density in comparison with that of coarse-grained polycrystalline Cu sample (with an average grain size larger than 80 μm) and a nanocrystalline Cu sample (with a mean grain size of 26 nm), prepared by an inert-gas consolidation and compaction techniques, cf. YOUSSEF *et al.* [60].

about 11 times higher than that of conventional coarse-grained copper, while retaining a 14% uniform tensile elongation.

JIA, RAMESH and MA [16] studied the mechanical behaviour of consolidated iron with average grain sizes from tens of nanometers to tens of microns, under uniaxial compression over a wide range of strain rates. The solid lines in Fig. 6

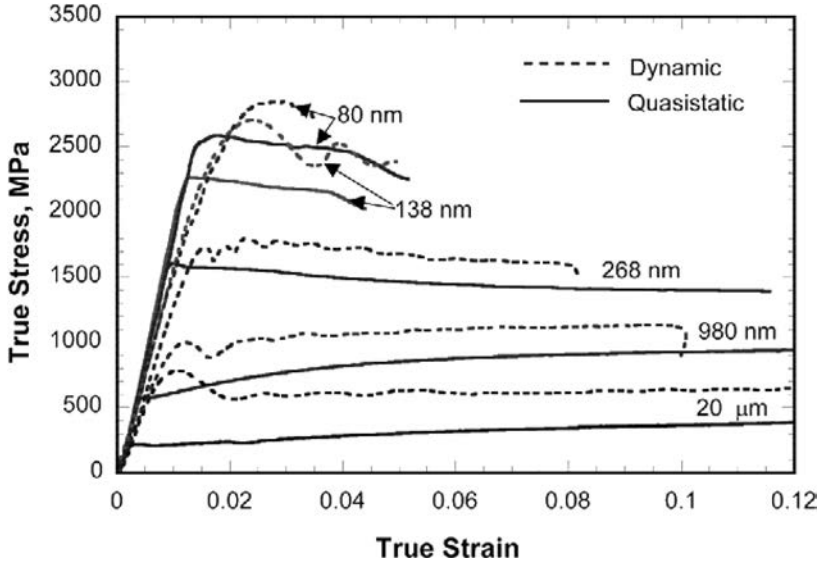


FIG. 6. Typical stress-strain obtained for the consolidated iron under quasistatic ($1 - 4 \times 10^{-4} \text{ s}^{-1}$) and high-strain-rate ($3 - 6 \times 10^3 \text{ s}^{-1}$) uniaxial compression for all of the grain sizes, cf. JIA, RAMESH and MA [16].

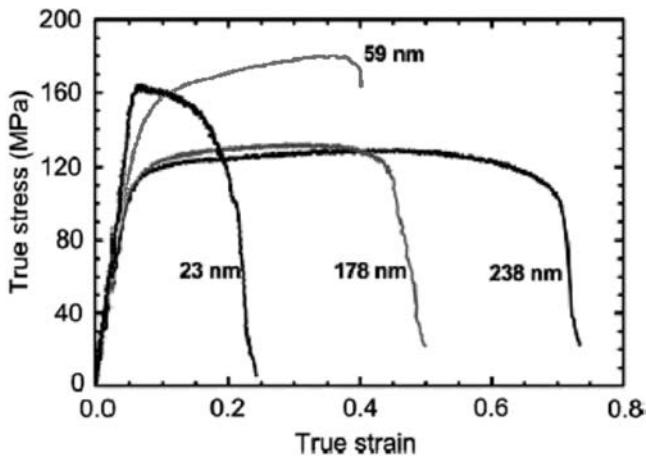


FIG. 7. Reduction of ductility as grain size is reduced for ball milled Zn tested at a constant strain rate of $10^{-4} - 10^{-3} \text{ s}^{-1}$ at room temperature, cf. ZHANG *et al.* [61].

shows the true stress-strain curves of the consolidated iron with various average grain sizes obtained from the quasi-static compression tests. It is apparent that the yield strength (or flow stress) increases with decreasing grain size. Compared with the 20 μm Fe, the strength of the nano-Fe (80 nm) is increased by one order of magnitude. The strain hardening rate (the slope of the stress-strain curve) changes with the grain size. Ductile behaviour is observed at relatively large grain sizes, the samples with grain sizes smaller than 200 nm fail relatively early (the stress-strain curves presented end because of specimen failure).

Figure 7 shows the mechanical response of nanocrystalline zinc samples with different grain sizes. There is a significant drop in ductility as the grain size goes down from 238 nm to 23 nm.

2.2. Yield strength

Strengthening with grain size refinement in metals and alloys, with an average grain size of 100 nm or larger, has been characterized by the Hall-Petch (H-P) relationship, where dislocation pile-up against grain boundaries along with other transgranular dislocations mechanisms, are the dominant strength-controlling processes. When the average and entire range of grain sizes is reduced to less than 100 nm, the dislocation operation becomes increasingly more difficult and grain boundary-mediated processes become increasingly more important.

The dependence of yield stress on grain size in metals is well established in the conventional polycrystalline range (micrometer and larger sized grains). Yield stress, σ_y , for materials with grain size d , is found to follow the Hall-Petch relation

$$(2.1) \quad \sigma_y = \sigma_o + kd^{-1/2},$$

where σ_o is the friction stress and k is a constant. This is an approximation, and a more general formulation is to use a power expression with exponent $-n$, i.e.

$$(2.2) \quad \sigma_y = \sigma_o + kd^{-n},$$

where $0.3 \leq n \leq 0.7$.

The Hall-Petch trends for a range of grain sizes from the micro to the nanocrystalline, are plotted in Fig. 8 for four different metals: Cu, Fe, Ni and Ti, cf. MEYERS *et al.* [24]. Data points have been collected from different sources for grain sizes ranging from a micrometer to the nanometer range. The authors pointed out that the data points in the conventional polycrystalline range for most of these plots overlap while they are more spread out in the nanocrystalline

range. The Hall-Petch curve for the nanocrystalline range clearly shows a deviation from the regular trend in the microcrystalline range. However, there is no clear evidence on the nature of the curves at grain sizes below 15 nm.

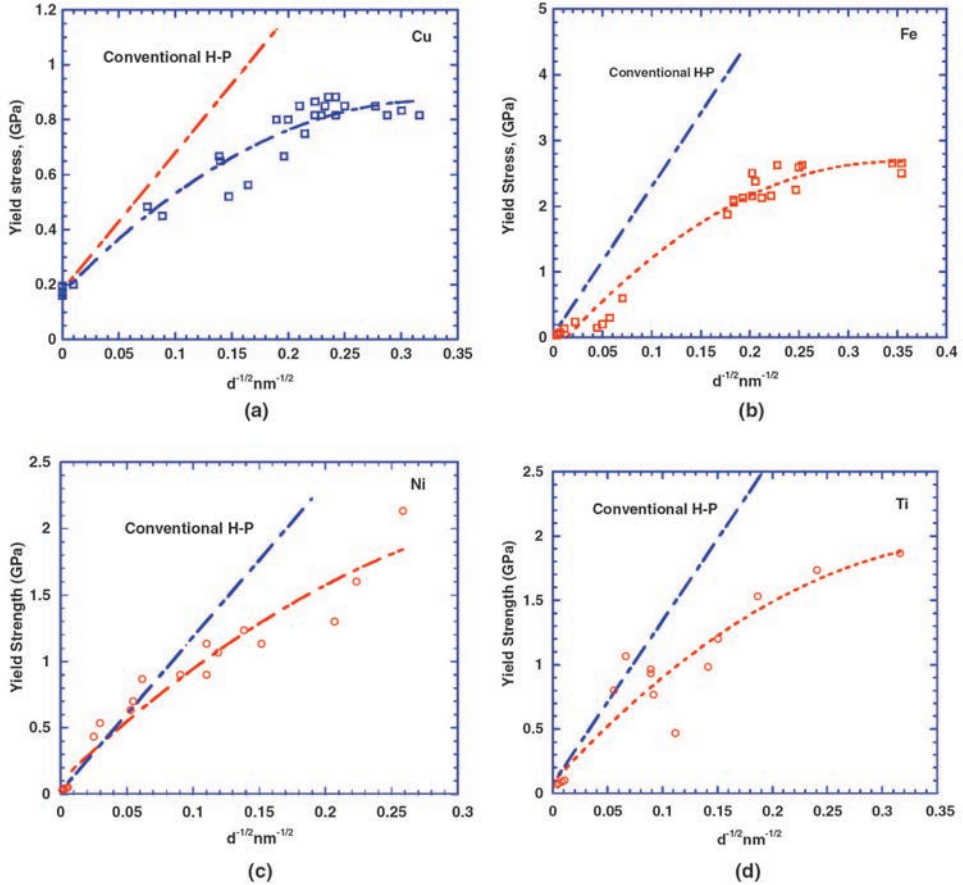


FIG. 8. Plots showing the trend of yield stress with grain size for different metals as compared to the conventional Hall-Petch response: (a) copper, (b) iron, (c) nickel and (d) titanium, cf. MEYERS *et al.* [24].

The difficulty in making realistic predictions of the strength of nanocrystalline metals based on experiments is illustrated by the results presented by MEYERS *et al.* [25] in Fig. 9. This figure represents a compilation of data from several sources for copper. This plot is of the Hall-Petch type, albeit with the abscissa in nanometer units. Although for larger grain sizes the linearity is clear, for grain sizes of 100 nm or larger ($d^{-1/2} > 0.1$ nm $^{-1/2}$) there is no clear trend. While some results show a decrease in the yield stress (negative Hall-Petch slope), some

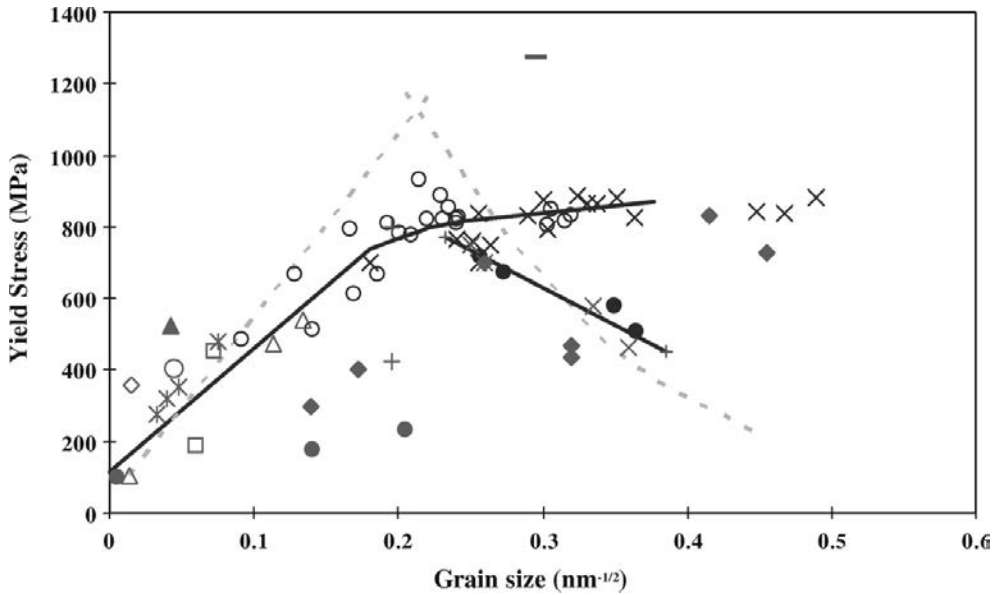


FIG. 9. The compiled yield stress versus grain size plot for copper from various sources ranging from coarse to nanograin size. The plots show different trend as the grain size falls below a critical size, cf. MEYERS *et al.* [25].

show an increase (positive Hall-Petch slope, albeit of a lower magnitude), and others still a plateau.

2.3. The behaviour of nanocrystalline metals under dynamic loadings

SCHWAIGER *et al.* [47] systematically changed the loading rate and strain rate during controlled identification of electrodeposited nc Ni (average grain size ~ 40 nm) and showed that the flow stress of samples was highly sensitive to the rate of deformation. Their results are reproduced in Fig. 10.

WANG and MA [52] for the Cu discussed in Subsec. 2.1 determined (in compression tests) the strain rate sensitivity. Figure 11a shows results of the tests at various fixed strain rates, using several different samples. Figure 11b, instead, uses repeated loading, unloading and reloading to observe effects of strain rate jumps on the flow stress for a given microstructure, so that the deformation process can be separated from the kinetics of microstructure evolution.

Figure 12 displays the engineering stress-strain curves of the 6 h RT-milled nc-Cu tested at different strain rates, ranging from 10^{-4} to 10^{-2} s $^{-1}$, cf. CHENG *et al.* [4]. Compared to Fig. 3, the curve with a rate of 10^{-4} s exhibits a larger elongation ($\sim 12\%$), but at the expense of some strength. This decreased strength can be attributed to a coarsened average grain size (average $d = 62$ nm) as

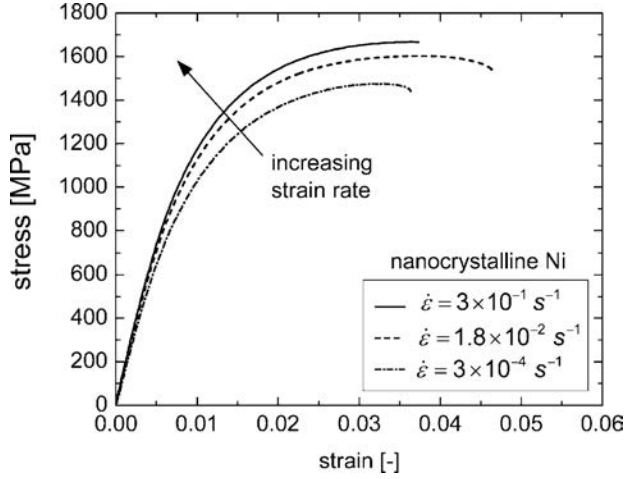


FIG. 10. Engineering stress-strain curves of an electrodeposited nanocrystalline Ni with an average grain size of 40 nm, obtained from tensile tests at different strain rates, cf. SCHWAIGER *et al.* [47].

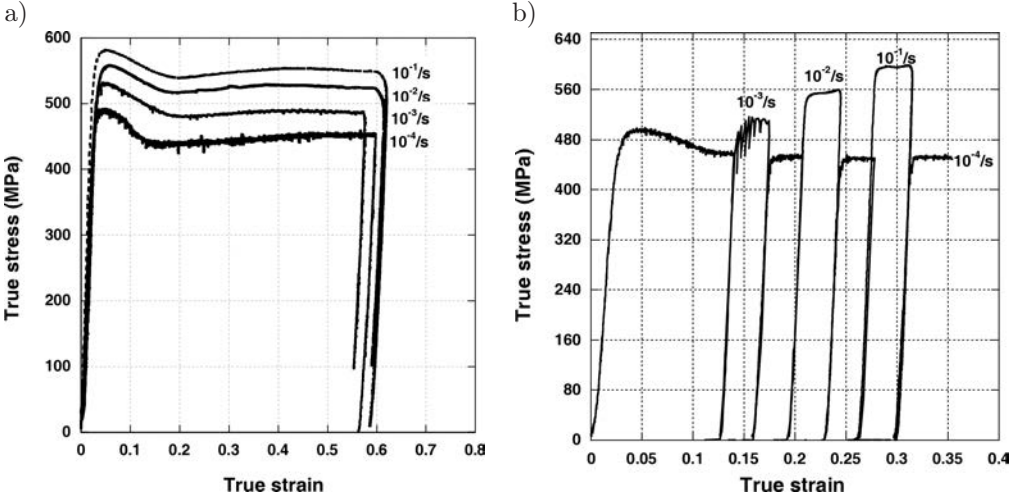


FIG. 11. (a) Compressive true stress-true strain curves of cryo-rolled Cu at several different strain rates and (b) a repeated loading-unloading-reloading compressive test curve for the cryo-rolled Cu to determine the strain rate sensitivity through rate jumps, cf. WANG and MA [52].

a result of the longer RT ball milling. One salient feature in Fig. 12 is the increased strength at higher strain rates. The elongation, however, decreases with the strain rate. The strain rate sensitivity of the flow stress, defined as

$$(2.3) \quad m = \left. \frac{\partial \log \sigma}{\partial \log \dot{\epsilon}} \right|_{\epsilon, \vartheta},$$

where σ is the flow stress and $\dot{\epsilon}$ the corresponding strain rate, was estimated to be ~ 0.027 from the flow stress data at a fixed strain of 2.5%, as shown in the inset of Fig. 12. The magnitude of m seen here represents a fourfold increase over that of conventional coarse-grained Cu ($m = 0.006$), cf. WANG and MA [52].

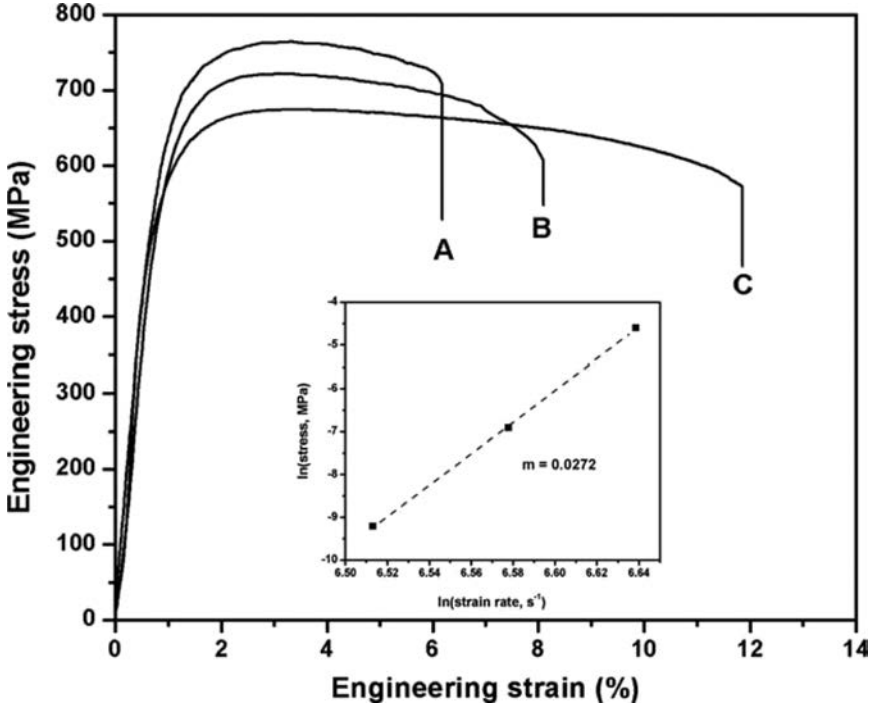


FIG. 12. Tensile test of nc-Cu at RT with different strain rates: A – $\dot{\epsilon} = 10^{-2} \text{ s}^{-1}$; B – $\dot{\epsilon} = 10^{-3} \text{ s}^{-1}$; C – $\dot{\epsilon} = 10^{-4} \text{ s}^{-1}$. The inset is used to estimate the strain rate sensitivity, m . The samples were ball milled at LN₂T for 3 h and RT for 6 h, cf. CHENG *et al.* [4].

Figure 6 (cf. JIA, RAMESH and MA [16]) also shows a set of stress-strain responses at high strain rates of $3 \times 10^3 - 6 \times 10^3 \text{ s}^{-1}$ (the dashed lines), for the consolidated iron for several grain sizes. Strain-rate hardening is evident for all the grain sizes considered. Small influence of the strain rate on the strain hardening (the slope of the curves) is observed, which is typical for *bcc* metals. The ends of the high-rate stress-strain curves for the smallest two grain sizes represent specimen failures. The influence of the rate of deformation on the flow stress is plotted in Fig. 13 for the entire range of grain sizes and strain rates, using a conventional semi-log format, with the flow stresses, corresponding to a fixed strain of 4%.

WEI *et al.* [56] investigated the plastic deformation behaviour of ultrafine-grained (UFG) bulk Fe. The UFG microstructure (grain size) ~ 300 and ~ 150 nm,

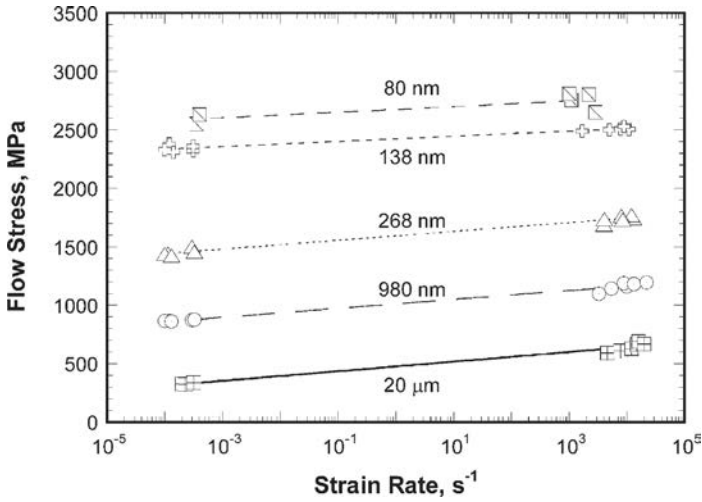


FIG. 13. Rate dependence of the flow stress of the consolidated iron for each grain size, with the flow stresses plotted at a fixed strain of 4%, cf. JIA, RAMESH and MA [16].

was obtained through combined equal channel angular extrusion (ECAE) and low-temperature rolling (ECAE+R), and confirmed using the transmission electron microscopy.

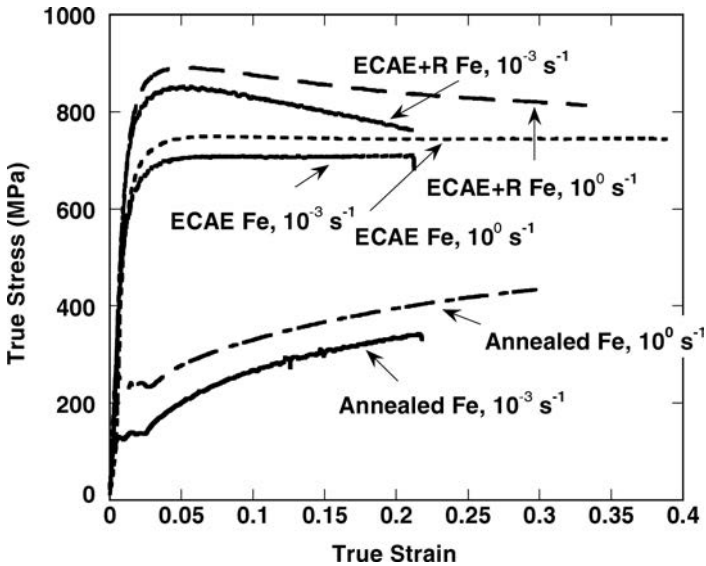


FIG. 14. Quasi-static stress-strain curves under compressive loading for Fe in annealed, ECAE processed, and ECAE+R conditions. Note the significant strain hardening in the annealed Fe which is absent in the SPD processed Fe. Also note the apparently reduced rate dependence in the SPD Fe. The strain rates are given in the figure, cf. WEI *et al.* [56].

Figure 14 presents the true stress-strain curves obtained during quasi-static compressive loading of the annealed Fe as well as the ECAE Fe and the ECAE+R Fe. The annealed material exhibits strain hardening typical for the *bcc* Fe, but the yield strength is higher than the ~ 50 MPa known for high-purity Fe. The ECAE Fe behaves in a nearly elastic-perfectly plastic manner at these strain rates (i.e., little strain hardening is observed). Yield strengths above 600 MPa are observed, with the strength increasing slightly with the strain rate. It is seen that the yield strength of the ECAE Fe is further increased by about 200 MPa after low-temperature rolling (see curves for ECAE+R Fe). Apart from the absence of strain hardening, in this case, some slight flow softening is in fact present.

Figure 15 displays the stress-strain curves obtained under dynamic loadings. The annealed Fe exhibits significant strain hardening to a strain level of 0.2, and after that, the stress-strain curve levels off because of adiabatic heating and subsequent dynamic recovery and recrystallization. After ECAE processing the strength is increased by a factor of approximately 2, accompanied by slight flow softening. In the case of ECAE+R Fe, the yield strength is further enhanced by

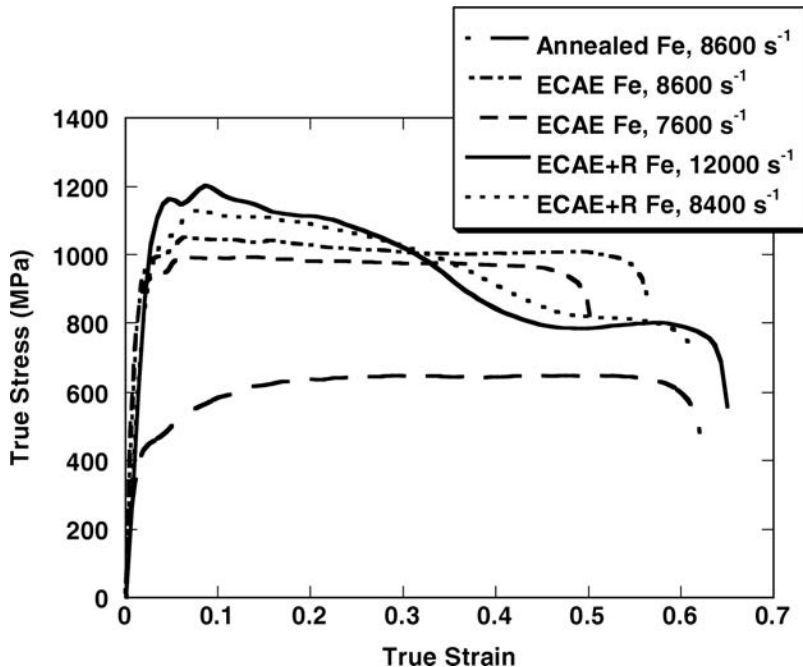


FIG. 15. Dynamic stress-strain curves from Kolsky bar compression tests for Fe in the annealed, ECAE, and ECAE+R conditions. Note the strain hardening in the annealed Fe to a strain of 0.2. The strain hardening is absent in the SPD processed samples. On the contrary, flow softening is observed in these samples, in particular in the ECAE+R state. The strain rates are given in the figure, cf. WEI *et al.* [56].

~ 150 MPa compared to the ECAE Fe. What is striking is that the ECAE+R Fe exhibits much more pronounced flow softening in comparison with the ECAE Fe. Similarly to the ECAE Fe, the rate dependence of the flow stress is reduced compared to the annealed state.

2.4. Strain rate sensitivity and temperature dependence of yield strength

The strain rate and temperature dependence of strength have been found to be rather in nc or ns metals, more so than it had been realized previously.

The engineering parameter measuring strain-rate sensitivity m is one of the key engineering parameters for controlling and understanding of the deformation in nanocrystalline metals. For example, a highly strain rate sensitive material is expected to resist localized deformation and hence be ductile.

With decreasing grain size, an increase in the strain rate sensitivity has been found to be common for nanocrystalline *fcc* metals, cf. DAO *et al.* [7]. For the behaviour of nanocrystalline *bcc* metals the situation is different, and more complex, cf. JIA *et al.* [16].

DAO *et al.* [7] summarized the variation of m as a function of grain size, d , for Cu samples, based on literature data. The m value increases with a decrease of grain size from the micron to the submicrometer scale (m from 0.06 to about 0.02), followed by an obvious rise when the grain sizes are reduced to below a couple of hundred nanometers.

In the nanoscale regime, m is much larger than that reported for conventional Cu. The current suggestion is that the highly localized dislocation activity (e.g. dislocation nucleation and/or dislocation de-pinning) at the grain boundaries, leads to an enhanced strain-rate sensitivity for nanocrystalline metals.

The overall strain-rate dependence of a material is influenced by dislocation activity, grain boundary diffusion and lattice diffusion. For microcrystalline *fcc* metals, the rate-controlling process is the cutting of forest dislocations resulting in a low strain-rate sensitivity. With d decreasing into submicrometer and nanocrystalline regime, forest cutting mechanisms subside since now it is the large number of grain boundaries and/or subgrain boundaries that serve as obstacles to the dislocation motion. The rate-limiting process is increasingly influenced by dislocation-grain boundary interactions.

There have been indications that the elevated strain rate sensitivity m in nc/ns metals plays a role in improving the strength/ductility properties. The strength increase due to the rate sensitivity is seen in Fig. 10.

The general trend of increasing of the strain-rate sensitivity m occurs with decreasing d for *fcc* nanocrystalline metals from the known data for Cu in Fig. 16a and Ni in Fig. 16b, as well as in Fig. 17a for Cu and Ni. For *bcc* nanocrystalline metals, the strain-rate sensitivity m shows an opposite dependence on grain size.

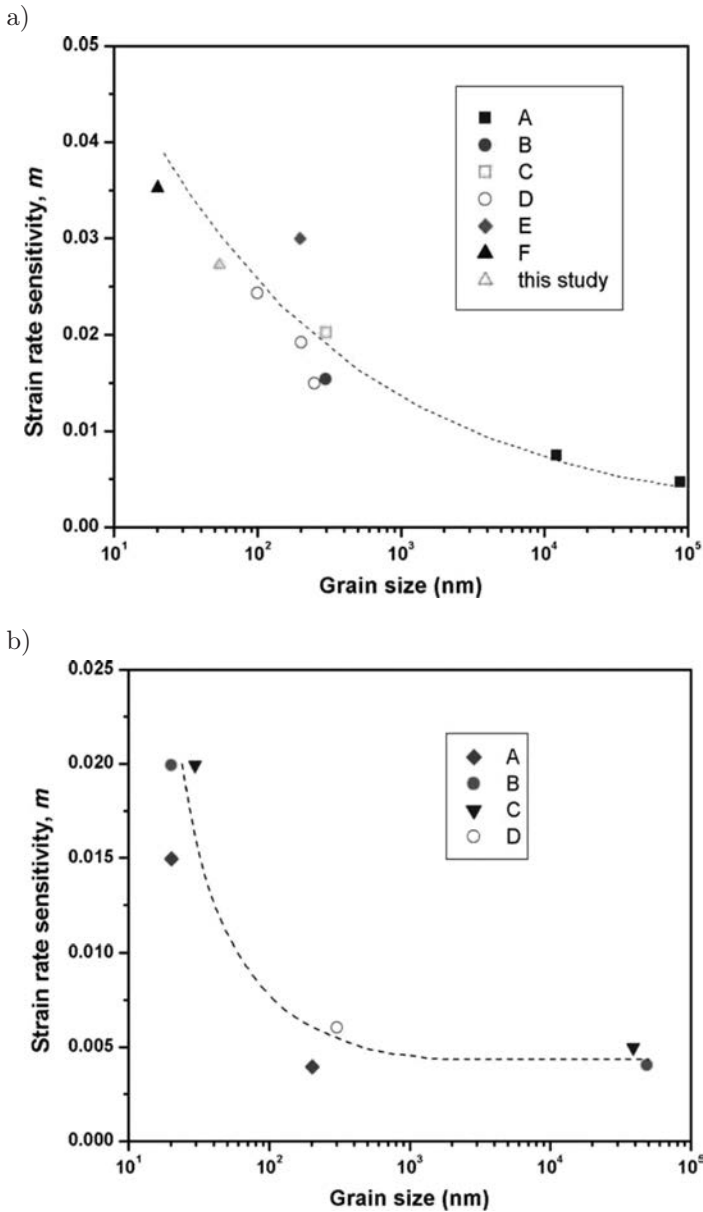


FIG. 16. Summary of strain rate sensitivity m vs. grain size d for Cu (a) and Ni (b) from literature. In both cases, m shows an increasing trend as d decreases. The dashed curves serve as guide to the eye, cf. CHENG *et al.* [4].

The result for Fe, Ta, V and W are shown in Fig. 17b. Similar results have been obtained in experimental observations of UFG/nc-Fe by JIA *et al.* [16] these data are illustrated in Fig. 18, and by WEI *et al.* [56], see Fig. 19.

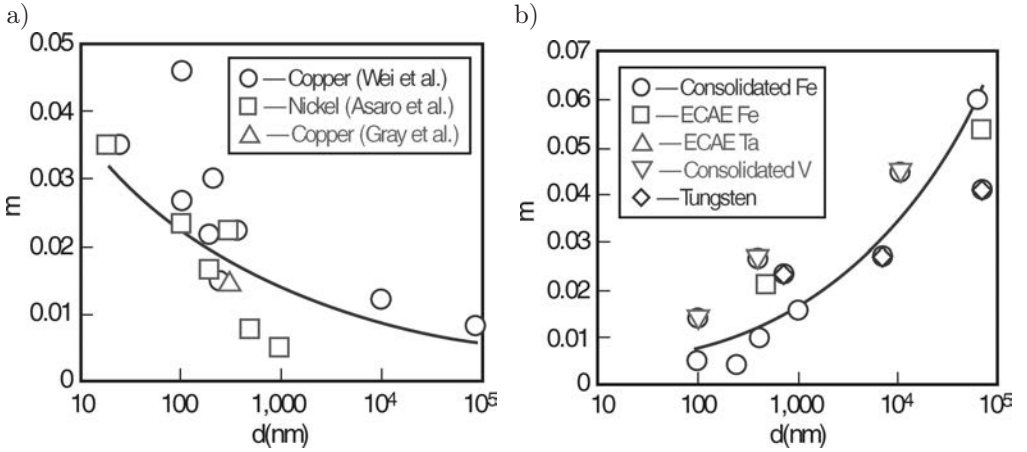


FIG. 17. The strain-rate sensitivity as a function of grain size for: a) *fcc* metals: Cu and Ni; b) *bcc* metals: Fe, Ta and W, cf. MEYERS *et al.* [25].

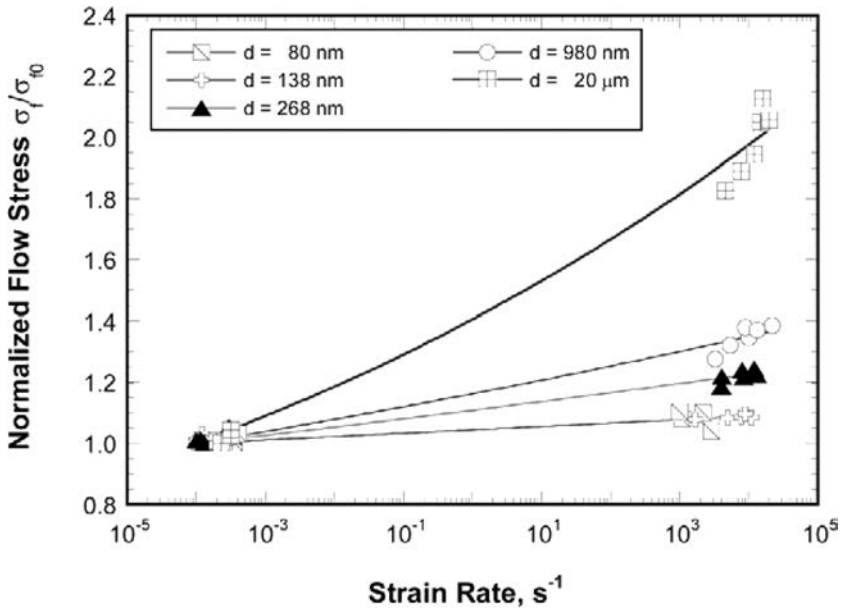


FIG. 18. The variation of the normalized flow stress σ_f/σ_{f0} with strain rate for various grain sizes. Note the reduction in the effective rate sensitivity at the smaller grain sizes, cf. JIA, RAMESH and MA [16].

These important differences for the dependence of the strain-rate sensitivity parameter m on grain size for *fcc* and *bcc* ns-metals are caused by various rate-controlling mechanisms. The rate-controlling mechanism for *fcc* ns-metals is cutting of dislocation forests by a moving dislocation, while for *bcc* ns-metals it

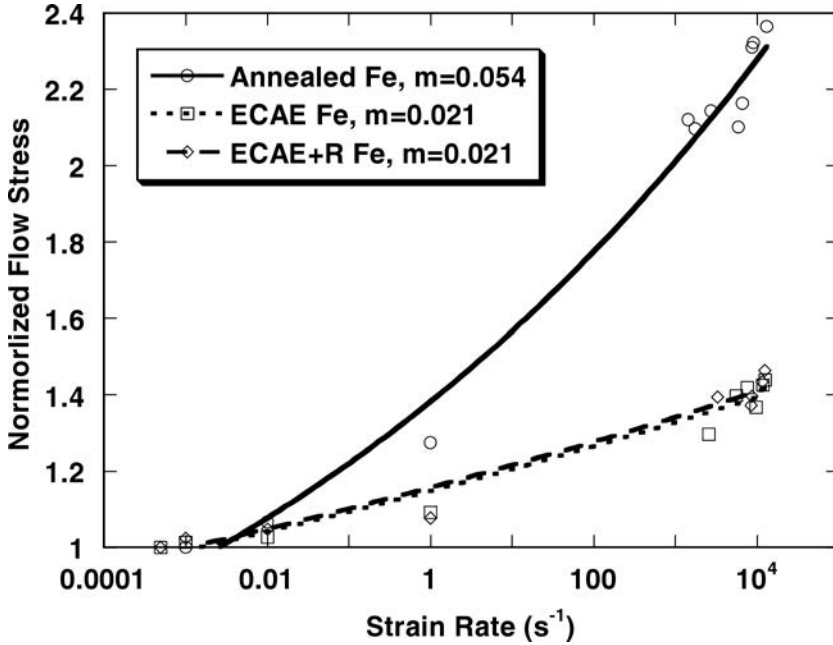


FIG. 19. Rate dependence of different states of Fe. The values of the strain rate sensitivity, m , are given in the figure. Note the substantial reduction in m in the SPD processed Fe in comparison to the annealed state, cf. WEI *et al.* [56].

is the thermally activated motion of screw dislocations by the Seeger kink-pair lateral movement and this is controlled by Peierls-Nabarro stresses.

Very interesting results were presented by WANG and MA [52] for cryo-rolled UFG Cu (with sizes of grains in the 200–300 nm range), cf. Fig. 20. They showed that for the strain-rate range used, the m is 0.03–0.04 which is higher than that for conventional Cu (0.01). We can also observe the important difference of the strain-rate sensitivity parameter m for the load-unload test, in comparison to the simple loading test.

Corresponding to the enhanced strain-rate dependence, there is also a more pronounced temperature dependence, arising from the thermally activated deformation mechanisms controlling the plastic flow. A rapid increase in yield strength has been documented for nc Ni and nc Cu, when the deformation temperature is lowered to below the room temperature. This feature could be useful for cryogenic applications.

CHENG *et al.* [4] reported strong temperature dependence of the flow stress *in situ* consolidated nanocrystalline Cu and explained the results in terms of the thermally activated deformation mechanism operative in the nanocrystalline grains. In Fig. 21 we observe the large jump in the yield strength from RT to 77 K.

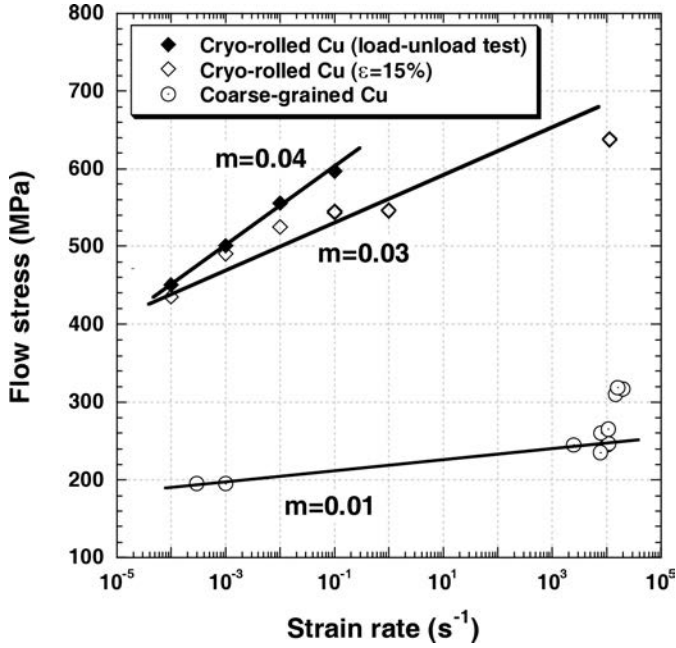


FIG. 20. Flow stress vs. strain rate plot for the cryo-rolled Cu compared with that for conventional Cu. The strain rate sensitivity m has been determined from double-log plots (not shown), cf. WANG and MA [52].

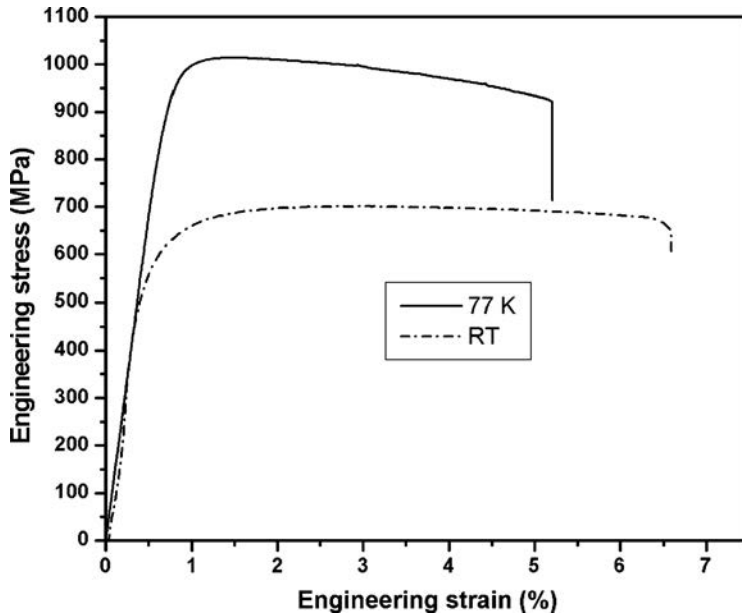


FIG. 21. Tensile test of nc-Cu at RT and 77 K, with a strain rate $\dot{\epsilon} = 10^{-4} s^{-1}$; the samples were ball-milled at LN_2T for 3 h and RT for 6 h, cf. CHENG *et al.* [4].

EBRAHIMI *et al.* [11] investigated nickel foils with nano-size grains in tensile tests at room temperature and -196°C . Figure 22 presents the stress-strain curves for two different grain sizes tested at room and liquid nitrogen temperature. Decreasing of test temperature increased the strength significantly. Nickel has a high stacking fault energy and therefore, its strain hardening rate is expected to be relatively temperature insensitive. However, the smaller grain size specimen showed a noticeable increase in the strain hardening rate with reducing the test temperature. The increase in strength was also more significant for the smaller grain size specimen.

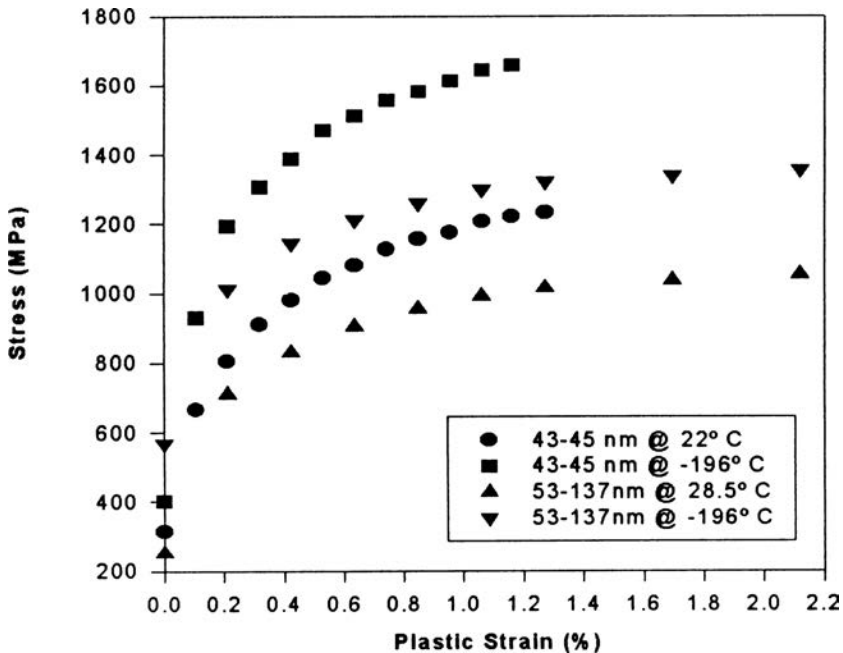


FIG. 22. Effect of grain size on tensile stress-strain curves of nickel at RT and liquid nitrogen temperature, cf. EBRAHIMI *et al.* [11].

2.5. Analysis of microshear and macroshear banding

JIA, RAMESH and MA [16] presented analysis of phenomenology of shear bands in UFG and nc Fe. They observed that the deformation mode of these materials changed dramatically as the grain size was decreased into the ultra-fine-grain range. In the $20\ \mu\text{m}$ -Fe and $980\ \text{nm}$ -Fe, the compressive deformations were uniform at all strain rates, and no shear bands were evident under either the optical microscope or SEM. However, for all smaller grain sizes ($d < 300\ \text{nm}$) the shear band localization development is often observed to occur immediately after the onset of plastic deformation. This has been correlated to changes in strain

hardening behaviour at those grain sizes, since the ability to work hardened by the increase in dislocations density is lost.

Shear bands were observed during both the quasistatic and high-rate deformations for these grain sizes. Comparative optical micrographs are presented in Fig. 23 after low-rate compressive deformations to similar plastic strains, showing (a) the uniform deformations in the 980 nm-Fe and (b) the strongly non-uniform deformations in the 268 nm-Fe. In both cases, the microshear is visible. Figure 23c shows the strongly non-uniform deformations observed in the 268 nm-Fe after high-rate loading to a similar strain as those shown in Figs. 23a and 23b.

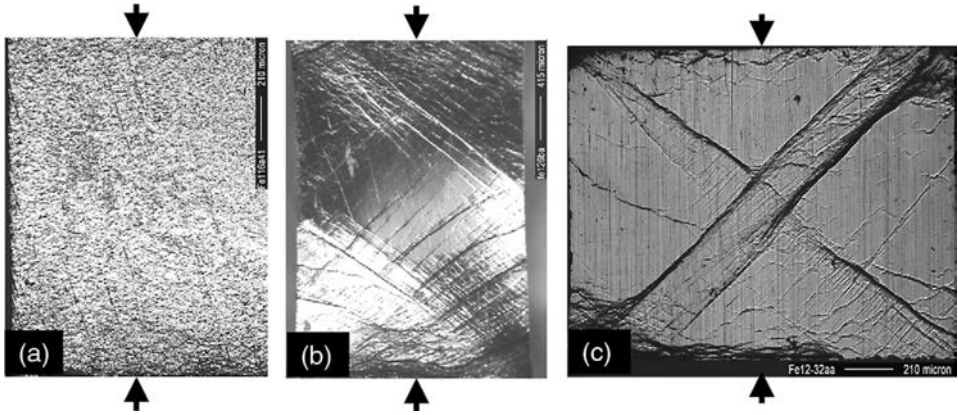


FIG. 23. Change in deformation mode of consolidated iron with grain size for uniaxial compression: a) uniform low-rate deformations with $d = 980$ nm, $\epsilon = 13.7\%$; b) non-uniform low-rate deformations with $d = 268$ nm, $\epsilon = 11.6\%$ and c) non-uniform high-rate deformations with $d = 268$ nm, cf. JIA, RAMESH and MA [16].

The process of macroshear banding that develops during a quasistatic experiment can be observed in Fig. 24, which shows a single area (far away from the edges) of a 268 nm-Fe specimen at nominal plastic strains of (a) 3.7% and (b) 7.8%. The loading axis is vertical in these figures. Authors suggested, basing on observations with optical microscopy and TEM for the deformed UFG and nc-Fe specimens, that large plastic deformations are developed within the bands. Thus, it appears that the process of macroshear banding in this material involves the nucleation of new bands, propagation along the shear plane, increase in width (broadening) and increase in strain (flow) within the band.

Figure 25a shows a high magnification view of a simple band with well-defined boundaries (this band was observed at a nominal plastic strain of 0.3%, just after yield in the 268 nm-Fe). The measured width of the macroshear band is ~ 16 μm and the shear strain in the band is $\sim 25\%$ (nearly two orders of magnitudes higher than the nominal specimen strain).

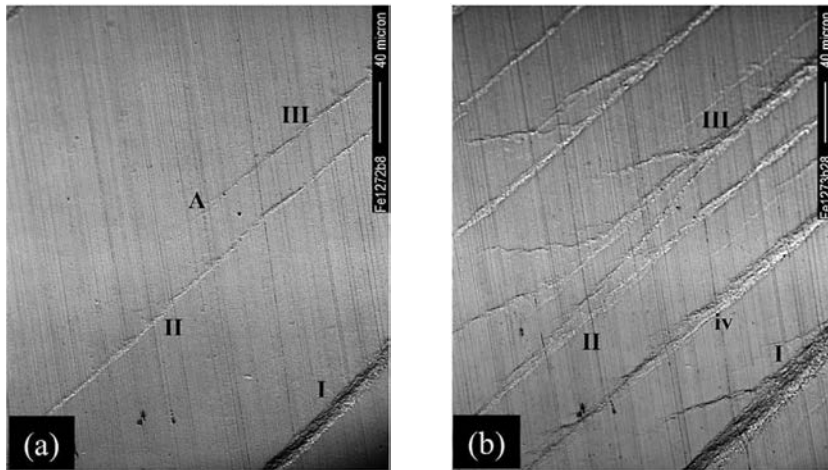


FIG. 24. Evolution and development of shear bands in 268 nm-Fe. Observations of shear bands at the same location at different nominal strain levels: a) 3.7%; b) 7.8%. Loading axis is vertical. Note the development of new shear bands, the broadening of existing shear bands, and the propagation of a shear band tip, cf. JIA, RAMESH and MA [16].

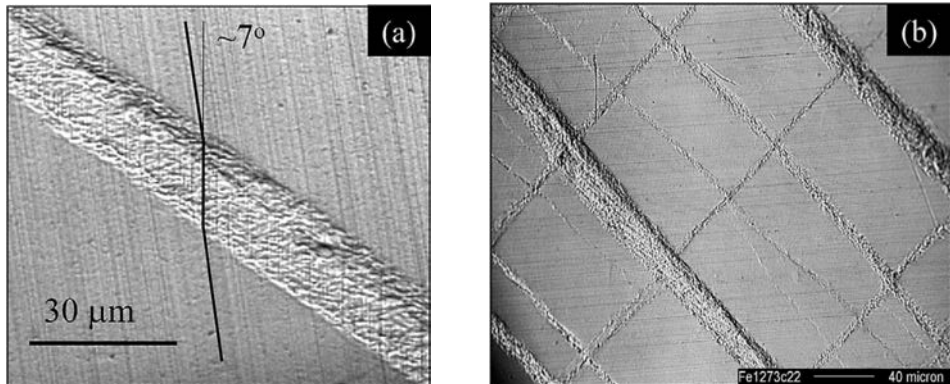


FIG. 25. a) Shear strain developed in shear band immediately after onset of plastic deformation (0.3% plastic strain) in 268 nm-Fe under uniaxial compression, b) Shear band network formed in 268 nm-Fe after uniaxial compression at low rates to 7.8%. Note the compatible deformations at the intersections of the shear bands, cf. JIA, RAMESH and MA [16].

Figure 25b shows a network of macroshear bands at about $\pm 45^\circ$ to the loading axis in a 268 nm-Fe specimen after low-rate loading to 7.8% of the nominal plastic strain. For most of the bands, the two boundaries can be clearly identified, so that the width can be accurately measured. Wider bands were observed in the 268 nm-Fe than in 138 or 80 nm-Fe. An example of the TEM results is presented in Fig. 26, which shows TEM micrographs obtained from within and

outside the macroshear bands in the 110 nm-Fe, deformed in compression at low rates. Figure 26a is a typical picture obtained from within the macroshear band, and shows elongated grains (elongated along the shearing direction) containing high dislocation densities. Figure 26b was obtained from a region outside the macroshear bands.

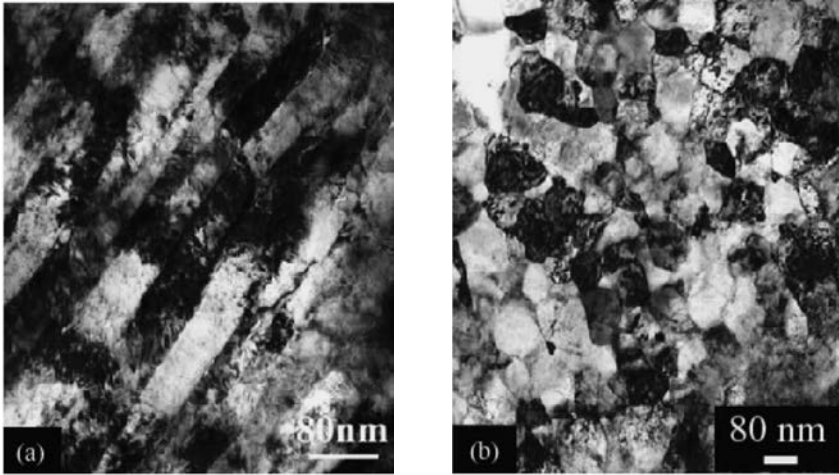


FIG. 26. TEM micrographs taken within (a) and outside (b) a shear band in 138 nm-Fe. Note the equiaxed grains outside the band, and the elongated grains in the band oriented along the shear direction, cf. JIA, RAMESH and MA [16].

WEI *et al.* [56] have been shown that under dynamic loading, the plastic flow mode changes from the uniform deformation of conventional coarse-grained Fe to substantial, localized deformation in UFG Fe. They observed that ECAE processed Fe did exhibit signs of localized deformation under dynamic compressive loading. Figure 27 depicts the concentrated shear in local regions of one of the samples (loading is along the vertical direction). The specimen was loaded to a true strain level of ~ 0.55 at a strain rate of $\sim 7000 \text{ s}^{-1}$. Figure 27a shows the low magnification SEM image of the shear marks on the surface of the sample. Figure 27b shows an overall view of some of the shear lines. More detailed structure of the shear lines is revealed in Fig. 27c.

Figure 28 shows the post-dynamic loading SEM images of the ECAE+R Fe. The specimen was loaded to a true strain level of ~ 0.6 at a strain rate of around 8000 s^{-1} . In this case, macroshear banding is ostensive. The low magnification SEM micrograph in Fig. 28a shows two major macroshear bands. Figure 28b is an enlarged image of the left band in Fig. 28a, with details of the areas indicated by arrows given in Fig. 28c–f. These images demonstrate that the macroshear bands have accommodated highly concentrated strain and local adiabatic temperature

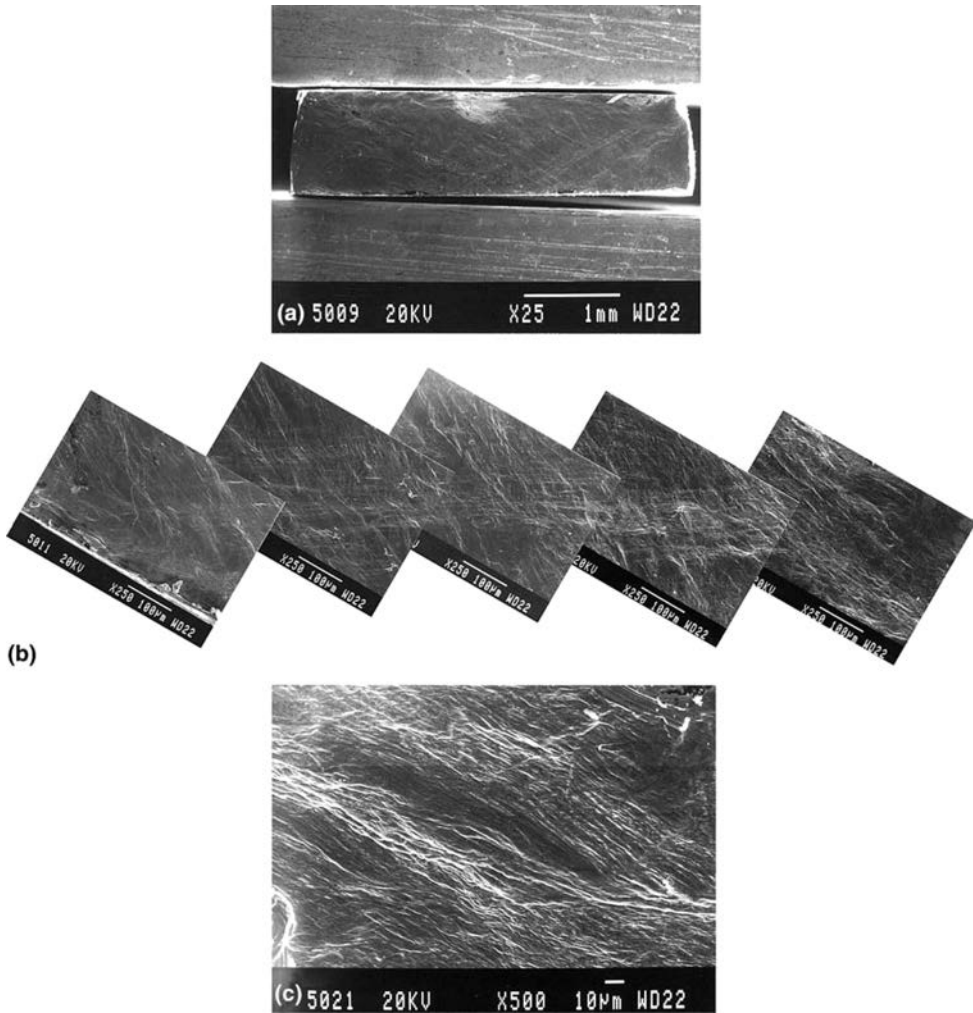


FIG. 27. SEM micrographs of the side face of a dynamically loaded ECAE Fe. a) Overall surface at a low magnification (loading is along the vertical direction and the sandwiched piece is the specimen); b) A collage showing the shear band contrast; c) An enlarged image showing the details of some shear bands. Note that in (b) the specimen has been rotated about 45° clockwise with respect to the loading direction to save space. The specimen was loaded to a true strain of ~ 0.55 at a strain rate of $\sim 7000 \text{ s}^{-1}$, cf. WEI *et al.* [56].

rise. What is more, in Fig. 28d, a layer of wavy structure within the macroshear band can be seen, suggesting rotation and twisting of the material therein under dynamic loading.

Figure 29 shows the etched specimen, where the macroshear band is clearly revealed with a well-defined width of about $15 \mu\text{m}$. The two white lines are added to identify better the macroshear band boundaries in the specimen.

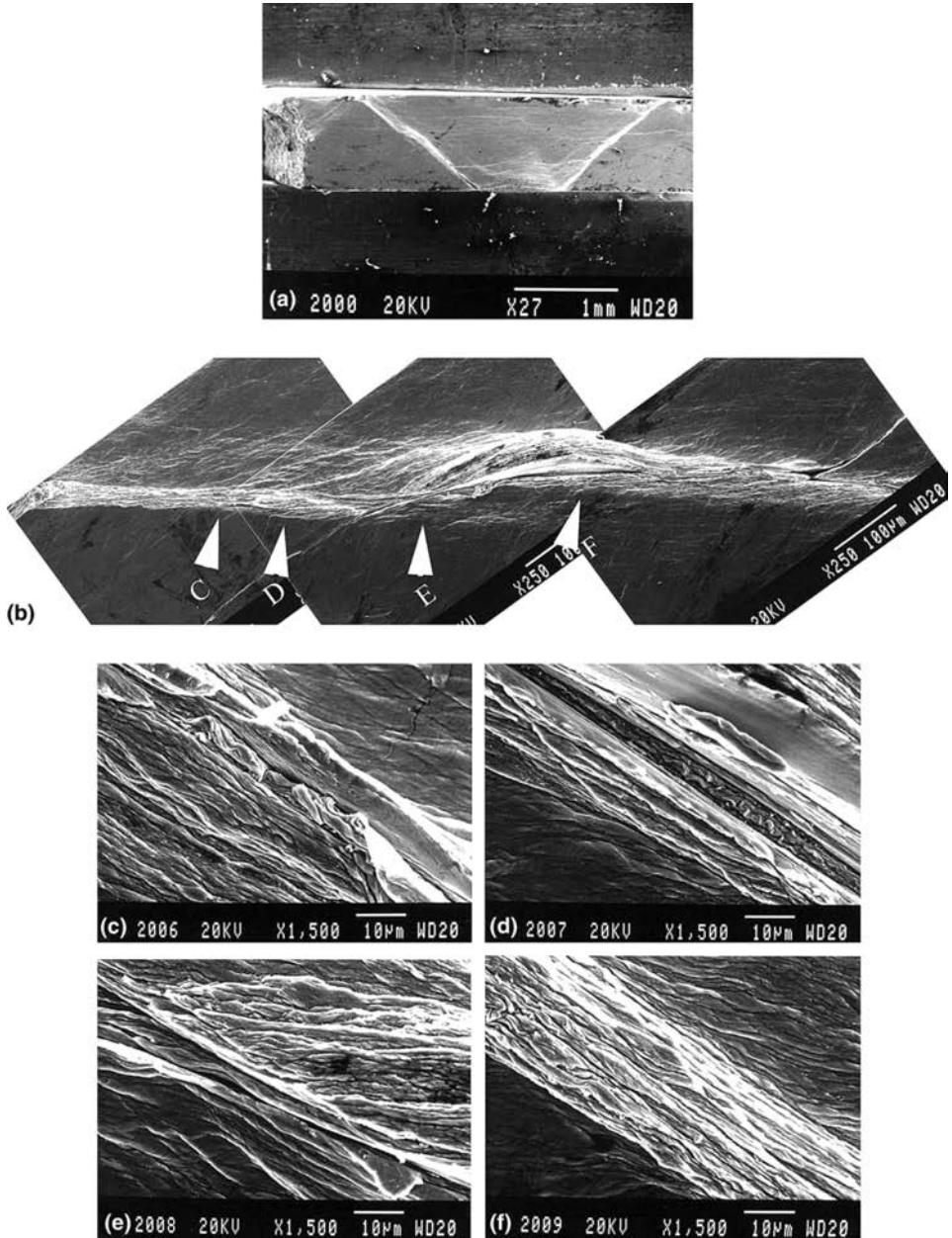


FIG. 28. A low magnification SEM micrograph (a) showing two major shear bands (loading is along the vertical direction, and the sandwiched piece is the specimen). Both the right and the left bands are oriented at an angle of ca. 45° relative to the loading direction.

(b) Enlarged image of the left band in (a), with the details of the areas indicated by arrows given in (c)–(f). Note that in (b) the specimen has been rotated about 45° counter-clockwise with respect to the loading direction to save space. The specimen was loaded to a true strain of ~ 0.6 at a strain rate of $\sim 8000 \text{ s}^{-1}$, cf. WEI *et al.* [56].

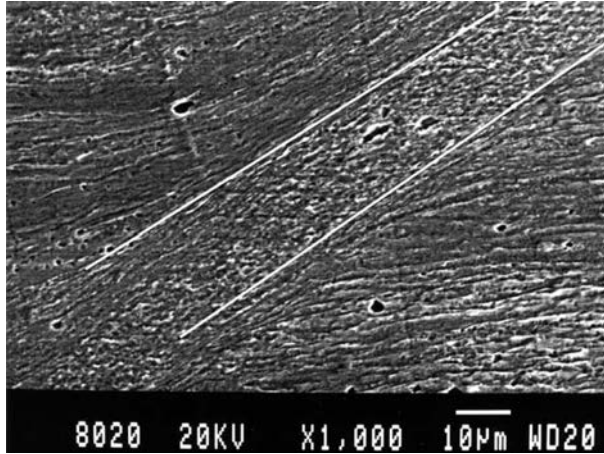


FIG. 29. Post-loading sample was polished and then etched using 5% Nital to reveal the microstructure, where the shear band is clearly seen with a width of about $15\ \mu\text{m}$. The boundaries of the adiabatic shear band have been marked out by a pair of white lines for the ease of identification, cf. WEI *et al.* [56].

CHENG *et al.* [4] observed the mode and evolution of the plastic deformation in nc-Cu. Their tensile tests were terminated before failure. The samples were unloaded, as shown for example at the end of the stress-strain curve of Fig. 30a. Figure 30b is a close view of the surface morphology for the sample unloaded right before the eventual failure, showing a further development of the slanted macroshear zone. The shear offset on the sample edges is obvious. Signs of necking and off-axis banding become visible only in the large stage of plastic deformation. The macroshear zone contains numerous slip markings due to shear bands micrometers in width. At this point a crack begins to develop, causing the onset of load drop. Figure 30c displays the development of the macroshear localization as captured by a high-speed camera for a sample tested at $10^{-4}\ \text{s}^{-1}$. The onset of plastic instability was found to be as early as around 3% of strain, whereas signs of necking appeared only much later (last three pictures).

Figure 31 shows an SEM micrograph of the fracture surface after tensile test. The image clearly indicates ductile fracture as characterized by the dimpled features.

JIA *et al.* [15] investigated deformation behaviour and plastic instabilities of ultrafine-grained titanium. Figure 32 shows a true stress-strain curve for the as-processed UFG-Ti, in comparison with that for the CG-Ti, obtained uniaxial compression at $2 \times 10^{-4}\ \text{s}^{-1}$. At a strain of 6% the flow stress of the UFG-Ti (1.02 GPa) is more than twice that of CG-Ti (0.45 GPa), consistent with the Hall-Patch relationship for conventional Ti. The as-processed UFG-Ti exhibits little strain hardening, with a nearly perfectly plastic behaviour at strain

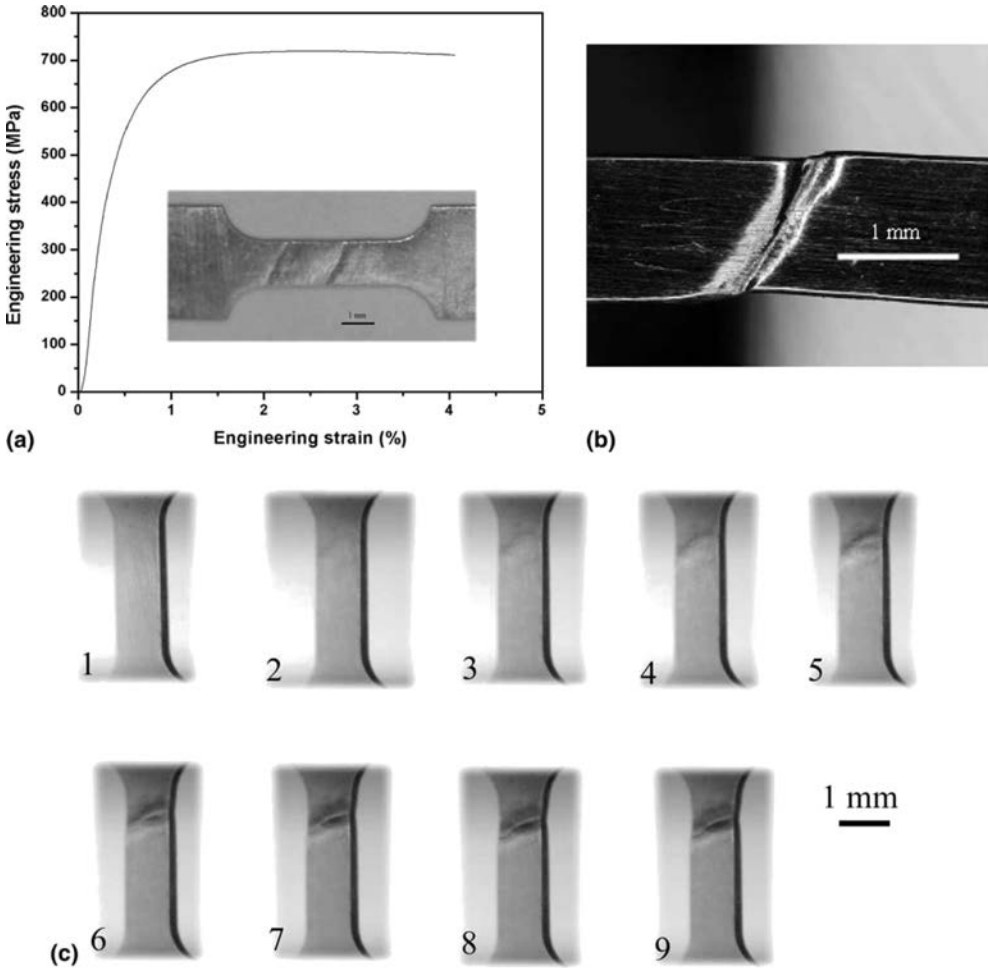


FIG. 30. (a) Tensile test, terminated before failure, of nc-Cu at RT, $\dot{\epsilon} = 10^{-4} \text{ s}^{-1}$. Shear location was observed. (b) An optical micrograph showing the shear zone and shear steps before cracking fails the sample. (c) The evolution of shear localization as captured by a high-speed camera. The corresponding engineering strain is as follows: (1) 0%; (2) $\sim 3.2\%$; (3) $\sim 3.9\%$; (4) $\sim 4.3\%$; and (5)–(9) were taken in the strain range of 4.6–7.0%. These pictures were captured from one sample that was tested at a strain rate 10^{-4} s^{-1} . The use of a high-speed camera avoids the smearing of images during strain. The samples were ball-milled at LN₂T for 3 h and RT for 5 h, cf. CHENG *et al.* [4].

above 5%. In comparison, CG-Ti shows obvious strain hardening. The stress-strain curve for UFG-Ti after annealing is also included in Fig. 32. Compared with the as-processed case, the yield strength of the annealed UFG-Ti is lower. The strain-hardening rate, on the other hand, is higher than the as-processed case for strains less than $\sim 5\%$, which is attributable to the recovery of the

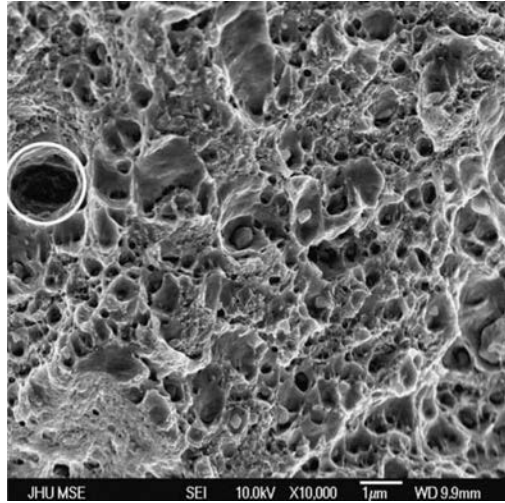


FIG. 31. Fracture surface of nc-Cu after tensile test to failure (cf. Fig. 3). The samples were ball milled at LN₂T for 3 h and RT for 5 h. The white circle shows a pore possibility left-over after consolidation, cf. CHENG *et al.* [4].

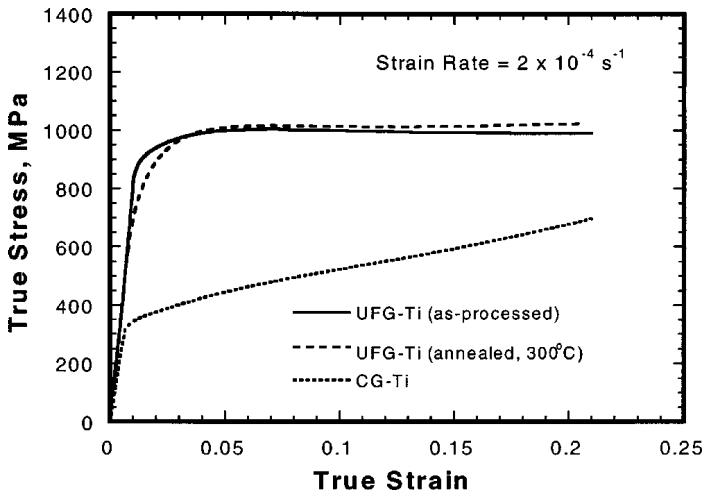


FIG. 32. Typical compressive true stress-strain curves for UFG-Ti (as processed and annealed) at a quasistatic-strain rate, with a curve for CG-Ti for comparison are shown, cf. JIA *et al.* [15].

cold-worked grains. However, due to the small grain size, the capacity for the accumulation of dislocations and twin boundaries and hence strain hardening, remains very limited and far less than that of CG-Ti. The higher strain hardening of the annealed UFG-Ti would also help to overcome softening caused by flaws or damage sites operative in tension. These predictions agree well with the

tension test curves (cf. Fig. 33a) and the necking morphology (cf. Fig. 33b), the authors have observed. The tensile fracture surface also shows clear ductile (cup and cone) features (cf. Fig. 33c), as expected from the large ductility seen in compression.

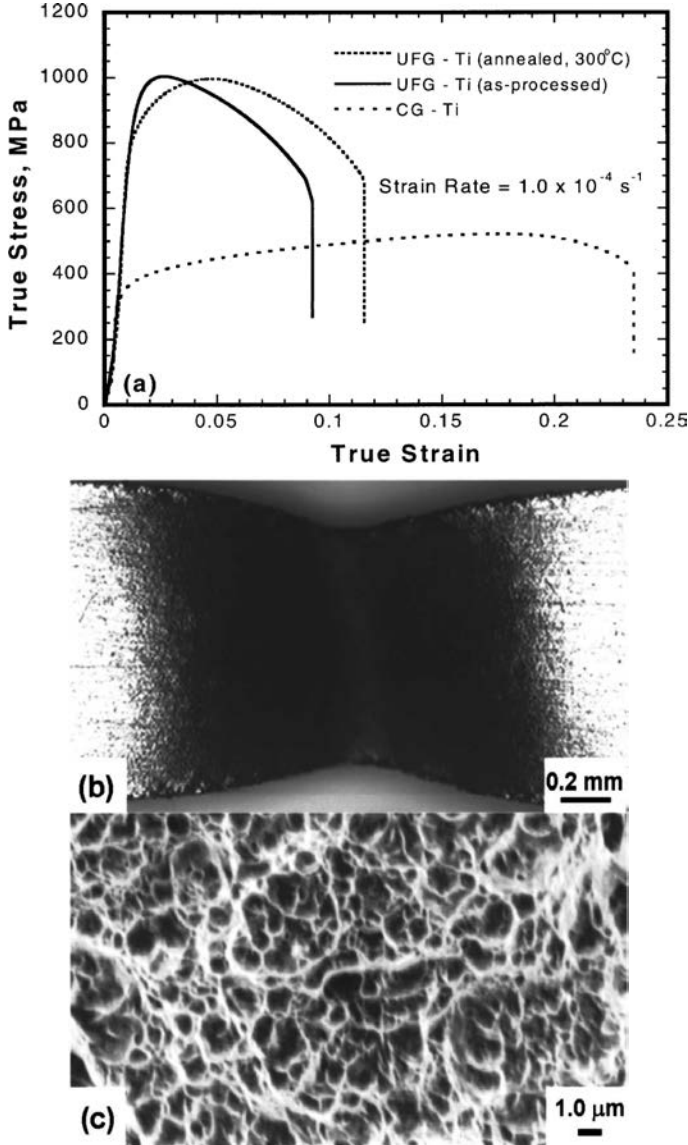


FIG. 33. (a) Tensile true stress-strain curves for as-processed and annealed UFG-Ti, in comparison with that of CG-Ti; (b) Optical micrograph showing necking in the annealed UFG-Ti; (c) Scanning electron microscopy of typical ductile features on the fracture surface of the sample in (b), cf. JIA *et al.* [15].

A typical true stress-strain curve for annealed UFG-Ti at a high-strain rate $4.3 \times 10^3 \text{ s}^{-1}$ is compared with a quasistatic curve in Fig. 34a, together with two corresponding curves for the CG-Ti at similar strain rates. The strain-rates dependence of the flow stress at a constant strain 6% is plotted in Fig. 34b for the strain-rate range from 2×10^{-4} to $9 \times 10^{-4} \text{ s}^{-1}$. If a linear relationship is assumed, the UFG-Ti lines have similar slopes $(\partial\sigma/\partial \log \dot{\epsilon})_{\epsilon}$, indicating that the magnitude

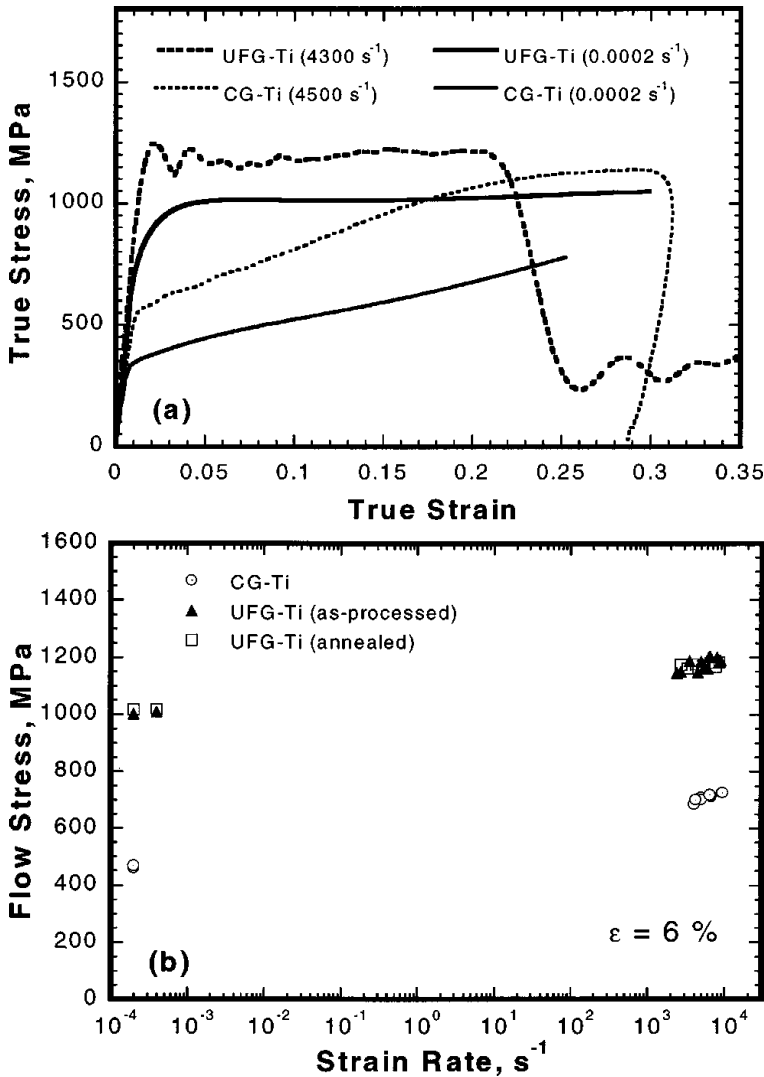


FIG. 34. (a) Comparison of high-strain-rate true stress-strain curves with those at quasistatic-strain rates for both the annealed UFG-Ti and CG-Ti are shown. (b) Strain-rate dependence of the flow stress of UFG-Ti and CG-Ti at a strain of 6% is presented, cf. JIA *et al.* [15].

of the strain-rate enhancement of the flow stress (~ 200 MPa) is similar for these two very different grain sizes. However, due to the elevated strength of UFG-Ti, the strain-rate sensitivity, m , defined as $(\partial \log \sigma / \partial \log \dot{\epsilon})_{\epsilon} = \left(\frac{1}{\sigma} \right) (\partial \sigma / \partial \log \dot{\epsilon})_{\epsilon}$, drops by a factor of 2–3 relative to that for CG-Ti (from 0.025 to 0.009). The value of m affects the necking instability, the material with a higher value of m is more stable. Thus, the low m renders the UFG-Ti less resistant to necking, and contributes to the fast post-necking softening and reduced elongation to the failure observed in Fig. 33.

In the paper (cf. WANG *et al.* [51]) extended the mechanical testing of nanostructured Ti to much larger strains and a wide range of strain rates, in order to understand what factors and how they control the deformation/failure behaviour of UFG-Ti. They paid special attention to the possibility of twinning activities in nanostructured Ti that were previously overlooked. In order to do so, the mechanical properties of commercial purity of nanostructured titanium prepared by equal channel angular pressing plus cold rolling (grain size ~ 260 nm) were systematically characterized. Hexagonal close-packed (*hcp*) ultrafine-grained (UFG) titanium processed by severe plastic deformation (SPD) has gained wide interest due to its excellent mechanical properties and potential applications as biomedical implants.

It is well-established that deformation twinning is an important mode of deformation in coarse-grained (CG) *hcp* materials. Experimental observations confirmed that the nanostructured titanium prepared by SPD contains not only high densities of dislocations but also a significant amount of deformation twins. Such unique microstructural characteristic suggests that the deformation mechanism and failure mode of nanostructured Ti may be different from those of other UFG materials.

Figure 35 shows true stress-strain curves of UFG-Ti with the strain rate in the range of $10^{-4} \text{ s}^{-1} - 10^{-1} \text{ s}^{-1}$. For comparison, the stress-strain curve of a CG-Ti is also included. A considerably elevated strength was observed in UFG-Ti with the yield stress 3–4 times higher than that of CG-Ti. In terms of ductility, UFG-Ti fails after a total compressive strain of $\sim 30\%$, as compared to $\sim 60\%$ in CG-Ti. Careful examinations of the strain hardening behaviour in UFG-Ti and CG-Ti reveal distinctive differences. The CG-Ti demonstrates a strong strain hardening behaviour throughout the test. Such an increasing strain hardening behaviour in CG-Ti is believed to be associated with extensive twinning. In contrast, a different scenario is observed for the plastic flow of UFG-Ti, which exhibits initially strain hardening, with a near perfectly plastic behaviour at strain up to 15%. This is strain hardening behaviour at small strain agrees with previous observations (cf. JIA *et al.* [15]) and is believed to render tensile instability in nanostructured Ti. At large strains, however, a non-negligible strain hardening

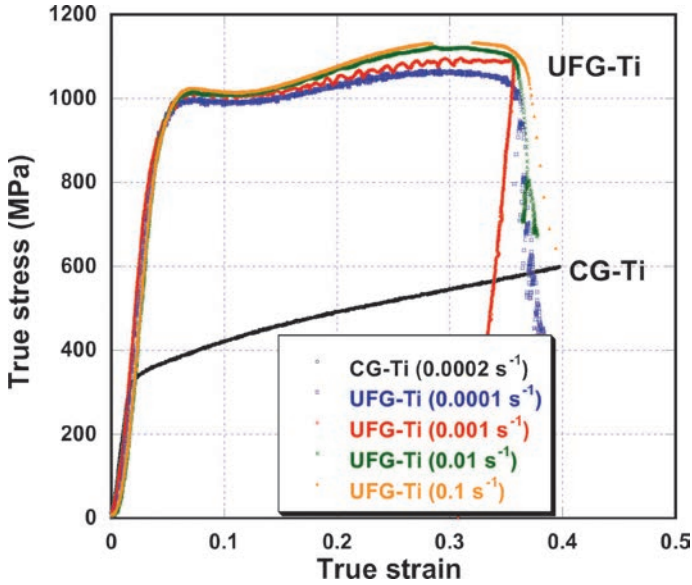


FIG. 35. Room temperature compressive true stress-strain curves of nanostructured Ti and the coarse-grained Ti over strain rate range of 10^{-4} s^{-1} – 10^{-1} s^{-1} , cf. WANG *et al.* [51].

is observed. The strain hardening for UFG-Ti becomes more pronounced when the samples were tested at high strain rates, as shown in Fig. 36.

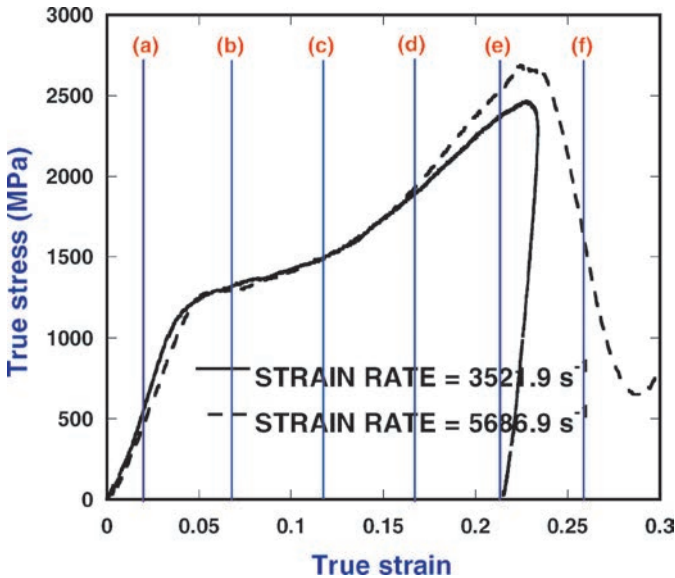


FIG. 36. Dynamic compressive true stress-strain curves of nanostructured Ti at room temperature, cf. WANG *et al.* [51].

Figure 37 displayed sequential TEM bright field images of the as-processed and deformed UFG-Ti. Due to the cold-rolling procedure, many grains in the as-prepared samples exhibit filamentary shape along the longitudinal rolling direction (Fig. 37a), with an average grain size of ~ 260 nm. Dislocation cells and

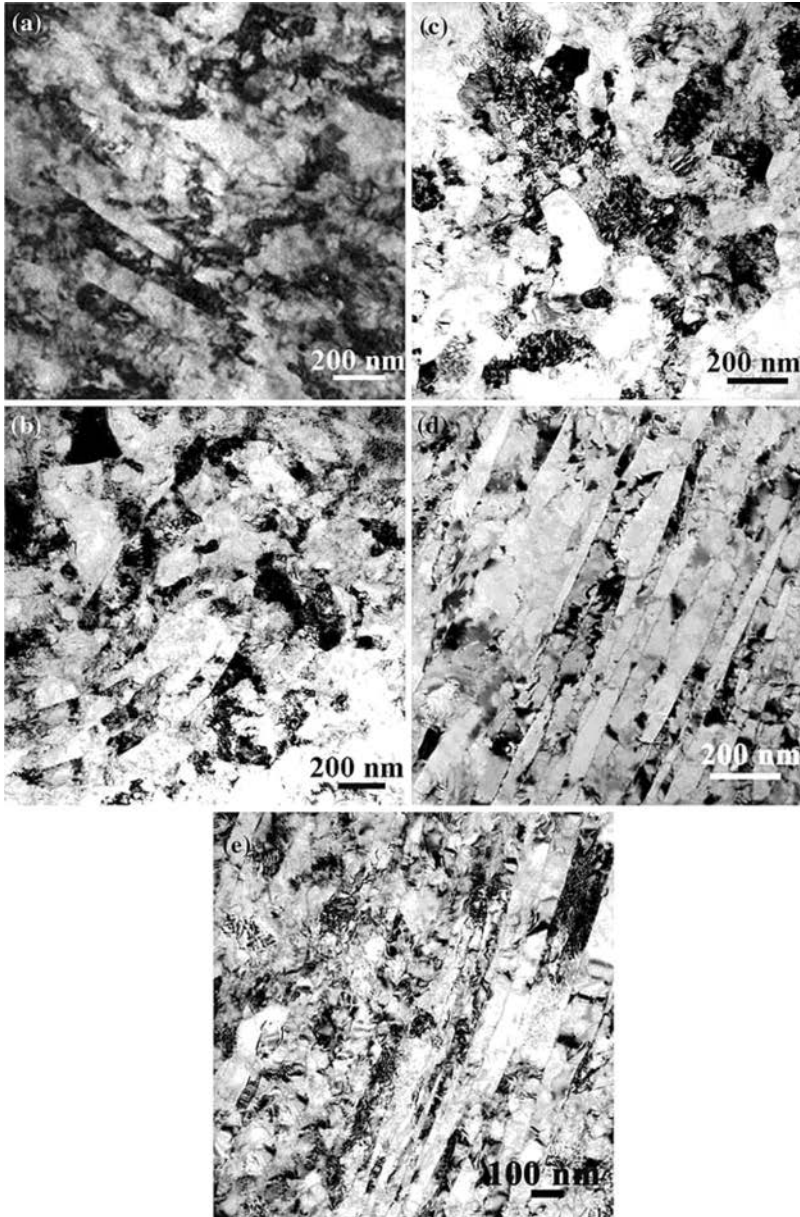


FIG. 37. TEM bright-field images of a) as-processed, b) 8%, c) 30%, d) high strain rate, and e) low-temperature (77 K) deformed UFG-Ti, cf. WANG *et al.* [51].

extremely high density of dislocations are the typical microstructural features. Deformation twins resulting from severe plastic deformation are also visible inside grains with the twin band width of the order of ~ 150 nm. After 10% deformation (Fig. 37b), the ultra-fine-grains become more or less equiaxed, though some grains with straight boundaries and elongated contours are still observable. The average grain size remains approximate constant across the transverse direction. After 30% strain (Fig. 37c), the grains look completely equi-axed (the sample failed at this point). The transformation of grain shape from fibrous type to equi-axial type during the quasi-static compressions implies the change of grain orientations and evolution of the texture, suggesting that the dislocation slip plays a significant role during plastic deformation of UFG-Ti.

TEM examinations in quasi-static deformed samples supports the notion that dislocation slip is the major deformation in nanostructured Ti at slow deformation and room temperature (cf. ZHU *et al.* [62]).

At dynamic loading rates (10^3 – 10^4 s $^{-1}$), however, a different scenario is observed (Fig. 37d). Deformation twin with the band width in the range of 50–100 nm becomes the characteristic microstructural feature. The twin bands in as-processed samples are noticeably wider, suggesting that deformation twinning has become an important event of the high strain rate deformation of UFG-Ti.

Extensive twinning activities were also observed when nanostructured Ti was deformed at cryogenic temperature (77 K), as shown in Fig. 37e, cf. WANG *et al.* [52]. The twin bands observed in low-temperature deformation is narrower (in the range of 10–50 nm) than those seen at high strain rates. This indicates that the twinning activity in nanostructured Ti is closely tied to deformation conditions such as strain rates and temperature.

The strain hardening behaviour has direct influence on the failure mode of UFG-Ti. The development crack during dynamic testing was captured by a high-speed camera in Fig. 38. The alphabetic order of the pictures is the same as those marked on the stress-strain curve of UFG-Ti (Fig. 36), with each letter representing a different strain level. The time interval between two frames is 10 ms, and the camera exposure time for each image is 1 ms. The cracks started to develop in the late stage of deformation (Fig. 36f) where the substantial strain softening has advanced.

In two papers (cf. WEI *et al.* [55] and WEI *et al.* [57]), the authors investigated the quasi-static and dynamic mechanical behaviour (especially dynamic failure) of ultra-fine grained tungsten (UFG W) under uniaxial compression. They used severe plastic deformation (SPD) to refine the microstructure of conventional W with commercial impurity levels. The microstructure was analyzed using TEM, cf. Fig. 39. The UFG W was tested at both quasi-static loading rates (10^{-4} – 10^0 s $^{-1}$) and dynamic loading rates ($\sim 10^3$ s $^{-1}$) using a compression Kolsky bar, cf. Fig. 40.

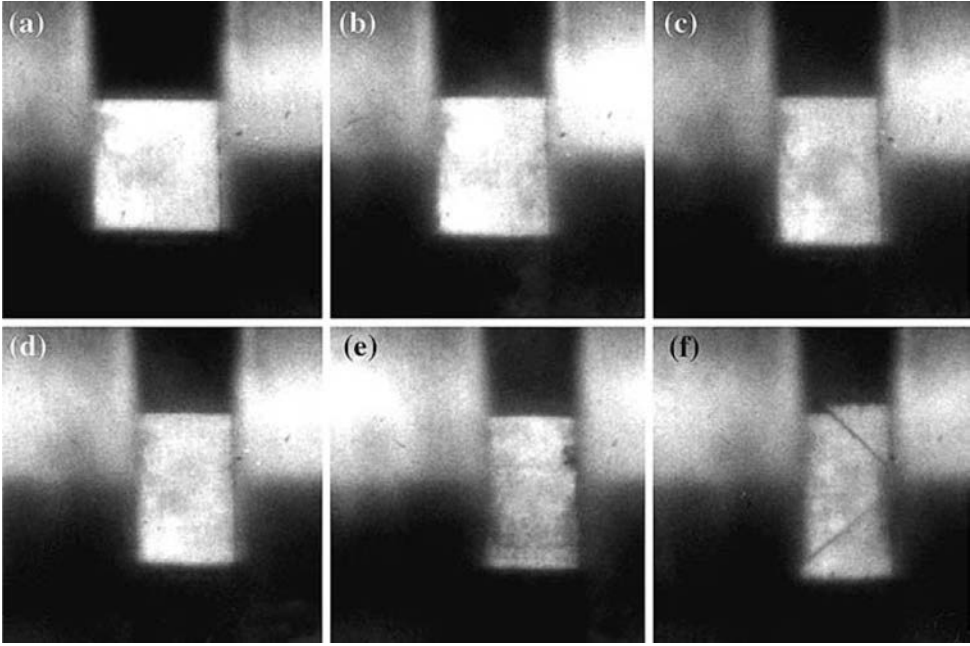


FIG. 38. (a)–(f) *In situ* high speed camera pictures of UFG-Ti during a dynamic compression test. Note the development of cracks with increasing strains, cf. WANG *et al.* [51].

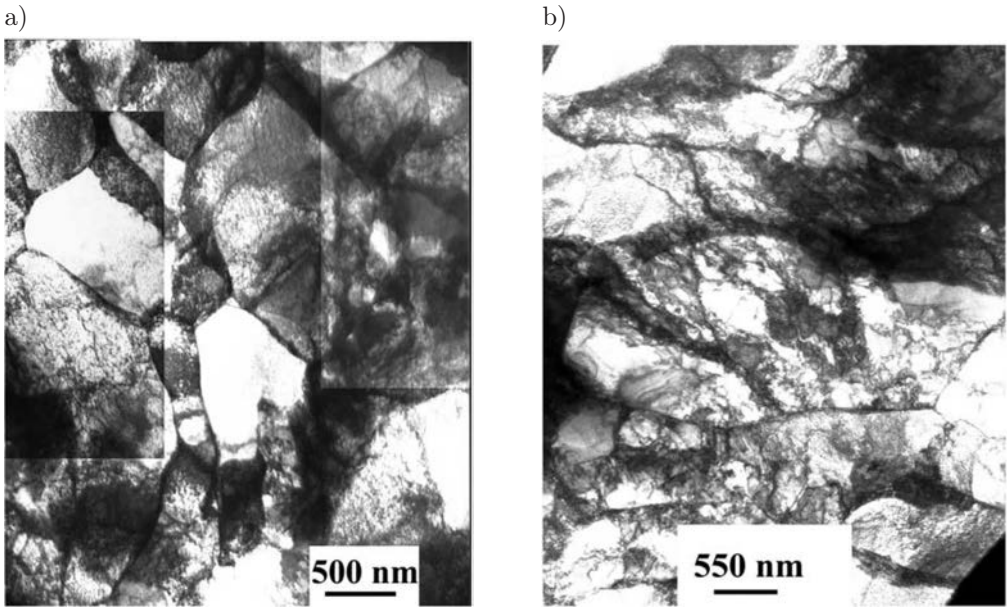


FIG. 39. Transmission electron micrographs of SPD-processed (ECAP + rolling) UFG W (a, b), showing grains and dislocation cell structures refined to sizes of the order of 500 nm, cf. WEI *et al.* [55].

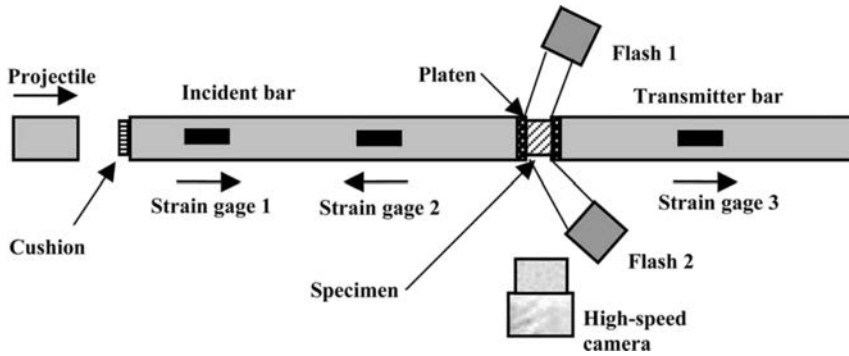


FIG. 40. Schematic of experimental setup for Kolsky bar compressive test with a high-speed camera synchronized with the system. Strain gages 1, 2, 3 are used for the high-speed camera, the incident/reflected and transmitted waves, respectively. The platens are a set of impedance-matched tungsten carbide disks collared with Ti-6Al-4V for the protection of the bars, cf. WEI *et al.* [55].

Figure 41 displays the stress-strain curves under various strain rates (from quasi-static to dynamic) for the ECAP W and W, that was processed by ECAP

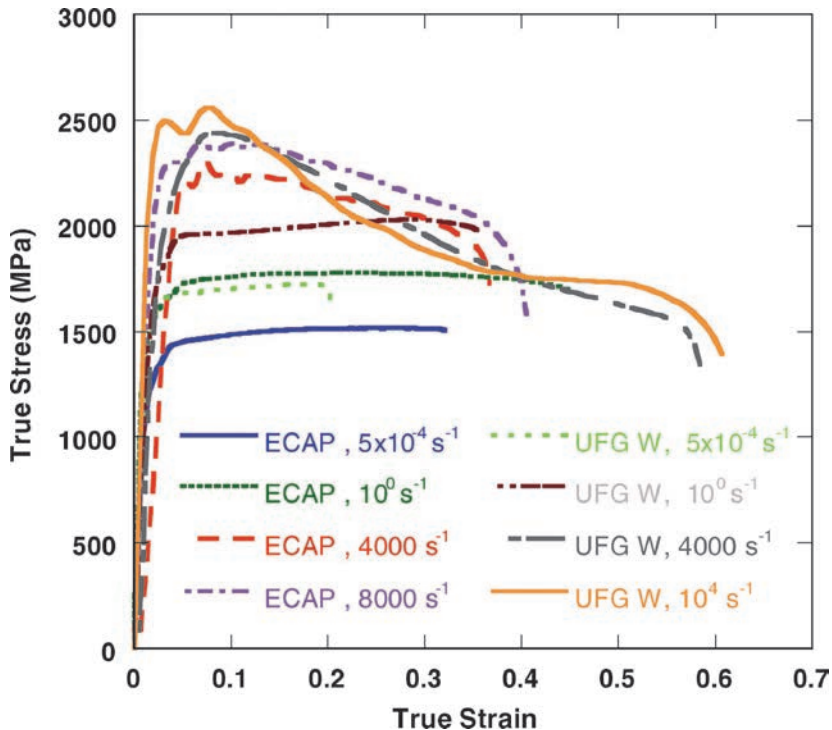


FIG. 41. True stress-strain curves of the ECAP W and the ECAP+CR (UFG) W, under uni-axial quasi-static, and dynamic (Kolsky bar) compressive loading, cf. WEI *et al.* [55].

at 1000°C followed by cold-rolling (referred to hereafter as ECAP+CR W). ECAP at 1000°C (six passes in this case) has elevated the quasi-static flow stress to ~ 1.5 times that of the CGW. ECAP has also markedly reduced the strain hardening. Cold rolling further strengthens the material until the flow stress is nearly doubled compared to the CGW. Under dynamic loading, both the ECAP W and ECAP+CR W exhibit flow softening after small plastic strains, in contrast to the dynamic behaviour of CGW where slight work-hardening is observed. This flow softening is in part due to the accumulation of plastic work that is converted into heat during dynamic loading.

Due to combination of high strength and ductility and the reduced role of stabilizing mechanisms (strain hardening and strain rate hardening), the UFG *bcc* microstructure will have an unprecedented low resistance to softening mechanisms. Plastic flow will be more likely to localize in zones and bands, in which very high strains and strain rates are concentrated. This was indeed observed upon uniaxial high-rate compressive loading of the high-strength UFG-W.

Figure 42a shows an optical micrograph of the UFG-W after loading at a strain rate of 7500 s^{-1} . Two major shear zones, at an angle of approximately 45° relative to the loading direction, are clearly observed. A scanning electron image of a side face, with marked shear zones, is shown in Fig. 42b. Figure 42c shows clearly evidence for the closely bundled flow lines as well as the subsequent incipient fracture along the localized adiabatic shearing.

To investigate the dynamics of the shear banding process and its relation with other phenomena, a high-speed camera was synchronized with the Kolsky bar system. *In situ* high-speed photography shows the evolution of the adiabatic shear band and subsequent fracture of the specimen. Figure 43 displays the corresponding stress-time and stress-strain curves from one such experiment (cf. Figs. 43a and 43b) and show two frames taken at the time or the strain indicated by the square symbols on the curves (cf. Figs. 43C and 43I). The first frame (cf. Fig. 43C) was taken before the plastic deformation occurred. Latter frame (cf. Fig. 43I) shows the well-developed shear bands. The authors pointed out that both post-mortem microscopic observations and in-situ high-speed photography reveal intensive plastic shear localization in the UFG-W, and the letter indicates that the shear localization takes place at a very small strain level. Fracture has also been observed as a consequence of the sever adiabatic shear localization in the UFG-W.

It is important to stress that materials with high flow stress, high thermal sensitivity, small strain hardening and small strain-rate sensitivity are more susceptible to adiabatic shear band localization under dynamic compression.

Thus, it is very important to investigate strain rate sensitivity for UFG-W. Figure 44a displays double-log plots for W with different microstructure (grain

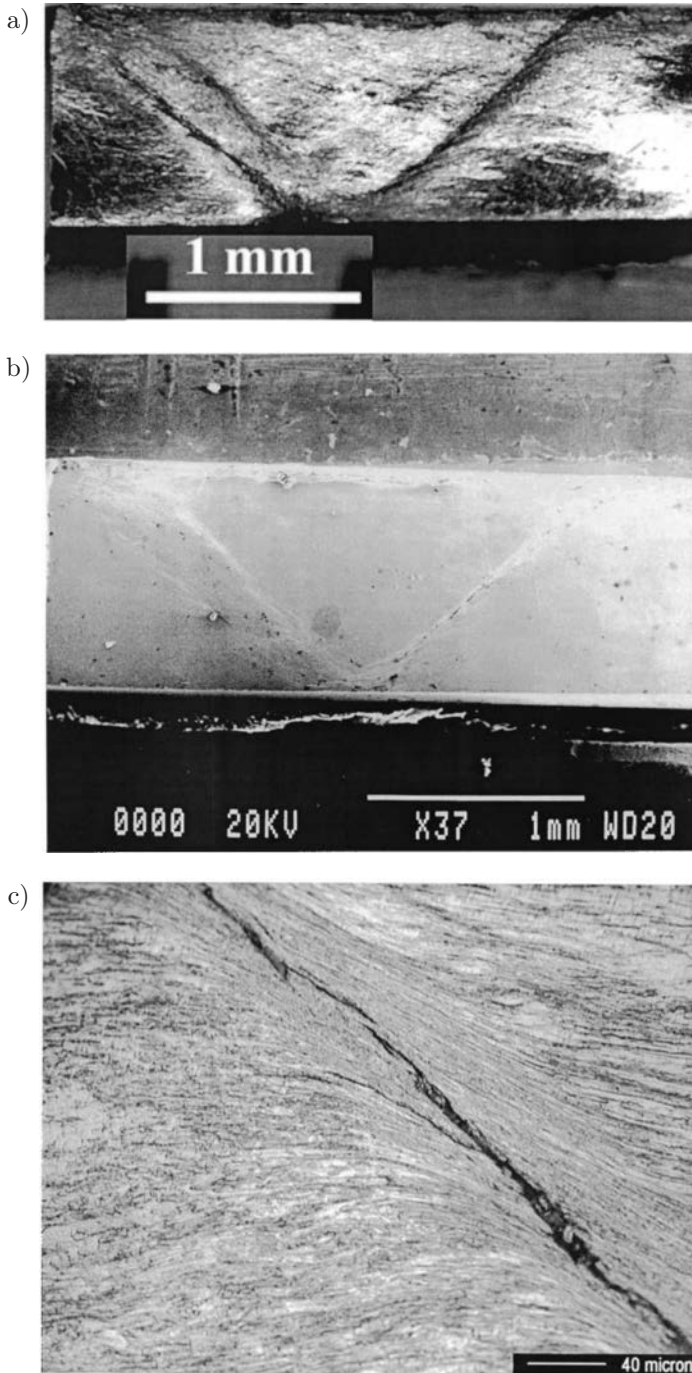


FIG. 42. (a) Optical and (b) scanning electron microscope images showing the shear zones, and (c) the intense concentrated plastic flow with crack initiation inside the shear zone, cf. WEI *et al.* [55].

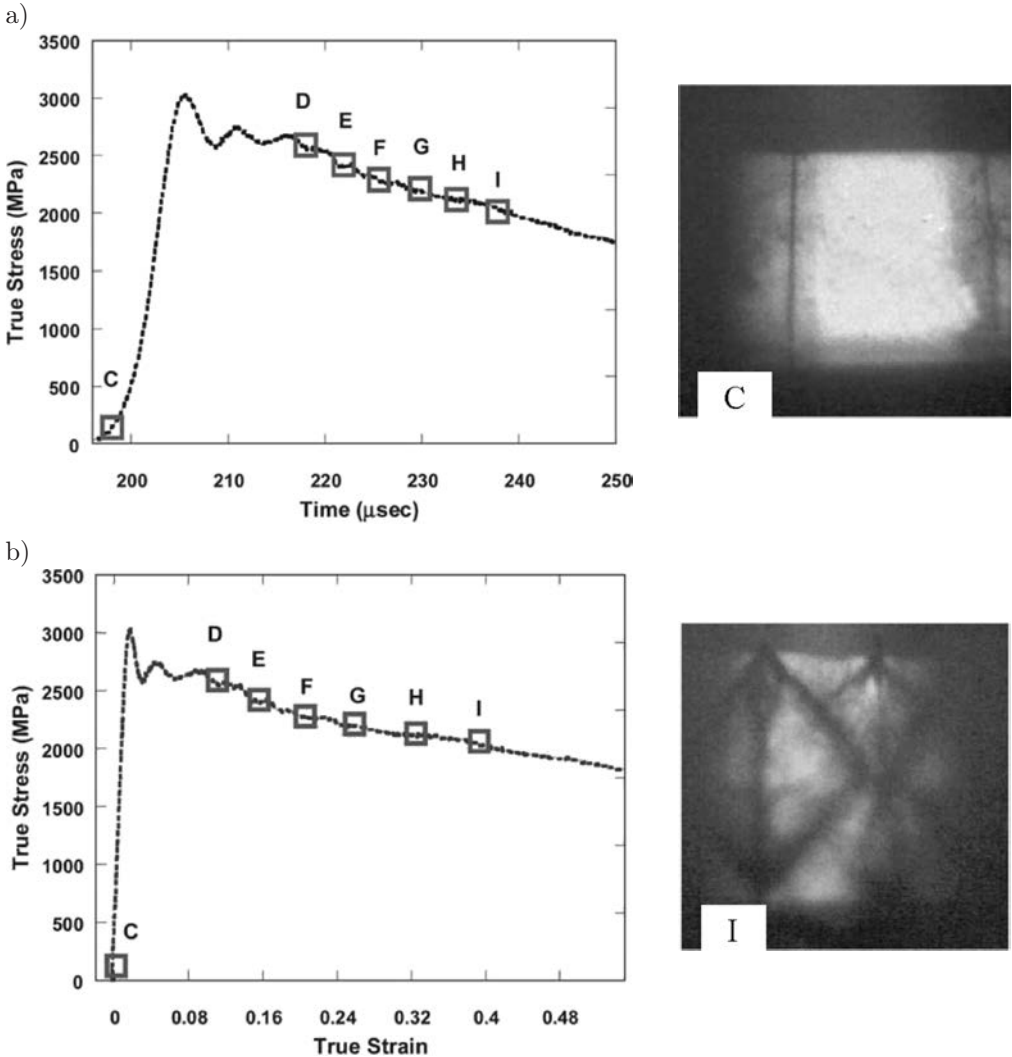


FIG. 43. The stress-time curve (a) and stress-strain curve (b) for a uniaxial compression Kolsky bar test of an SPD UFG W. The square boxes in each figure indicate the time or strain level at which each frame was captured, cf. WEI *et al.* [55].

sizes), showing that the strain rate sensitivity of UFG-W has been cut to half the value of the CG-W (the CG-W of commercial purity has an m of ~ 0.04). Figure 44b includes previous results on *bcc* Fe, Ta and V showing that m can drop substantially when grain size is refined.

Microstructure and mechanical properties of super-strong nanocrystalline tungsten processed by high-pressure torsion have been recently investigated by WEI *et al.* [58].

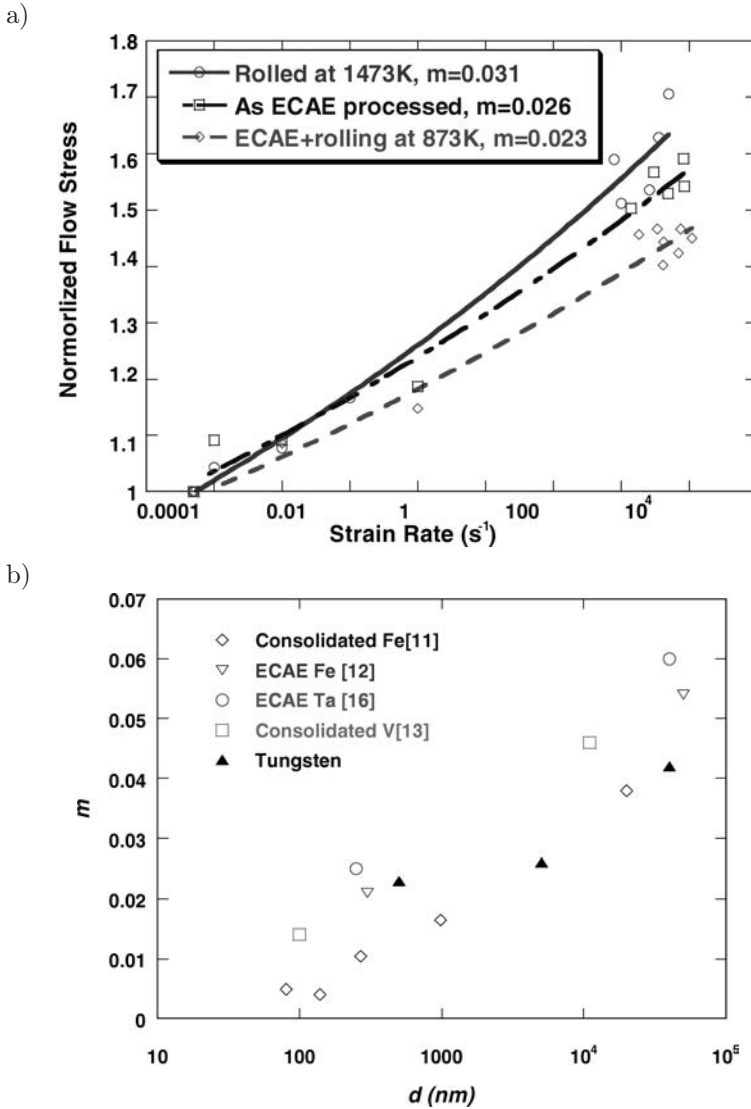


FIG. 44. (a) Flow stress-strain rate curves of W after working under various conditions. The CG W of commercial purity has an m of ~ 0.04 from an early investigation. (b) Strain rate sensitivity, m , is reduced monotonically with microstructure refinement into the UFG regime, in several *bcc* (Fe, Ta, V) metals (open symbols), cf. WEI *et al.* [55].

2.6. Yield strength reduction due to dynamic grain growth

During prolonged mechanical test, or for samples that have very high purity, the high strength may degrade with time. This is due to the large excess energy associated with grain boundaries in nc materials, which is expected to cause

instability in their nc grain size distributions. Evolution towards equilibrium can be driven, or promoted, by stress during deformation process.

Indeed, recent studies have found that indentation induced rapid grain growth in nc Cu and nc Al.

After these initial observations of indentation-induced grain growth in nc Cu and nc Al, grain growth was observed experimentally in nc materials that are deformed under other deformation modes.

Surprisingly, it is found that grain coarsening is even faster at cryogenic temperatures than that at room temperature, cf. DAO *et al.* [7].

2.7. Strain induced anisotropy effects

Grain refinement has long been the matter under investigation to improve fatigue and fracture resistance of engineering materials and alloys. It is of great interest to study the effects of grain refinement on fatigue behaviour at the nanoscale range when average, as well as peak, grain sizes are below 100 nm, cf. DAO *et al.* [7].

Recent experimental observation on the fatigue life and fatigue crack growth for full-density nc metals, using electrodeposited nc Ni (with an average grain size in the range 20–40 nm, and peak grain size near 70 nm), HANLON *et al.* [12] showed the effect of grain size on the fatigue resistance. Nanocrystalline Ni was shown to have a moderately higher endurance limit when subject to stress-controlled fatigue loading than ufc Ni, while both nc Ni and ufc Ni showed significantly higher fatigue resistance than the mc Ni. Experimental observations performed by HANLON *et al.* [13] confirmed that over a wide range of load ratios, the nc Ni showed significantly lower resistance to fatigue crack growth.

Figure 45 shows SEM crack growth images of mc, ufc and nc Ni subjected to fatigue loading at 10 Hz and loading ratio $R = 0.3$. The crack path is much less tortuous with a decreasing grain size.

With the enhanced fatigue limit for nc metals but at the reduced crack growth resistance, it is likely that a controlled grain size gradient may bring benefit fatigue properties while avoiding unwanted disadvantages, cf. DAO *et al.* [7].

The behaviour of nanocrystalline metals under cyclic loading processes can be described properly when we take into account the residual stresses in a material, which have very important influence on the evolution of intrinsic nanostructure of metals.

The intrinsic nanostructure of nanocrystalline metals during loading, unloading and reloading processes can be changed very intensively. This change during load, unload, reload test for cryo-rolled nc Cu has shown by WANG and MA [52], cf. Fig. 20.

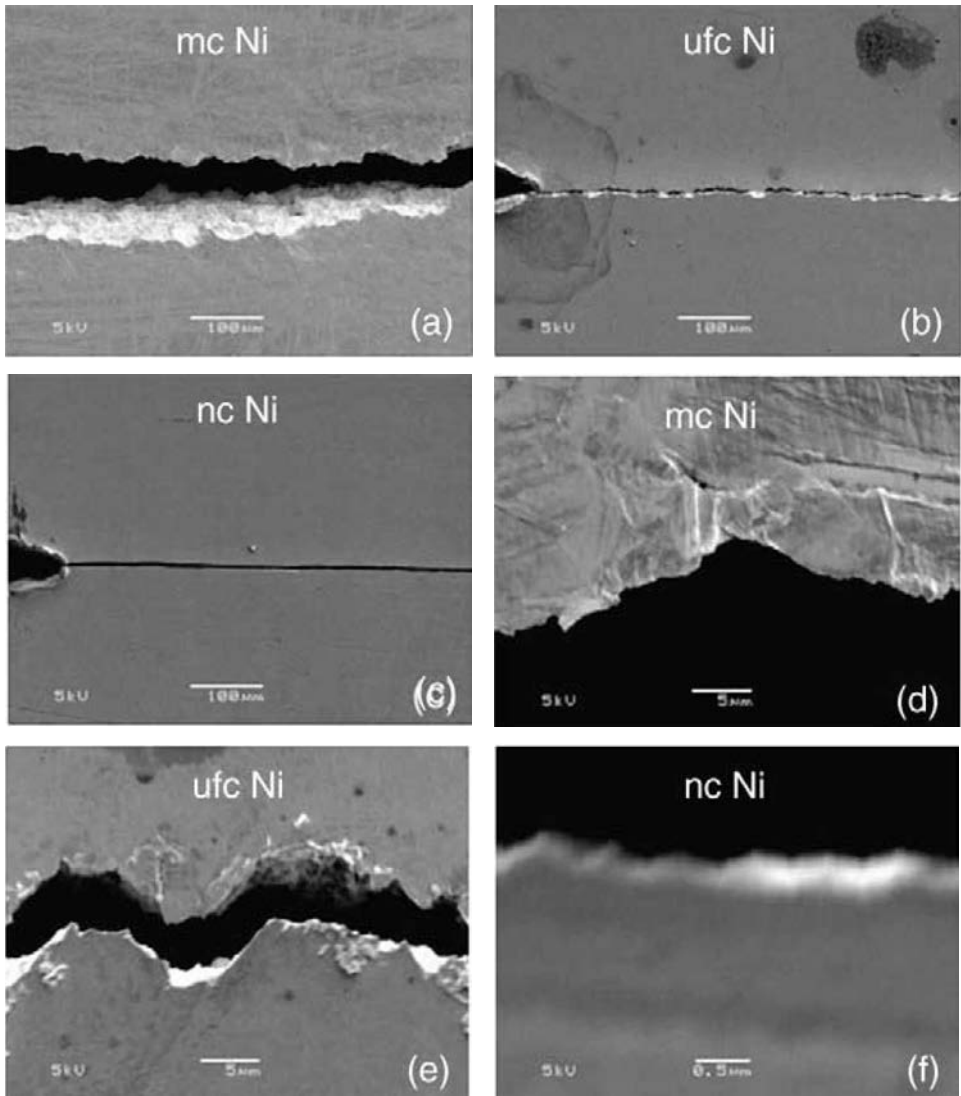


FIG. 45. Scanning electron micrographs of mc, ufc and nc Ni subjected to sinusoidal fatigue loading at the initial stress intensity factor values of 10, 6.2, and 8.5 MPa $m^{1/2}$, respectively. A cyclic frequency of 10 Hz and loading ratio $R = 0.3$ were used in all cases. Crack path tortuosity clearly decreases with grain refinement. Images (d)–(f) are high-magnification images of (a)–(c), respectively, and the magnification of (f) is 10 times of (d) and (e), cf. HANLON *et al.* [13].

2.8. Ductility and fracture

For many nanocrystalline metals, low ductility and premature fracture, sometimes the failure occurring even in the elastic range, were due to processing flaws

and artifacts, cf. DAO *et al.* [7]. However, nanocrystalline metals are characterized by a low work-hardening rate, which is a direct consequence of the low density of dislocation encountered after plastic deformation. This low work-hardening rate leads to tensile instability and a low tensile ductility. There are reports, recently published on increased ductility in nanocrystalline metals; very good example of this is the experimental investigation work by CHENG *et al.* [4] *in situ* consolidated nanocrystalline Cu. The authors reported on a much improved combination of tensile strength and ductility, over the tensile properties of other nc-Cu materials documented in the literature, cf. Fig. 46.

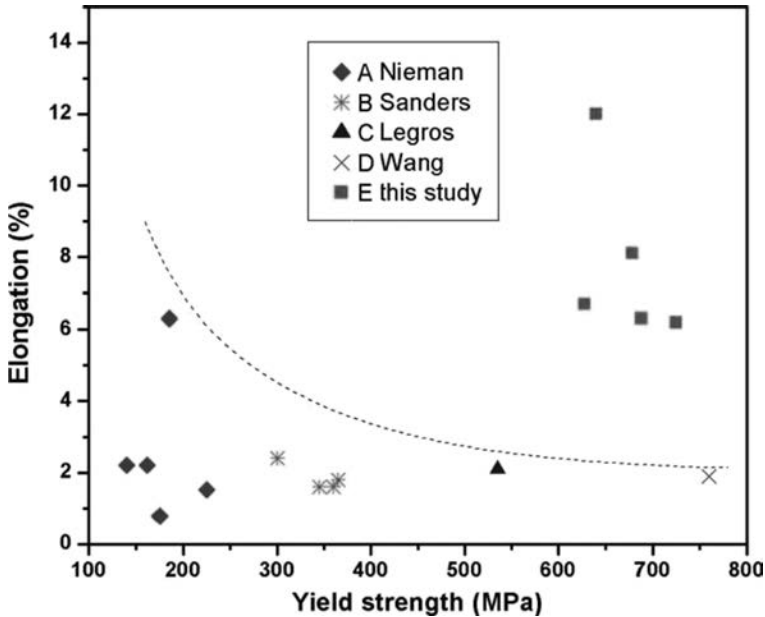


FIG. 46. Comparison of tensile yield strength and elongation to failure of various truly nc-Cu (average $d < 100$ nm) in literature. The dashed line shows a general trend as guide to the eye, cf. CHENG *et al.* [4].

The authors suggested that in most of the previous tensile tests, the nc-Cu used suffered from sample flaw problems. Flaws possibly accelerated the onset of cracking in the local regions with concentrated strains (shear band zones or necked regions). Although residual defects (porosity, microcracks) may still be present *in situ* consolidated nc-Cu, they are such a low population that tensile flow can be maintained to appreciable strain levels before cracking finally fails the sample, cf. Fig. 30. It is, therefore, conceivable that in samples without any residual porosity, an even larger tensile elongation could be achievable.

Fracture in nanocrystalline metals is a complex phenomenon of initiation, propagation and coalescence of micro(nano)voids or micro(nano)cracks, leading

to the separation of a body into two or more parts. The spacing/size of dimples, however for nanocrystalline metals, is considerably larger than the grain size on their specimens. KUMAR *et al.* [19] presented the interpretation of the evolution of micro(nano)cracks, cf. Fig. 47. The mechanisms responsible for void initiation are: (i) existing voids at grain boundaries and triple points; (ii) voids created by dislocation emission from grain boundaries; (iii) voids created by grain-boundary sliding which leaves wedges at triple junction; (iv) cavities created by the action of grain-boundary sliding on the ledges. The spacing of these initiation sites, which is larger than the grain size, determines the dimple size, cf. Fig. 48 and Fig. 31.

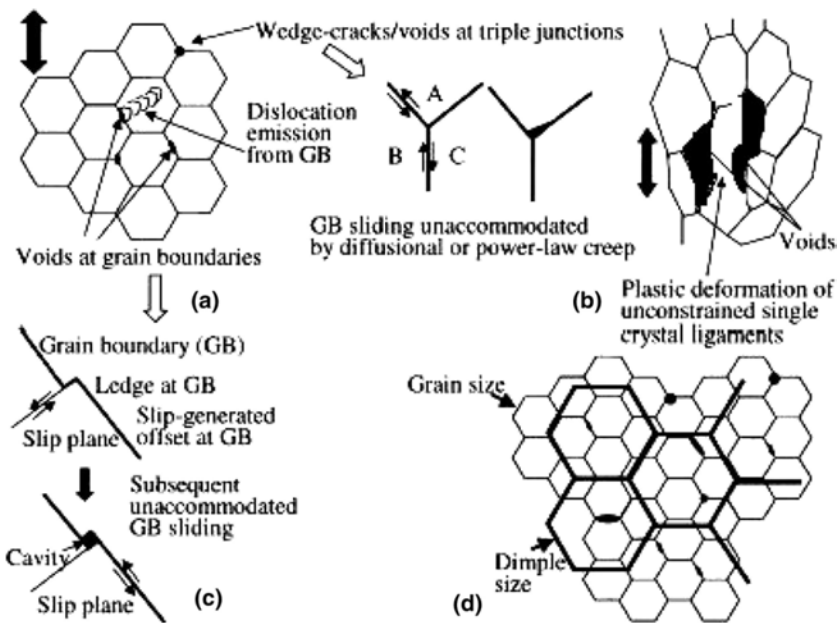


FIG. 47. Schematic illustration showing how deformation evolves in the nanocrystalline nickel and leads to (a) dislocation emission from grain boundaries, void formation/growth at grain boundaries and triple junctions, grain-boundary sliding; (b) the formation of partially unconstrained ligaments that deform plastically; (c) generation of cavities at grain-boundary ledges and (d) the interaction of these various features to produce final dimple size, KUMAR *et al.* [19].

Recent experimental observations have shown the interesting possibility, that nanosized grains rotate during plastic deformation and can coalesce along the directions of shear, creating larger paths for dislocation movement. As plastic deformation takes place, two neighboring grains might rotate in a fashion that brings their orientation closer together. This leads to the elimination of the barrier presented by the boundary between them, providing a path for more

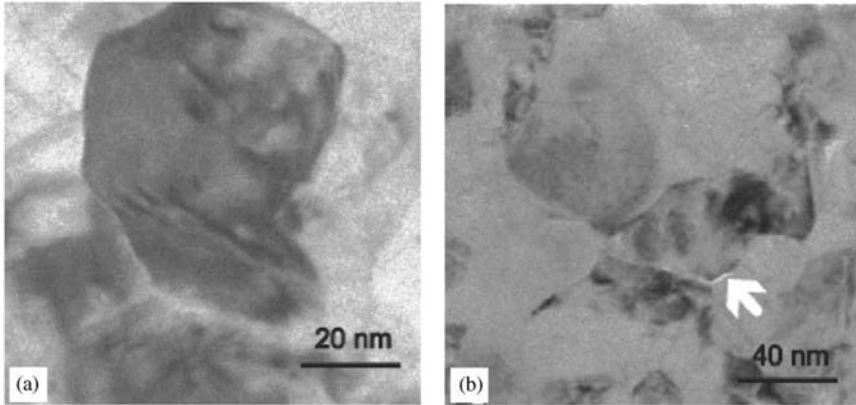


FIG. 48. Microstructure of nc-Ni after 4% plastic strain in compression: a) bright-field TEM image showing a few dislocations within a grain; b) a possible crack at a grain-boundary triple junction, WEI and ANAND [59].

extended dislocation motion. This mechanism can actually lead to softening and localization, and is consistent with the limited ductility often exhibited by nanocrystalline metals, cf. Fig. 49. The mechanism of rotation of neighboring nanograins and creation of elongated grains by annihilation of grain boundary during intensive plastic deformation within the localized region of macroshear band in consolidated nc-Fe, has been observed experimentally, cf. Fig. 26a.

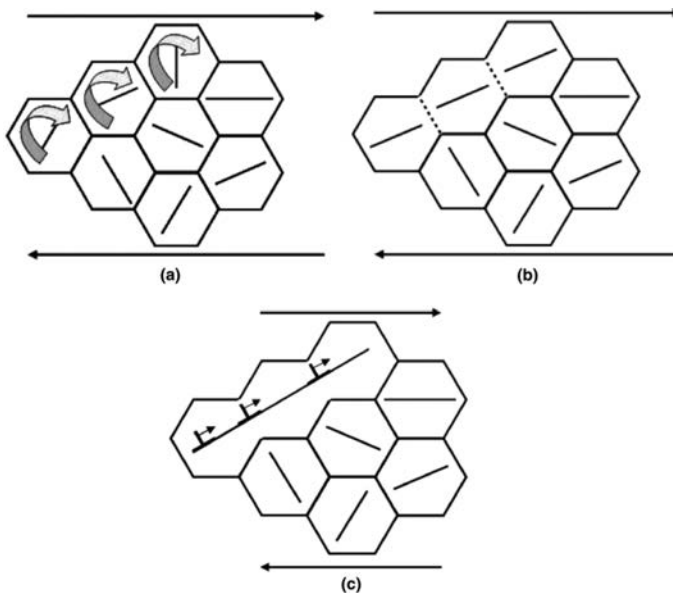


FIG. 49. Rotation of neighboring nanograins during plastic deformation and creation of elongated grains by annihilation of grain boundary, cf. MEYERS *et al.* [24].

3. PHYSICAL FOUNDATIONS

The rate and temperature dependence of the flow stress of metal crystals can be explained by various physical mechanisms of dislocation motion. The microscopic processes combine in different ways to give several group of deformation mechanisms, each of which can be limited to the particular range of temperature and strain rate changes.

The principal short-range barrier, the Peierls-Nabarro stress, is important for ultrafine crystalline *bcc* metals, whereas in ultrafine crystalline *fcc* and *hcp* metals, forest dislocations are the primary short-range barriers at lower temperatures, cf. DAO *et al.* [7] and MEYERS *et al.* [24]).

Schematic representations of these two mechanisms in which the obstacles are overcome are given in Fig. 50. In each case, thermal fluctuations assist the applied stress in getting a dislocation segment L past the barrier. Both of these mechanisms lead to viscoplastic response of the crystal.

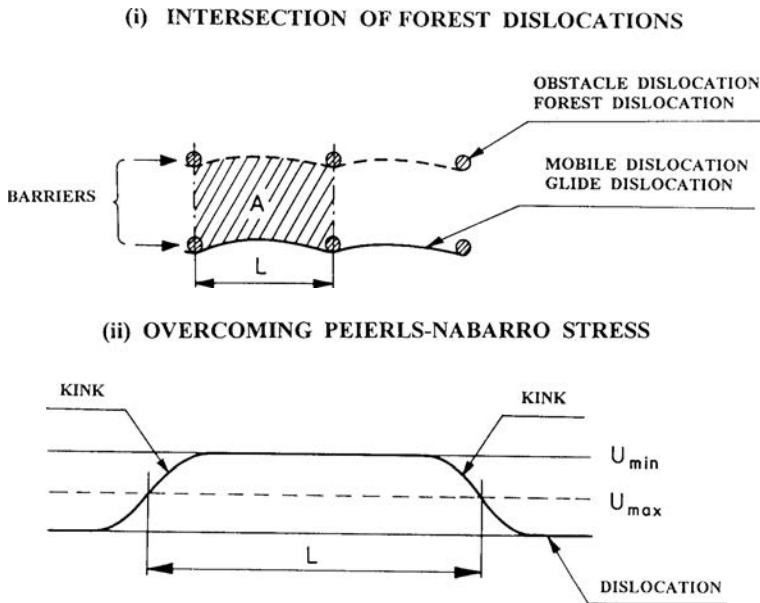


FIG. 50. Schematic representations of the physical mechanisms responsible for inelastic flow of *fcc*, *bcc* and *hcp* metals.

The main idea of the viscoplastic flow mechanism is to accomplish in one model the description of behaviour of single crystals valid for the entire range of strain rate changes. In other words, the main concept is to encompass the interaction of the thermally activated and phonon damping mechanisms, cf. PERZYNA [28–32].

To achieve this aim, the empirical overstress function Φ has been introduced and the plastic strain rate is postulated in the form as follows (cf. PERZYNA [41])

$$(3.1) \quad \dot{\epsilon}^p = \frac{1}{T} \left\langle \Phi \left[\frac{\tau}{\tau_Y(\epsilon^p, \vartheta, \boldsymbol{\mu}^*, d)} - 1 \right] \right\rangle \operatorname{sgn} \tau,$$

where T is the relaxation time, $\langle \cdot \rangle$ denotes the Macauley bracket, τ is the actual stress and τ_Y is the yield stress function, which may depend on the inelastic strain ϵ^p , temperature ϑ and the internal state variables $\boldsymbol{\mu}^*$ and d (d is the average grain size). The internal state variable vector $\boldsymbol{\mu}^*$ may represent the density of obstacle dislocations, the density of mobile dislocations and the concentration of point defects.

We can use the Hall-Petch relation (2.2), then

$$(3.2) \quad \tau_Y = \tau_0(\epsilon^p, \vartheta, \boldsymbol{\mu}^*) + kd^{-n},$$

where k is a constant and $0.3 \leq n \leq 0.7$.

Finally we have the constitutive assumption in the form

$$(3.3) \quad \dot{\epsilon}^p = \frac{1}{T} \left\langle \Phi \left[\frac{\tau}{\tau_0(\epsilon^p, \vartheta, \boldsymbol{\mu}^*) + kd^{-n}} - 1 \right] \right\rangle \operatorname{sgn} \tau.$$

It is noteworthy that the empirical overstress function Φ may be determined basing on available experimental results performed under dynamic loading.

4. KINEMATICS OF FINITE DEFORMATION AND FUNDAMENTAL DEFINITIONS

Let $\{X^A\}$ and $\{x^a\}$ denote coordinate systems on \mathcal{B} and \mathcal{S} respectively. Then we refer to $\mathcal{B} \subset \mathbb{R}^3$ as the reference configuration of a continuum body with particles $X \in \mathcal{B}$ and to $\mathcal{S} = \phi(\mathcal{B})$ as the current configuration with points $\mathbf{x} \in \mathcal{S}$. The matrix $\mathbf{F}(\mathbf{X}, t) = \partial\phi(\mathbf{X}, t)/\partial\mathbf{X}$ with respect to the coordinate bases $\mathbf{E}_A(\mathbf{X})$ and $\mathbf{e}_a(\mathbf{x})$ is given by

$$(4.1) \quad F_A^a(\mathbf{X}, t) = \frac{\partial\phi^a}{\partial X^A}(\mathbf{X}, t),$$

where a mapping $\mathbf{x} = \phi(\mathbf{X}, t)$ represents a motion of a body \mathcal{B} .

We consider the local multiplicative decomposition

$$(4.2) \quad \mathbf{F} = \mathbf{F}^e \cdot \mathbf{F}^p,$$

where $(\mathbf{F}^e)^{-1}$ is the deformation gradient that releases elastically the stress on the neighborhood $\phi(\mathcal{N}(\mathbf{X}))$ in the current configuration.

Let us define the total and elastic Finger deformation tensors

$$(4.3) \quad \mathbf{b} = \mathbf{F} \cdot \mathbf{F}^T, \quad \mathbf{b}^e = \mathbf{F}^e \cdot \mathbf{F}^{eT},$$

respectively, and the Eulerian strain tensors as follows:

$$(4.4) \quad \mathbf{e} = \frac{1}{2} (\mathbf{g} - \mathbf{b}^{-1}), \quad \mathbf{e}^e = \frac{1}{2} (\mathbf{g} - \mathbf{b}^{e^{-1}}),$$

where \mathbf{g} denotes the metric tensor in the current configuration.

By definition¹⁾

$$(4.5) \quad \mathbf{e}^p = \mathbf{e} - \mathbf{e}^e = \frac{1}{2} (\mathbf{b}^{e^{-1}} - \mathbf{b}^{-1})$$

we introduce the plastic Eulerian strain tensor.

To define objective rates for vectors and tensors we use the Lie derivative²⁾. Let us define the Lie derivative of a spatial tensor field \mathbf{t} with respect to the velocity field \mathbf{v} as

$$(4.6) \quad \mathbf{L}_{\mathbf{v}}\mathbf{t} = \phi_* \frac{\partial}{\partial t} (\phi^* \mathbf{t}),$$

where ϕ^* and ϕ_* denote the pull-back and push-forward operations, respectively.

The rate of deformation is defined as follows:

$$(4.7) \quad \mathbf{d}^b = \mathbf{L}_{\mathbf{v}}\mathbf{e}^b = \frac{1}{2} \mathbf{L}_{\mathbf{v}}\mathbf{g} = \frac{1}{2} (g_{ac}v^c \lfloor_b + g_{cb}v^c \rfloor_a) \mathbf{e}^a \otimes \mathbf{e}^b,$$

where the symbol \lfloor denotes the index lowering operator and \otimes the tensor product,

$$(4.8) \quad v^a \lfloor_b = \frac{\partial v^a}{\partial x^b} + \gamma_{bc}^a v^c,$$

and γ_{bc}^a denotes the Christoffel symbol for the general coordinate systems $\{x^a\}$. The components of the spin $\boldsymbol{\omega}$ are given by

$$(4.9) \quad \omega_{ab} = \frac{1}{2} (g_{ac}v^c \lfloor_b - g_{cb}v^c \rfloor_a) = \frac{1}{2} \left(\frac{\partial v_a}{\partial x^b} - \frac{\partial v_b}{\partial x^a} \right).$$

Similarly

$$(4.10) \quad \mathbf{d}^{e^b} = \mathbf{L}_{\mathbf{v}}\mathbf{e}^{e^b}, \quad \mathbf{d}^{p^b} = \mathbf{L}_{\mathbf{v}}\mathbf{e}^{p^b},$$

¹⁾For precise definition of the finite elasto-plastic deformation see PERZYNA [38].

²⁾The algebraic and dynamic interpretations of the Lie derivative have been presented by ABRAHAM *et al.* [2], ABRAHAM and MARSDEN [1], cf. also MARSDEN and HUGHES [22].

and

$$(4.11) \quad \mathbf{d} = \mathbf{d}^e + \mathbf{d}^p.$$

Let $\boldsymbol{\tau}$ denote the Kirchhoff stress tensor related to the Cauchy stress tensor $\boldsymbol{\sigma}$ by

$$(4.12) \quad \boldsymbol{\tau} = J\boldsymbol{\sigma} = \frac{\rho_{\text{Ref}}}{\rho}\boldsymbol{\sigma},$$

where the Jacobian J is the determinant of the linear transformation

$$\mathbf{F}(\mathbf{X}, t) = (\partial/\partial X)\phi(\mathbf{X}, t),$$

$\rho_{\text{Ref}}(\mathbf{X})$ and $\rho(\mathbf{x}, t)$ denote the mass density in the reference and current configuration, respectively.

The Lie derivative of the Kirchhoff stress tensor $\boldsymbol{\tau} \in \mathbf{T}^2(\mathcal{S})$ (elements of $\mathbf{T}^2(\mathcal{S})$ are called tensors on \mathcal{S} , contravariant of order 2) gives

$$(4.13) \quad \begin{aligned} L_{\mathbf{v}}\boldsymbol{\tau} &= \phi_* \frac{\partial}{\partial t} (\phi^* \boldsymbol{\tau}) = \left\{ \mathbf{F} \cdot \frac{\partial}{\partial t} \left[\mathbf{F}^{-1} \cdot (\boldsymbol{\tau} \circ \phi) \cdot \mathbf{F}^{-1T} \right] \cdot \mathbf{F}^T \right\} \circ \phi^{-1} \\ &= \dot{\boldsymbol{\tau}} - (\mathbf{d} + \boldsymbol{\omega}) \cdot \boldsymbol{\tau} - \boldsymbol{\tau} \cdot (\mathbf{d} + \boldsymbol{\omega})^T, \end{aligned}$$

where \circ denotes the composition of mappings.

5. THERMO-ELASTO-VISCOPLASTICITY CONSTITUTIVE MODEL

5.1. Constitutive postulate

Let us assume that: (i) conservation of mass, (ii) balance of momentum, (iii) balance of moment of momentum, (iv) balance of energy, (v) entropy production inequality, hold.

We introduce the four fundamental postulates:

- (i) Existence of the free energy function. It is assumed that the free energy function is given by

$$(5.1) \quad \psi = \widehat{\psi}(\mathbf{e}, \mathbf{F}, \vartheta; \boldsymbol{\mu}),$$

where ϑ is temperature and $\boldsymbol{\mu}$ denotes a set of the internal state variables. To extend the domain of the description of the material properties and particularly, to take into consideration different dissipation effects, we have to introduce the internal state variables represented by the vector $\boldsymbol{\mu}$.

- (ii) Axiom of objectivity (spatial covariance). The constitutive structure should be invariant with respect to any diffeomorphism (any motion) $\zeta : \mathcal{S} \rightarrow \mathcal{S}$.

- (iii) The axiom of the entropy production. For any regular motion of a body \mathcal{B} , the constitutive functions are assumed to satisfy the reduced dissipation inequality

$$(5.2) \quad \frac{1}{\rho_{\text{Ref}}} \boldsymbol{\tau} : \mathbf{d} - (\eta \dot{\vartheta} + \dot{\psi}) - \frac{1}{\rho \dot{\vartheta}} \mathbf{q} \cdot \text{grad} \vartheta \geq 0,$$

where η is the specific (per unit mass) entropy, and \mathbf{q} denotes the heat flow vector field.

- (iv) The evolution equation for the internal state variable vector $\boldsymbol{\mu}$ is assumed in the form as follows:

$$(5.3) \quad L_{\mathbf{v}} \boldsymbol{\mu} = \widehat{\mathbf{m}}(\mathbf{e}, \mathbf{F}, \vartheta, \boldsymbol{\mu}),$$

where the evolution function $\widehat{\mathbf{m}}$ has to be determined based on careful physical interpretation of a set of the internal state variables and the analysis of available experimental observations.

The determination of the evolution function $\widehat{\mathbf{m}}$ (in practice, a finite set of the evolution functions) appears to be the main problem of the modern constitutive modeling.

5.2. Fundamental assumptions

Experimental observation results and analysis of physical foundations (cf. Secs. 2 and 3) suggest that the fundamental mechanism of viscoplastic flow is most important for proper description of *fcc*, *bcc* and *hcp* nanocrystalline metals. We intend to describe this main mechanism of viscoplastic flow by introducing the equivalent viscoplastic deformation ϵ^P as the internal state variable.

Strain rate sensitivity of these materials is very much influenced by micro(nano)shear banding, which occurs very early during both the quasi-static and high-rate deformation processes.

Since the process of macroshear localization in these materials for all smaller grain sizes ($d < 300$ nm) develops almost immediately after the onset of viscoplastic deformation, the mechanisms of anisotropic intrinsic micro(nano)damage play a very important role. To describe the effects of anisotropic intrinsic micro(nano)damage, we intend to introduce the tensorial micro(nano)damage internal state variable $\boldsymbol{\xi}$.

Based on experimental observations, we can suggest that the intrinsic micro(nano)damage process in nanocrystalline metals depends very much on the strain-rate effects and has very anisotropic nature.

Experimental observation results presented by SHOCKEY *et al.* [48] have shown that coalescence mechanism can be treated as nucleation and growth

process on a smaller scale. This conjecture simplifies very much the description of the intrinsic micro(nano)damage process by taking account only of the nucleation and growth mechanisms.

Recent investigations of plastic behaviour of nanocrystalline metals suggest that the anisotropy induced by finite plastic deformation plays also a fundamental role. This induced anisotropy is mainly caused by the residual stresses which are generated by the heterogeneous nature of plastic deformation in nanocrystalline metals. To describe these effects of plastic strain-induced anisotropy, the residual stress tensor (the back stress tensor) $\boldsymbol{\alpha}$ has to be introduced to the constitutive structure as the internal state variable. The aim of this is to take into account the kinematic hardening phenomenon, which can be treated as the first approximation of the description of plastic deformation-induced anisotropy.

The mechanism of rotation of neighboring nanograins during intense viscoplastic deformation process observed experimentally has to be described by taking account of finite viscoplastic deformation and the viscoplastic spin.

The dynamic grain growth process observed experimentally is easy to take into account by introducing the mean grain diameter d as the internal state variable.

For our practical purposes it is sufficient to assume that the internal state vector $\boldsymbol{\mu}$ has the form

$$(5.4) \quad \boldsymbol{\mu} = (\epsilon^p, \boldsymbol{\xi}, \boldsymbol{\alpha}, d),$$

where ϵ^p is the equivalent viscoplastic deformation, i.e.

$$(5.5) \quad \epsilon^p = \int_0^t \left(\frac{2}{3} \mathbf{d}^p : \mathbf{d}^p \right)^{1/2} dt,$$

$\boldsymbol{\xi}$ denotes the microdamage second-order tensor, with the physical interpretation that $(\boldsymbol{\xi} : \boldsymbol{\xi})^{1/2} = \xi$ defines the volume fraction porosity and takes account for microdamaged effects, $\boldsymbol{\alpha}$ denotes the residual stress (the back stress) and aims at the description of the kinematic hardening effects, d defines the mean grain diameter and is introduced as the internal state variable to describe the dynamic grain growth during deformation process.

Let us introduce the plastic potential function $f = f(\tilde{J}_1, \tilde{J}_2, \vartheta, \boldsymbol{\mu})$, where \tilde{J}_1, \tilde{J}_2 denote the first two invariants of the stress tensor $\tilde{\boldsymbol{\tau}} = \boldsymbol{\tau} - \boldsymbol{\alpha}$.

Let us postulate the evolution equations as follows:

$$(5.6) \quad \mathbf{d}^p = \Lambda \mathbf{P}, \quad \boldsymbol{\omega}^p = \Lambda \boldsymbol{\Omega}, \quad L_{\mathbf{v}} \boldsymbol{\xi} = \boldsymbol{\Xi}, \quad L_{\mathbf{v}} \boldsymbol{\alpha} = \mathbf{A}, \quad \dot{d} = \mathcal{D},$$

where for elasto-viscoplastic model of a material we assume (cf. PERZYNA [28–30, 38, 42])

$$(5.7) \quad \Lambda = \frac{1}{T_m} \left\langle \Phi \left(\frac{f}{\kappa} - 1 \right) \right\rangle,$$

T_m denotes the relaxation time for mechanical disturbances, the isotropic work-hardening-softening function κ is

$$(5.8) \quad \kappa = \widehat{\kappa}(\epsilon^P, \vartheta, \boldsymbol{\xi}, d),$$

Φ is the empirical overstress function, the bracket $\langle \cdot \rangle$ defines the ramp function,

$$(5.9) \quad \mathbf{P} = \frac{\partial f}{\partial \boldsymbol{\tau}} \Big|_{\boldsymbol{\xi}=\text{const}} \left(\left\| \frac{\partial f}{\partial \boldsymbol{\tau}} \right\| \right)^{-1},$$

$\boldsymbol{\Omega}$, $\boldsymbol{\Xi}$, \mathbf{A} and \mathcal{D} denote the evolution functions which have to be determined.

5.3. Microshear banding effects

To describe the microshear banding effects let us assume that the relaxation time T_m depends on the active microshear bands fraction f_{ms} and on the rate of equivalent viscoplastic deformation $\dot{\epsilon}^P$ (cf. PEŁCHERSKI [46], NOWAK, PERZYNA and PEŁCHERSKI [27] and PERZYNA [43]), i.e.

$$(5.10) \quad T_m = T_m(f_{ms}, \dot{\epsilon}^P).$$

Additionally, we introduce the simplification as follows:

$$(5.11) \quad T_m = T_m^0 \phi_1(f_{ms}) \phi_2(\dot{\epsilon}^P),$$

where T_m^0 is material function of the mean grain diameter d .

For example, for nanocrystalline iron we can postulate

$$(5.12) \quad \phi_1(f_{ms}) = [1 - f_{ms}(\epsilon^P)] = \left[1 - f_{ms}^0 \frac{1}{1 + \exp(a - b\epsilon^P)} \right],$$

and

$$(5.13) \quad \phi_2(\dot{\epsilon}^P) = \left(\frac{\dot{\epsilon}^P}{\dot{\epsilon}_s^P} - 1 \right)^{1/p},$$

where f_{ms}^0 , a , b , p and $\dot{\epsilon}_s^P$ are material function of d .

Finally we have

$$(5.14) \quad T_m = T_m^0 \left[1 - f_{ms}^0 \frac{1}{1 + \exp(a - b\epsilon^P)} \right] \left(\frac{\dot{\epsilon}^P}{\dot{\epsilon}_s^P} - 1 \right)^{1/p}.$$

5.4. Constitutive assumption for the viscoplastic spin

Based on experimental observations that the nanosized grains rotate during plastic deformation (cf. Subsec. 2.8), we suggest that in the proper description of nanocrystalline metals the viscoplastic spin may play a very important role.

Let us postulate that $\boldsymbol{\Omega}$ has the form³⁾ (cf. DAFALIAS [6] and LORET [21])

$$(5.15) \quad \boldsymbol{\Omega} = \eta^*(\boldsymbol{\alpha} \cdot \mathbf{P} - \mathbf{P} \cdot \boldsymbol{\alpha}),$$

where η^* denotes the scalar-valued function of the invariants of the tensors $\boldsymbol{\alpha}$, $\boldsymbol{\xi}$ and \mathbf{P} , and may depend on temperature ϑ and the mean grain diameter d .

5.5. Anisotropic intrinsic microdamage mechanisms

To take into consideration the observed time-dependent effects, it is advantageous to use the proposition of the description of the intrinsic microdamage process presented by PERZYNA [34, 35], DUSZEK–PERZYNA and PERZYNA [10], and DORNOWSKI and PERZYNA [8].

Let us assume that the intrinsic microdamage process consists of the nucleation and growth mechanisms.

Based on the heuristic suggestions and taking into account the influence of the stress triaxiality and anisotropic effects on the nucleation and growth mechanisms, we assume the evolution equation for the microdamage tensor $\boldsymbol{\xi}$ as follows (cf. PERZYNA [43]):

$$(5.16) \quad \mathbf{L}_{\mathbf{v}}\boldsymbol{\xi} = \frac{\partial h^*}{\partial \boldsymbol{\tau}} \frac{1}{T_m} \left\langle \Phi \left[\frac{\tilde{I}_n}{\tau_n(\boldsymbol{\xi}, \boldsymbol{\alpha}, \vartheta, \epsilon^p, d)} - 1 \right] \right\rangle \\ + \frac{\partial g^*}{\partial \boldsymbol{\tau}} \frac{1}{T_m} \left\langle \Phi \left[\frac{\tilde{I}_g}{\tau_{eq}(\boldsymbol{\xi}, \boldsymbol{\alpha}, \vartheta, \epsilon^p, d)} - 1 \right] \right\rangle.$$

The tensorial function $\partial h^*/\partial \boldsymbol{\tau}$ describes the mutual microcrack interaction for nucleation mechanism, while the tensorial function $\partial g^*/\partial \boldsymbol{\tau}$ represents the mutual microcrack interaction for growth process, τ_n and τ_{eq} denote the threshold stresses for microcrack nucleation and growth, respectively.

$$(5.17) \quad \tilde{I}_n = a_1 \tilde{J}_1 + a_2 \sqrt{\tilde{J}_2} + a_3 \left(\tilde{J}_3 \right)^{1/3}$$

³⁾For a thorough discussion of a concept of the plastic spin and its constitutive description in phenomenological theories for macroscopic large plastic deformations, please consult the critical review paper by VAN DER GIESSEN [50].

defines the stress intensity invariant for nucleation, a_i ($i = 1, 2, 3$) are the material coefficients which can depend on d , \tilde{J}_2 and \tilde{J}_3 are the second and third invariants of the stress deviator $\tilde{\boldsymbol{\tau}} = (\boldsymbol{\tau} - \boldsymbol{\alpha})'$,

$$(5.18) \quad \tilde{I}_g = b_1 \tilde{J}_1 + b_2 \sqrt{\tilde{J}_2} + b_3 \left(\tilde{J}_3 \right)^{1/3},$$

defines the stress intensity invariant for growth and b_i ($i = 1, 2, 3$) are the material coefficient which can depend on d . This determines the evolution function Ξ .

In the evolution Eq. (5.16) the functions

$$(5.19) \quad h = \hat{h}(\boldsymbol{\tau}, \vartheta, \epsilon^P, \boldsymbol{\xi}, \boldsymbol{\alpha}, d),$$

$$(5.20) \quad g = \hat{g}(\boldsymbol{\tau}, \vartheta, \epsilon^P, \boldsymbol{\xi}, \boldsymbol{\alpha}, d),$$

play the fundamental role, and have to be determined based on available experimental observation data. We also introduced the denotations as follows

$$(5.21) \quad \frac{\partial h^*}{\partial \boldsymbol{\tau}} = \frac{\partial \hat{h}}{\partial \boldsymbol{\tau}} \left(\left\| \frac{\partial \hat{h}}{\partial \boldsymbol{\tau}} \right\| \right)^{-1}, \quad \frac{\partial g^*}{\partial \boldsymbol{\tau}} = \frac{\partial \hat{g}}{\partial \boldsymbol{\tau}} \left(\left\| \frac{\partial \hat{g}}{\partial \boldsymbol{\tau}} \right\| \right)^{-1}.$$

The threshold stresses τ_n and τ_{eq} for microcrack nucleation and growth, respectively, can be assumed as the material functions in the form

$$(5.22) \quad \tau_n = \tau_n(\boldsymbol{\xi}, \boldsymbol{\alpha}, \vartheta, \epsilon^P, d), \quad \tau_{eq} = \tau_{eq}(\boldsymbol{\xi}, \boldsymbol{\alpha}, \vartheta, \epsilon^P, d).$$

5.6. Kinematic hardening

To determine the evolution function \mathbf{A} we shall follow some results obtained by DUSZEK and PERZYNA [9]. The kinematic hardening evolution law takes the form

$$(5.23) \quad \mathbf{L}_v \boldsymbol{\alpha} = \frac{1}{T_m} \left\langle \Phi \left(\frac{f}{\kappa} - 1 \right) \right\rangle \left[r_1 \mathbf{P} + r_2 \frac{\mathbf{P} : \mathbf{Q}}{\tilde{\boldsymbol{\tau}} : \mathbf{Q} + r_3 \boldsymbol{\xi} : \mathbf{Q}} (\tilde{\boldsymbol{\tau}} + r_3 \boldsymbol{\xi}) \right],$$

where r_1 , r_2 and r_3 are the grain diameter-dependent material coefficients and

$$(5.24) \quad \mathbf{Q} = \left[\frac{\partial f}{\partial \boldsymbol{\tau}} + \left(\frac{\partial f}{\partial \boldsymbol{\xi}} - \frac{\partial \kappa}{\partial \boldsymbol{\xi}} \right) : \frac{\partial \boldsymbol{\xi}}{\partial \boldsymbol{\tau}} \right] \left\| \frac{\partial f}{\partial \boldsymbol{\tau}} + \left(\frac{\partial f}{\partial \boldsymbol{\xi}} - \frac{\partial \kappa}{\partial \boldsymbol{\xi}} \right) : \frac{\partial \boldsymbol{\xi}}{\partial \boldsymbol{\tau}} \right\|^{-1}.$$

The kinetic law (5.23) represents the linear combination of the Prager and Ziegler kinematic hardening rules and additionally depends linearly on the microdamage tensor $\boldsymbol{\xi}$.

5.7. Description of dynamic grain growth

Based on the heuristic suggestion and taking into consideration the conclusion from the experimental observation and the physical foundations that the dynamic grain growth is the rate-dependent mechanism, we can postulate

$$(5.25) \quad \dot{d} = \frac{\widehat{\mathcal{G}}(\vartheta, \boldsymbol{\mu})}{T_m} \left\langle \Phi \left[\frac{\widetilde{I}_d}{\tau_d(\vartheta, \boldsymbol{\mu})} - 1 \right] \right\rangle,$$

where $\mathcal{G} = \widehat{\mathcal{G}}(\vartheta, \boldsymbol{\mu})$ is the material function, and

$$(5.26) \quad \widetilde{I}_d = c_1 \widetilde{J}_1 + c_2 \sqrt{\widetilde{J}_2} + c_3 \left(\widetilde{J}_3 \right)^{1/3}$$

represents the stress intensity invariant for grain growth, c_i ($i = 1, 2, 3$) are the material coefficients which may depend on d , and

$$(5.27) \quad \tau_d = \tau_d(\vartheta, \boldsymbol{\mu})$$

denotes the threshold stress for dynamic grain growth mechanism.

It is noteworthy that evolution equation (5.25) is dependent on the stress triaxility.

5.8. Thermodynamic restrictions and rate type constitutive relations

Suppose the axiom of the entropy production holds. Then the constitutive assumption (5.1) and the evolution equations (5.6) lead to the results as follows:

$$(5.28) \quad \boldsymbol{\tau} = \rho_{Ref} \frac{\partial \widehat{\psi}}{\partial \mathbf{e}}, \quad \eta = -\frac{\partial \widehat{\psi}}{\partial \vartheta}, \quad -\frac{\partial \widehat{\psi}}{\partial \boldsymbol{\mu}} \cdot \mathbf{L}_\nu \boldsymbol{\mu} - \frac{1}{\rho \vartheta} \mathbf{q} \cdot \text{grad} \vartheta \geq 0.$$

The rate of internal dissipation is determined by

$$(5.29) \quad \begin{aligned} \widehat{\vartheta} i &= -\frac{\partial \widehat{\psi}}{\partial \boldsymbol{\mu}} \cdot \mathbf{L}_\nu \boldsymbol{\mu} \\ &= - \left[\sqrt{\frac{2}{3}} \frac{\partial \widehat{\psi}}{\partial \epsilon^P} + \frac{\partial \widehat{\psi}}{\partial \boldsymbol{\alpha}} : \left(r_1 \mathbf{P} + r_2 \frac{\mathbf{P} : \mathbf{Q}}{\widetilde{\boldsymbol{\tau}} : \mathbf{Q} + r_3 \boldsymbol{\xi} : \mathbf{Q}} (\widetilde{\boldsymbol{\tau}} + r_3 \boldsymbol{\xi}) \right) \right] \Lambda \\ &\quad - \frac{\partial \widehat{\psi}}{\partial \boldsymbol{\xi}} : \boldsymbol{\Xi} - \frac{\partial \widehat{\psi}}{\partial d} \mathcal{D}. \end{aligned}$$

Operating on the stress relation (5.28)₁ with the Lie derivative and keeping the internal state vector constant, we obtain

$$(5.30) \quad \mathbf{L}_\nu \boldsymbol{\tau} = \mathcal{L}^e : \mathbf{d} - \mathcal{L}^{th} \dot{\vartheta} - [(\mathcal{L}^e + \mathbf{g} \boldsymbol{\tau} + \boldsymbol{\tau} \mathbf{g} + \mathcal{W}) : \mathbf{P}] \frac{1}{T_m} \left\langle \Phi \left(\frac{f}{\kappa} - 1 \right) \right\rangle,$$

where

$$(5.31) \quad \mathcal{L}^e = \rho_{\text{Ref}} \frac{\partial^2 \widehat{\psi}}{\partial \mathbf{e}^2}, \quad \mathcal{L}^{th} = -\rho_{\text{Ref}} \frac{\partial^2 \widehat{\psi}}{\partial \mathbf{e} \partial \vartheta},$$

$$\mathcal{W} = \eta^* [(\mathbf{g}\boldsymbol{\tau} - \boldsymbol{\tau}\mathbf{g}) : (\boldsymbol{\alpha}\mathbf{g} - \mathbf{g}\boldsymbol{\alpha})].$$

Substituting $\widehat{\psi}$ into the energy balance equation and taking into account the results (5.28)₃ and (5.29), we obtain

$$(5.32) \quad \rho \vartheta \dot{\eta} = -\text{div} \mathbf{q} + \rho \vartheta \widehat{i}.$$

Operating on the entropy relation (5.28)₂ with the Lie derivative and substituting the result into (5.32), we obtain

$$(5.33) \quad \rho c_p \dot{\vartheta} = -\text{div} \mathbf{q} + \vartheta \frac{\rho}{\rho_{\text{Ref}}} \frac{\partial \boldsymbol{\tau}}{\partial \vartheta} : \mathbf{d} + \rho \chi^* \boldsymbol{\tau} : \mathbf{d}^p + \rho \chi^{**} \mathbf{K} : L_{\mathbf{v}} \boldsymbol{\xi} + \rho \chi^{***} \dot{d},$$

where the specific heat $c_p = -\vartheta \frac{\partial^2 \widehat{\psi}}{\partial \vartheta^2}$ and we introduce the denotations

$$(5.34) \quad \chi^{**} \mathbf{K} = - \left(\frac{\partial \widehat{\psi}}{\partial \boldsymbol{\xi}} - \vartheta \frac{\partial^2 \widehat{\psi}}{\partial \vartheta \partial \boldsymbol{\xi}} \right), \quad \chi^{***} = - \left(\frac{\partial \widehat{\psi}}{\partial d} - \vartheta \frac{\partial^2 \widehat{\psi}}{\partial \vartheta \partial d} \right)$$

and χ^* , χ^{**} and χ^{***} are the irreversibility coefficients.

5.9. Length-scale sensitivity of the constitutive model

The constitutive equations for a thermo-elastic-viscoplastic model introduce implicitly a length-scale parameter into the dynamic initial-boundary value problem, i.e.

$$(5.35) \quad l = \beta c T_m = \beta(d) c T_m^0 \phi_1(f_{ms}) \phi_2(\dot{\epsilon}^P),$$

where c denotes the velocity of the propagation of the elastic waves in the problem under consideration and the proportionality factor β depends on the particular initial-boundary value problem and may also depend on the nanoscopic properties of the material as well as on the mean grain diameter.

As an example for nanocrystalline iron we have

$$(5.36) \quad l = \beta(d) c T_m^0(d) \left\{ 1 - f_{ms}^0(d) \frac{1}{1 + \exp[a(d) - b(d)\epsilon^P]} \right\} \left[\frac{\dot{\epsilon}^P}{\dot{\epsilon}_s^P(d)} - 1 \right]^{1/p}.$$

It is noteworthy to stress that the length-scale sensitivity of the constitutive structure is of great importance for proper description of particular initial-boundary value problems by using the numerical methods.

To expect the proper description we have to postulate $l < d$. This assumption can be treated as the important condition which has to be satisfied in the identification procedure.

For particular one-dimensional case for nanocrystalline iron we have

$$(5.37) \quad l=2 \frac{\sigma_0 + kd^{-n}}{\sqrt{\rho E}} T_m^0(d) \left\{ 1 - f_{ms}^0(d) \frac{1}{1 + \exp[a(d) - b(d)\epsilon^P]} \right\} \left[\frac{\dot{\epsilon}^P}{\dot{\epsilon}_s^P(d)} - 1 \right]^{1/p}.$$

6. FRACTURE CRITERION BASED ON THE EVOLUTION OF MICRODAMAGE

We base the fracture criterion on the evolution of the microdamage tensor $\boldsymbol{\xi}$.

Let us assume that for $(\boldsymbol{\xi} : \boldsymbol{\xi})^{1/2} = \xi^F$ catastrophe takes place (cf. PERZYNA [33]), that is

$$(6.1) \quad \kappa = \widehat{\kappa}(\epsilon^P, \vartheta, \boldsymbol{\xi}, d)|_{(\boldsymbol{\xi} : \boldsymbol{\xi})^{1/2} = \xi^F} = 0.$$

It means that for $(\boldsymbol{\xi} : \boldsymbol{\xi})^{1/2} = \xi^F$ the material loses its carrying capacity. The condition (6.1) describes the main feature observed experimentally that the load tends to zero at the fracture point.

It is noteworthy that the isotropic hardening-softening material function $\widehat{\kappa}$ proposed in Eq. (5.8) should satisfy the fracture criterion (6.1).

From the condition (6.1) we may have the critical value of the equivalent inelastic deformation at the fracture point

$$(6.2) \quad \epsilon_F^P = \widehat{\mathcal{F}}(\vartheta, \xi^F, d).$$

7. EPILOGUE

The thermodynamical theory of elasto-viscoplasticity of nanocrystalline metals has been developed within the framework of the rate-type covariance constitutive structure, with a finite set of the internal state variables. The crucial idea in the present theory is the very efficient physical interpretation of the assumed internal state variables (as the equivalent inelastic deformation ϵ^P , the microdamage tensor $\boldsymbol{\xi}$, the residual stress tensor (the back-stress tensor) $\boldsymbol{\alpha}$ and the mean grain diameter d) and the proposition of the evolution equations for them.

We may say that this developed theory is the realization of our previous hope presented in the papers by PERZYNA [43, 44]. We have to admit that the developed theory is very general and very complex. However, in practical application of it and particularly, in the solution of the initial-boundary value problems in modern manufacturing processes, we may use its special version when only some of the internal state variables will play a fundamental role.

It is noteworthy that the thermodynamical theory of elasto-viscoplasticity of nanocrystalline metals developed in this paper has been inspired by the brilliant

new developments in experimental investigations, as well as several mechanisms based and physically motivated models published in the literature, especially during the last ten years.

It is important to stress that very fundamental feature of the developed theory is its length-scale sensitivity. This has particularly a great effect for the solution of the initial-boundary value problems by using the numerical methods.

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SENDING HIDDEN DATA THROUGH WWW PAGES: DETECTION AND PREVENTION

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In the paper we propose a method of detecting and removing a hidden content which could be sent through the HTML code of WWW pages. We start from the overview of known methods of inserting hidden data to the mark-up languages (HTML or XML)-written texts. Next we propose a method of detecting suspicious web pages, based on statistical analysis. We also propose the method of transforming the HTML code of the web pages to remove any hidden communication.

Key words: steganography, steganalysis, HTML, internet security, data hiding.

1. INTRODUCTION

In contemporary world it is hard to imagine life without the Internet. Over the last two decades, Internet technology had really a big impact on our common activity, allowing to find remotely every information one is about to look for. Invention of the HTML, which is a language easy to learn, allowed people to create their personal web pages and contributed to the Internet success. Thus, everyone can create his or her own page and publish it in the Internet making it globally accessible. At present there are tens of billions of such web pages and their number is growing rapidly. Obviously the Internet huge size, combined with lack of an effective control, gives one an opportunity to “smuggle” some undesirable content into the ordinary web pages. Furthermore, a number of methods exist that allow to hide such a content or hidden message without changing the web page look. They are taking advantage of steganography. Steganography consists in hiding a secret data in a covert channel which can be, e.g., a graphic file, a web page or a network protocol, by exploiting some of its redundant properties, so the unaware recipients of the covert message do not notice any difference. It can be achieved, e.g., by changing the value of insignificant bits in a file or optional flags in a network protocol.

Steganography is not always used for a good purpose. Last years steganography has got great public interest as a suspicion arose that some terrorists might have used steganography to send secret communicates. Steganography is hard to detect and in the Internet it enables application of many various techniques. One of the possibilities, which we are studying in this paper, is hiding the messages in the mark-up languages, e.g., HTML web pages source code or XML documents.

Considering the difficulties of detecting steganographic communication and possible threats it can bring, we believe that there is a need for methods of detecting suspicious web pages and deleting hidden messages from them. In this paper we present the method that allows to achieve these goals.

2. HIDING INFORMATION IN MARK-UP LANGUAGES

Considering methods of hiding information in XML/HTML documents, two main groups can be identified. The first group comprises techniques originating from the classical text steganography while the second group includes methods which make use of mark-up languages specific properties.

The former group methods treat XML/HTML documents as text files and consist in embedding secret in a file by changing its content in a particular way, depending on information one wants to carry. The result can be achieved, e.g., by inserting additional white-spaces, making deliberate spelling errors or changing a font. Many different methods of text steganography exist and they are described in details in literature, e.g., [1–5]. Although they can be successfully applied to XML/HTML documents, they will not be analysed further in this paper because they are easy to detect. Our intention is to analyse schemes of sending secret message, which do not affect the visible content of a web page presented by a web browser.

It is an advantage of the techniques from the latter group, which exploit the ordered structure of the mark-up languages. Employing such techniques prevents the viewers from being alerted by unexpected changes of the content; in this regard, the visible web screen is entirely equivalent to the original document. The allowable modifications are constrained by the particular languages' specifications, see e.g. [6–8].

A number of approaches to HTML/XML steganography has been proposed. Now they will be briefly presented including their advantages and drawbacks. One of the most important terms which allow comparison of different steganographic methods is a steganographic capacity which describes the amount of information, which can be hidden in a given covert channel. It is typically expressed as the maximum size of a secret message in bits. Obviously there is usually a trade-off between the capacity and the security, i.e. the bigger capacity a certain method offers, the easier it is to detect.

2.1. Hiding Information in HTML documents

Each HTML document contains tags which, in turn, may contain attributes. Every tag has its own name. There is a limited number of allowed tags listed in the HTML specification [6, 9]. The tags are the tools used to describe how a web page should be presented. We can enumerate a number of methods of sending secret messages with the HTML texts. They are described in many papers regarding steganography, see e.g., in [1, 10, 11].

White-spaces in tags. In HTML we can add a white space before “>” sign, which marks the end of a tag. This way it is possible to send one bit of a secret message for each tag, by selecting the tags to which we want add an additional space before its end sign. Another possibility is inserting white-spaces after the tag (if there is no body text after it). Main drawback of this approach is that in consequence of its application to files, they are getting bigger, so the stego channel can be easily revealed.

Changing the case of letters in tags. HTML tags are case insensitive, hence we can take advantage of it to hide a message within a document by changing the case of specific letters in a tag’s name. For example, <ID>, <id>, <Id> and <ID> mean exactly the same and we can encode two bits by choosing one of its version. Big capacity is the main advantage of this method. On the other hand, it is very easy to discover the stego channel since it is very unusual to use small and capital letters alternately.

Using default values of attributes. Some of the HTML attributes have their default values defined. An HTML document is treated by an HTML viewer the same way whether the default values have been explicitly defined or not. It gives an opportunity to hide an additional information by specifying default values in some parts of the HTML document, and skipping them in other parts. This method is hard to discover, but the limited possible number of attributes having default values is its main drawback.

Attribute order permutation. The HTML standard does not define a preferred order of attributes, what means that any order can be used without affecting a web page appearance. Since the order of attributes has no mean, this method can be applied without any restrictions. Changing the order of attributes for hiding information within an HTML document is the most interesting HTML steganography method. It does not change the original file size and it is hard to detect without computer programs analysing the HTML document’s structure. Having a tag comprising 8 attributes, there are $8! = 40320$ different permutations, what lets one to hide over 15 bits of information within this single tag. This

method is probably the most often mentioned one in the context of hiding data in the mark-up language documents. Its main advantage lies in its security, but in practice it allows only to send a small amount of data, because it is limited by the number of attributes being used in the original document.

A free tool which implements this method exists: DEOGOL, which was written by Stephen FORREST in Perl in 2003 [12]. We used it to examine the efficiency of this method by calculating the capacity of WWW pages, to determine how much information can be secretly sent using the method described above. Our test set of web pages has been divided into four groups according to how the pages are administrated: pages with a content uploaded by their users, company pages, news portals and thematic pages dedicated to a specific topic. The results we obtained are presented in the Tables 1–4.

Table 1. Steganographic capacity of WWW pages (user content pages).

Page	Capacity (B)	Size (kB)	Efficiency (B/kB)
youtube.com	255	123	2.07
wrzuta.pl	118	52	2.27
joemonster.org	192	95	2.02

Table 2. Steganographic capacity of WWW pages (company pages).

Page	Capacity (B)	Size (kB)	Efficiency (B/kB)
microsoft.com	126	76	1.66
sony.com	100	7	14.29
cisco.com	53	24	2.21

Table 3. Steganographic Capacity of WWW Pages (news portals).

Page	Capacity (B)	Size (kB)	Efficiency (B/kB)
yahoo.com	133	208	0.64
cnn.com	153	96	1.59
onet.pl	90	87	1.03

Table 4. WWW Pages Steganographic Capacity (thematic pages).

Page	Capacity (B)	Size (kB)	Efficiency (B/kB)
fallout3.net	84	13	6.46
elka.pw.edu.pl	130	42	3.10
nba.com	104	79	1.32

Analysing the results we can notice that pages with user-generated content usually have the biggest steganographic capacity. These pages contain a lot of elements (especially hyperlinks) which have to be described by the HTML tags with attributes, what increases their capacity (Table 1). Table 2 shows that company pages usually have smaller capacity because their main pages are usually small ones in order to simplify navigation and finding specific information sought by the companies' customers. News portals usually do not allow to hide a lot of information comparing to their size, because the attributes do not appear so frequently in their source code. However, they are usually the big volume pages so they can constitute a decent stego-channel (Table 3). Thematic pages can vary significantly in terms of their capacity and size, therefore it is hard to extract their common features (Table 4).

Another thing to mention is that web pages created/edited in Microsoft Word have significantly bigger capacity than clear HTML pages. It is caused by an overhead added by the program: the redundant, Word-specific attributes are inserted into the document in HTML source code to format its view. After applying the Word-processing we got 462 bytes (3696 bits) of capacity for the `cnn.com` page what, comparing to 153 bytes before, gave us over 200% increase. For `gazeta.pl` we obtained 240% gain (442 B versus initial 130 B), and for `fallout3.net` 234% (281 B, versus 84 B before processing). These results show that this kind of processing allows to considerably increase the maximum size of hidden messages that can be sent over a HTML source code with the attribute's permutation algorithm.

Other methods. Except for the already mentioned methods, some other were proposed over the years. One of them was hiding coded data within the ID attribute of HTML tags proposed by Mohammad SHAHREZA [13]. This method allows to hide big quantity of information relatively to the previously discussed methods, but its usage can attract someone's attention, since ID attributes do not occur very often and even then they are usually in a meaningful and descriptive form.

2.2. Hiding information in XML

All the methods described in the previous subsection can be successfully applied to hide data in XML documents (except for method which involves changing case of letters because XML language is case-sensitive). Moreover, there are few additional techniques that can be used with XML documents, see [8].

Empty element representation. Each tag in XML has to have a closing tag. Two equivalent representations of an empty element exist what gives us an opportunity to use them to hide information.

Elements order. Next possibility is to change elements order. Obviously, it is only possible in the case when applications using XML documents do not require particular elements' order. This method resembles attributes' permutation method described before. It has similar advantages, however it is a bit easier to analyse and potentially detect, because the number and the type of attributes in a certain tag can vary significantly.

Web pages can also be saved in the XML compliant format called XHTML. Of course, all methods described above still apply. We analysed the differences in capacity between documents stored in these two different formats but they turned out to be insignificant.

3. PAGE STRUCTURE'S CHANGES DETECTION

Hiding information inevitably involves leaving some trace. When one embeds additional data within a document, the changes are impossible to avoid. An analysis of documents allows to detect those changes by finding particular unusual patterns and to decide upon this basis if a certain document may contain a hidden data.

As it was already mentioned, there are many possibilities of hiding information in WWW pages' HTML code. Taking into account the vast number of pages in the Internet, it is a tough task to scan all of them and find the suspicious ones. Moreover, there are almost no studies conducted in this area. We failed to find any information about effective implementations of the mark-up languages steganalysis, which would allow to examine the source code of the web pages automatically.


Good steganographic methods should neither affect visible content which is presented to a viewer, nor change properties which are very easy to check, e.g., the size of the document. The attributes permutation method meets both these requirements. It can be applied to the mark-up language documents since there is no attribute order defined and it can vary a lot across different documents. However, documents created by the same person, in a short time period should not differ too much, since web designers usually have their own style worked out through years of work, and they apply it consequently, what makes the web page design process significantly faster thanks to the improved code readability. Especially, considering a case of a single document created by one person, its consistency assumptions should be fulfilled.

On the other hand, having to do with a document with a variable inner structure (regarding the attributes order), one can state a thesis that the document has been deliberately changed by someone. One of purposes of such a change can be hiding secret data within the web page.

Next in this paper we propose the method of analysing document's structure, which allows to track changes of the structure and possibly to discover attempts of information hiding. This is not a trivial task because the attributes can occur in many different combinations in each tag, hence every possible combination have to be considered. This implies a necessity of an algorithm that would determine the expected order of attributes for each tag, such that it would be possible to compare the order of attributes in their subsequent occurrences of the tag with it.

4. DESCRIPTION OF THE METHOD PROPOSED

The method we would like to introduce consists in comparing all couples of attributes in each tag that occurred in a particular document. For each couple it has to be counted how many times the first attribute occurred before the second one and how many times the opposite situation happened. Then we check which case has occurred more frequently (hence it is more probable); this one is assumed to be the correct one. Afterwards we take the first couple of attributes and look for all its occurrences within a document, to check how many times the order is correct (according to the predominant order determined in the previous step) and how many times it is not. Then we repeat the same procedure with all other couples.



```

<tag1 at1 at2 at3 > ... </tag1>
<tag1 at1 at3 at2 > ... </tag1>
<tag1 at1 at2 at3 at4 > ... </tag1>

```

FIG. 1. Example of different attributes order in a tag.

In Fig. 1 we present a simple example of a tag containing 3 different attributes. We can observe the following dependences between attributes in it:

- $at1$ occurs before $at2$ 3 times. $at2$ had not occurred before $at1$. Therefore the correct order for this couple of attributes is $\langle at1, at2 \rangle$,
- $at2$ occurs before $at3$ 2 times. $at3$ before $at2$ – 1 time. The correct order: $\langle at2, at3 \rangle$,
- $at1$ occurs before $at3$ 3 times. $at3$ before $at1$ – 0. The correct order: $\langle at1, at3 \rangle$,
- $at1, at2, at3$ occurs before $at4$ – 3 times. $at4$ never occurs before any of them. The correct orders are: $\langle at1, at4 \rangle$, $\langle at2, at4 \rangle$ and $\langle at3, at4 \rangle$.

This way we can examine the whole document and check how many unordered couples of the attributes exist. In the next subsection we present a formal description of this algorithm.

4.1. The procedure of anomalies detection

Let S be an HTML code containing a set of tags $\{T_1, T_2, T_3 \dots\}$. Each tag occurrence has a set of attributes denoted by $T_{n,i} \{a_1, a_2, a_3 \dots\}$, where n is the tag identifier and i defines the specific tag's occurrence. For the tag T_n containing attributes a_1 and a_2 , let us denote that a_1 precede a_2 in a particular tag's occurrence by $T_{n,i}(a_1, a_2) = (a_1, a_2)$ which means they consist of an ordered pair of attributes. In that case $P_{n,i}(a_x, a_y) = 1$, see (4.1). Furthermore, $O_n(a_x, a_y)$ describes the more frequent order of the couples of attributes in a particular tag, see (4.2).

$$(4.1) \quad P_{n,i}(a_x, a_y) = \begin{cases} 1 & \text{if } T_{n,i}(a_x, a_y) = (a_x, a_y), \\ 0 & \text{otherwise;} \end{cases}$$

$$(4.2) \quad O_n(a_x, a_y) = \begin{cases} (a_x, a_y) & \text{if } \sum_i P_{n,i}(a_x, a_y) \geq \sum_i P_{n,i}(a_y, a_x), \\ (a_y, a_x) & \text{otherwise.} \end{cases}$$

The value of $R_{n,i}(a_x, a_y)$ in Eq. (4.3) describes, if for a specific tag occurrence, the order of attributes is compliant with the previously determined predominant order.

$$(4.3) \quad R_{n,i}(a_x, a_y) = \begin{cases} 1 & \text{if } T_{n,i}(a_x, a_y) = O_n(a_x, a_y), \\ 0 & \text{otherwise.} \end{cases}$$

The sum of $R_{n,i}$ for all pairs of attributes determines the number of their occurrences in the predominant order. Total number of all occurrences of all couples of attributes in S is denoted by C . Hence, we can calculate W , which expresses the fraction of couples of attributes which occurred in a given S in a different order than the predominant one: O_n , see (4.4).

$$(4.4) \quad \forall x \forall y \quad x < y : W = 1 - \frac{\sum_n \sum_i R_{n,i}(a_x, a_y)}{C}.$$

Basing on that statistics, we can predict what is a chance that the document has been altered by someone. If W is high, we can suspect that someone changed the code of the page or that the page was created by more than one person. In the next section we will present results of tests that we performed to evaluate the efficiency of the method proposed.

5. EXAMPLES OF APPLICATION

To test the proposed algorithm we chose a set of web pages falling into different categories and we hide text messages of different lengths within them, so we can check how efficiently the steganalytic algorithm works.

Among the pages the following groups were distinguished:

- *pages gathering users uploaded content*, e.g., youtube.com,
- *company pages*, e.g., microsoft.com,
- *news portals*, e.g., yahoo.com, onet.pl, cnn.com,
- *thematic sites focused on a specific topic: games, music, etc.*, e.g., fall-out3.net.

5.1. Test 1: sensitivity of the method

To perform the tests we generated 7 text messages (from 5 to 151 characters). At first we inserted the messages into the downloaded pages using DEOGOL (the attribute permutation algorithm). Because of different capacities of the web pages, in some cases it was impossible to embed the longest messages.

Afterwards we examined how the W value depends on the message length. The obtained results are presented in Fig. 2. The plot presents the unordered attributes couples percentage W versus the relative steganographic occupation of each site (the ratio of the length of a hidden message and the page steganographic capacity).

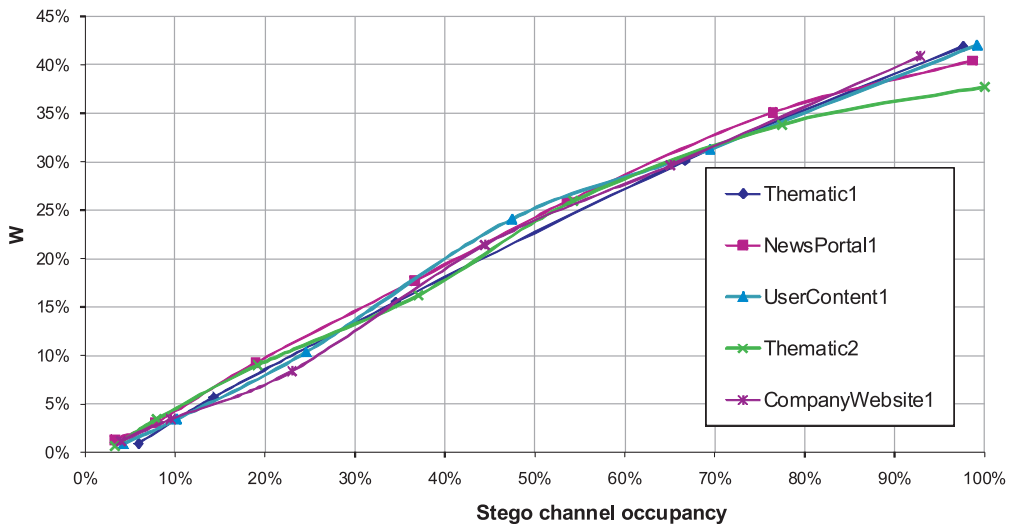


FIG. 2. Dependence of W on the stego channel occupancy for different WWW pages.

As we could expect, the increased length of the message causes the growth of the unordered couples number. For maximum occupancy, for the examined pages we have got results between 38% and 42%, whereas theoretical maximum is 50%, which in fact in the described case is a bit lower, since the pairs which are unique in a certain document have not been excluded (they are always considered as ordered). For the pages artificially modified, with the completely randomized order of attributes, we obtained very similar results; it means that they are equivalent to pages containing the maximum amount of secret data hidden inside.

For all pages under analysis the obtained results were nearly the same. That means that they were practically independent of a chosen site. We can notice a linear growth of W for the linearly growing length of a hidden message.

In Fig. 3 we compare a steganographically processed web page (in a way described in the previous paragraph) with pages that have not been converted. For readability, in Fig. 3 unprocessed web pages are marked by dashed lines. In fact there should be isolated points instead, as their stego channel occupancy is constant.

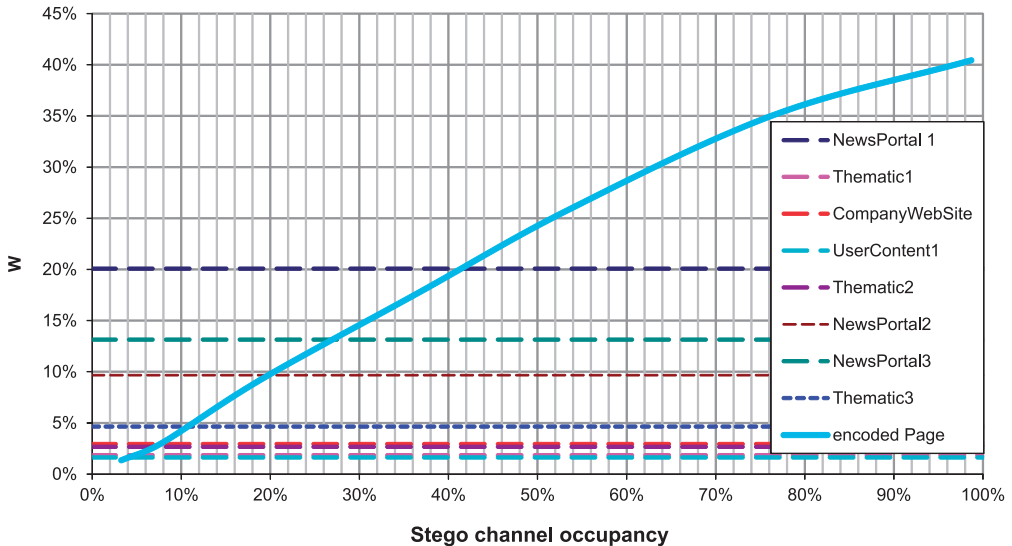


FIG. 3. Comparison of a steganographically modified page with original web pages.

We can see that the most of pages have little values of W ($< 5\%$), there is a smaller group with bigger values (10–14%) and one page with the result of 20% (a big news portal). We can notice that for the news portals we are getting bigger results than for other web pages. It can be explained as follows: usually these pages are created by many people who in turn may represent different styles

what may lead to higher results for W , since predominant order in one part is not necessarily such as in the parts created by different people. Such documents are not compliant with our assumption of the page coherence. The problem is to distinguish such pages from these really modified ones.

On the other hand, for other types of pages, we are able to obtain a good accuracy of the steganalysis and we can quite precisely distinguish unmodified pages from the ones containing hidden data.

In Fig. 4 we present exemplary decision thresholds. The higher one is set at 21%, hence it is bigger than any result received during the tests. For such a threshold we are able to detect a message occupying a bit more than 40% of the stego channel space. For the second one, which is 15%, we can find shorter messages, having the length of 30% of the web page stego channel capacity. The choice of the threshold is a trade-off between the precision and the recall. Having a high threshold, we can achieve good precision but we can omit some pages containing a steganographic data. On the contrary, for a lower threshold we can detect virtually all pages carrying secret messages (good recall), but some of the pages evaluated as suspicious ones may be classified wrongly.

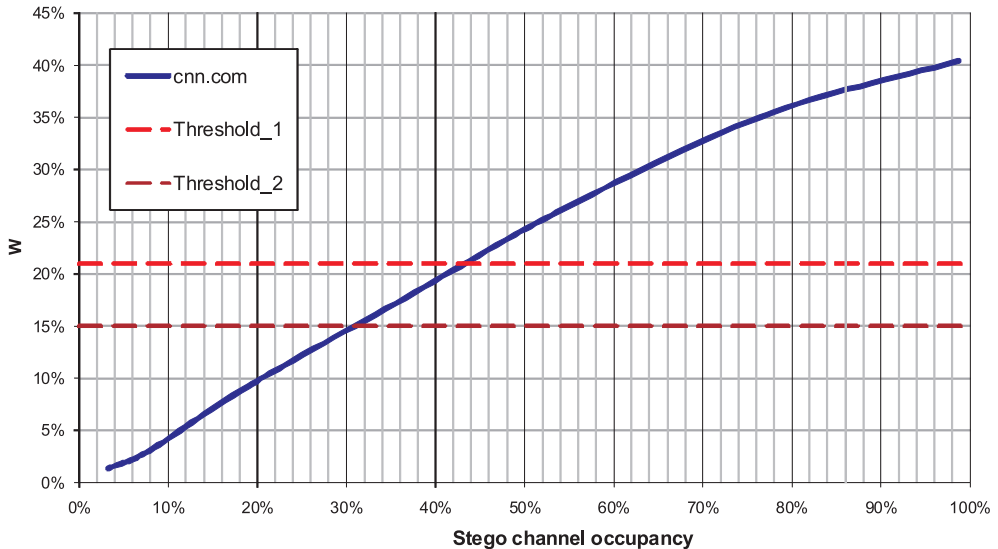


FIG. 4. A steganographically modified page with an exemplary decision threshold.

5.2. Test 2: long-term observations of web pages

Another kind of test that is carried out was a long-term test. Such a test is meant to check how the proposed measure W is changing over a long time

period. We assumed that hidden messages may not be transmitted constantly, i.e., there are some quiet periods when the steganographic channel is empty and the number of unordered couples of attributes is considerably lower.

The test was performed for four pages: two of them were news portals (Figs. 5–6), one was a page with user-uploaded content (Fig. 7) and one was a thematic page (Fig. 8). They were analysed every hour for almost one month (from 6.05.2009 to 2.06.2009). The irregular data in Fig. 6 for probes 216–234 should be considered as measurement errors caused by errors during the page download process and they will not be taken into account during our analysis.

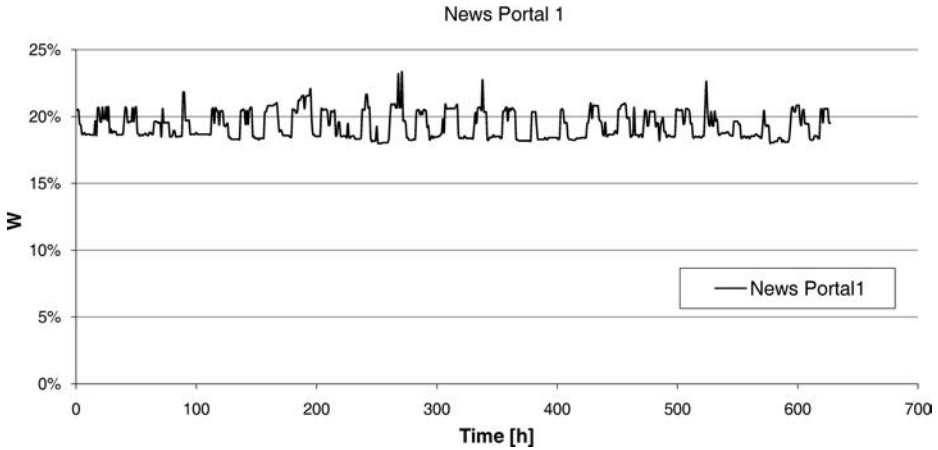


FIG. 5. Long-term test for news portal 1.

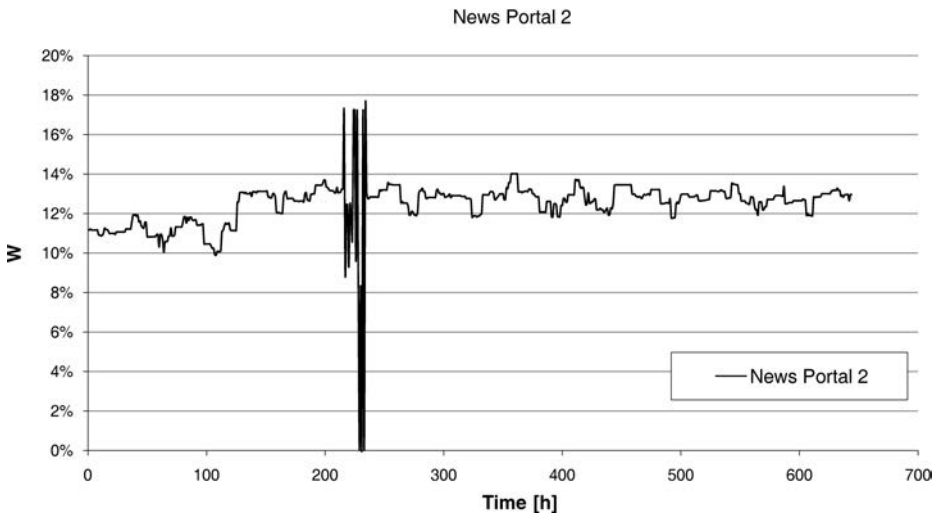


FIG. 6. Long-term test for news portal 2.

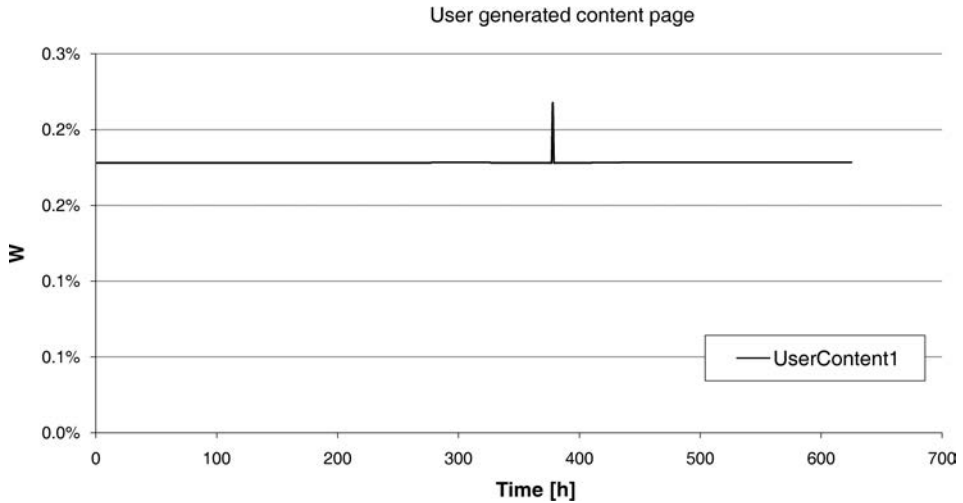


FIG. 7. Long-term test for a web page with user generated content.

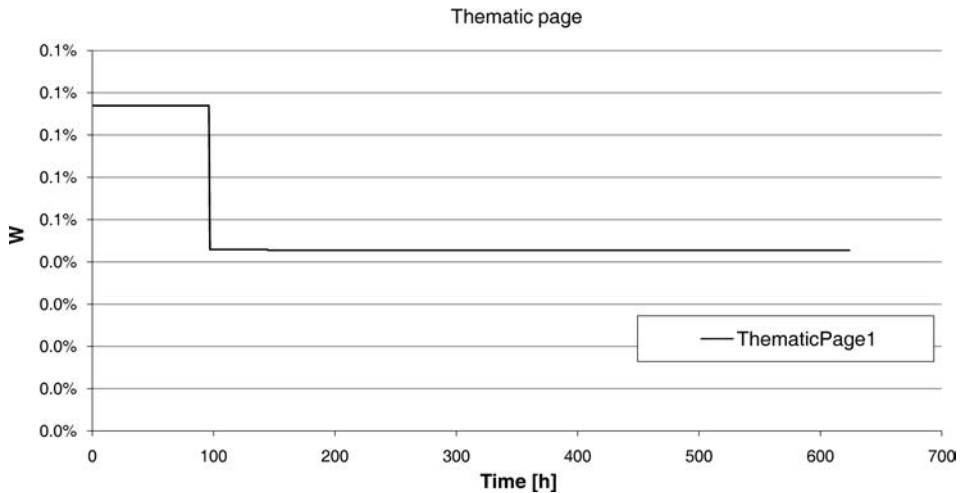


FIG. 8. Long-term test for a thematic web page.

In the charts we can see how the value of W has been changing over the examined period of time. For the last two pages there was only a single small change (about 0.5%). Completely different results were obtained for informational portals: the examined ratio W changes much more (up to 4-5%). Analysing those results it is easy to see a difference between large news pages which are frequently updated and the pages having a fixed structure, which are changing rarely. The news web pages, created by many people, are characterized by a higher level of unordered couples ratio W and its higher dynamics.

The proposed algorithm can be used to monitor changes in a web page structure. Because of the algorithm is the attributes' order-sensitive, it allows to detect changes only in a page structure, not in its content. Thus, we come to the conclusion that a long-term tests would allow to distinguish big informational pages from the pages really modified. We deduce that pages containing stego messages should have a constant, high value of the ratio W (when the message is transmitted all the time) or conversely, it should fluctuate heavily (when the message is transmitted only in certain periods of time). On the other hand, normal changes should look like on the charts presented above: regular and periodical. However, it is very hard to verify this hypothesis, because obviously there is no information available regarding pages exploiting this kind of steganography.

Another thing to mention is that since we have calculated the expected order of the attributes O_n for a given document, we can easily change the order of all attributes in the document in this way that they are compliant with O_n . Hence, we are able to 'clean' it without changing visual appearance of the web page and to be sure that no additional information is sent within the page. Since it does not change the visual content, it can be done always, even if we are not sure whether the page was modified. Similarly, other methods can also be applied to remove suspicious features that are not visible in a web browsers and can be used for sending hidden messages, e.g., white-spaces at the end of line.

6. CONCLUSION

In this paper we proposed the procedure which allows to monitor the changes of web pages structure. We introduced the measure which describes how the attributes of tags are ordered in HTML/XML documents. It allows us to discover potential secret communication which uses the attributes' permutation method. Our experiments show that in some cases it might be hard to determine if a page was really changed or if it was created by several different people and therefore it might be inconsistent. Long-term tests can be used to distinguish both kinds of pages and to trace the changes in a web page inner structure.

Furthermore, we are always able to protect web pages from the steganographic techniques involving attributes' permutation by setting all the attributes in a fixed order. Our method can be applied to control web pages and to assure that nobody could exploit them as stego channels.

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